



MPQ2484U

75V, Multi-Topology (Buck, Boost, Buck-Boost) LED Controller, AEC-Q100 Qualified

DESCRIPTION

The MPQ2484U is a flexible, multi-topology, asynchronous controller for LED lights requiring high luminous output. The device supports buck, boost, and buck-boost configurations, which makes it suitable for a wide range of LED lighting applications.

The MPQ2484U features a wide 4.5V to 45V input voltage (V_{IN}) range and a maximum boost output voltage up to 75V. Peak current mode provides fast transient response and simplifies loop stabilization. The switching frequency (f_{SW}) can be set via the FSET pin, or it can be synchronized with a 100kHz to 2.2MHz external clock signal. The configurable frequency spread spectrum (FSS) function can periodically enable frequency dithering to improve EMI. The MPQ2484U provides switch-mode dimming by utilizing an external P-channel MOSFET. Without a P-channel MOSFET, two-step dimming or PWM dimming can be selected.

Robust fault protections include thermal shutdown, cycle-by-cycle peak current limiting, output over-voltage protection (OVP), output short-circuit protection (SCP), LED open protection, and LED short protection. A fault indicator outputs an active logic low signal if a fault occurs.

The MPQ2484U is available in a TSSOP-28EP package.

FEATURES

- **Built for Automotive Lighting**
 - Load Dump Up to 45V
 - Cold Crank Down to 4.5V
 - Maximum 75V Boost Output
 - Two-Step Dimming via the H/L Pin
 - PWM Dimming via the PDIM Pin
 - Integrated P-Channel MOSFET Driver for Switch Dimming
 - Available in AEC-Q100 Grade 1
- **Multi-Topology**
 - Supports Buck, Boost, and Buck-Boost Topologies
- **Low-Noise EMI/EMC**
 - Frequency Spread Spectrum (FSS)
 - Configurable or Synchronizable Switching Frequency (f_{SW})
- **Robust Protection Suite**
 - Cycle-by-Cycle Current Limit
 - Output Over-Voltage Protection (OVP)
 - Open LED Protection
 - LED String Anode/Cathode to Battery/Ground Short Protection
 - One or Multiple LED Short Protection
 - Over-Temperature Shutdown
 - Fault Flag Output (/FLT)
- **Additional Features**
 - $<5\mu A$ Shutdown Current
 - $<1mA$ Quiescent Current
 - Configurable Current-Sense Reference via an External Resistor
 - External Loop Compensation
 - Available in a TSSOP-28EP Package

APPLICATIONS

- Automotive Exterior LED Lighting
 - Headlights
 - Tail Lights
 - Fog Lights
- Commercial and Industrial LED Lighting

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TYPICAL APPLICATION

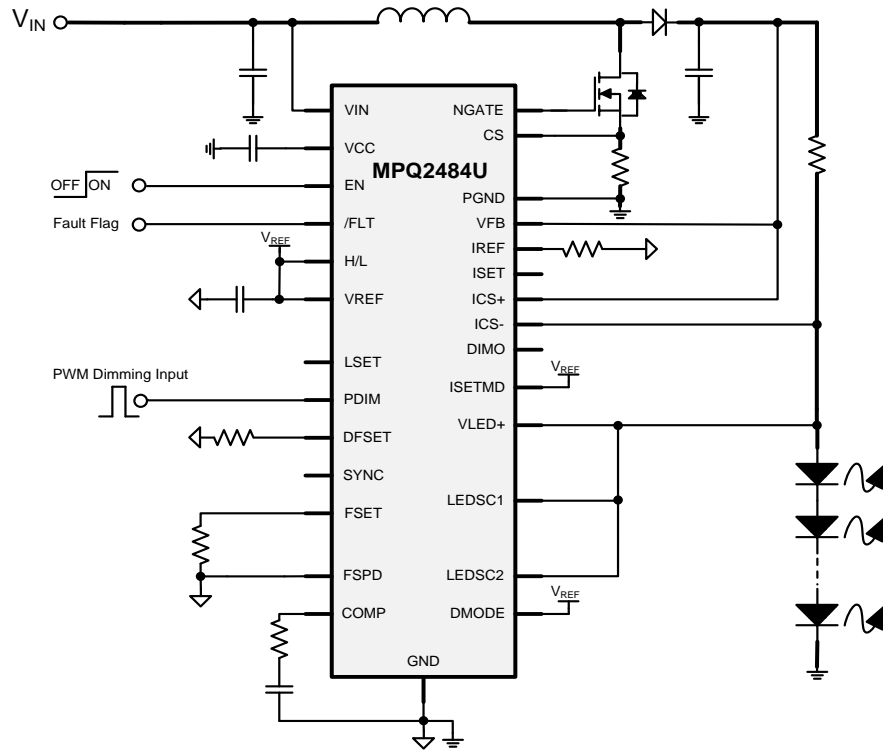


Figure 1: Boost Configuration

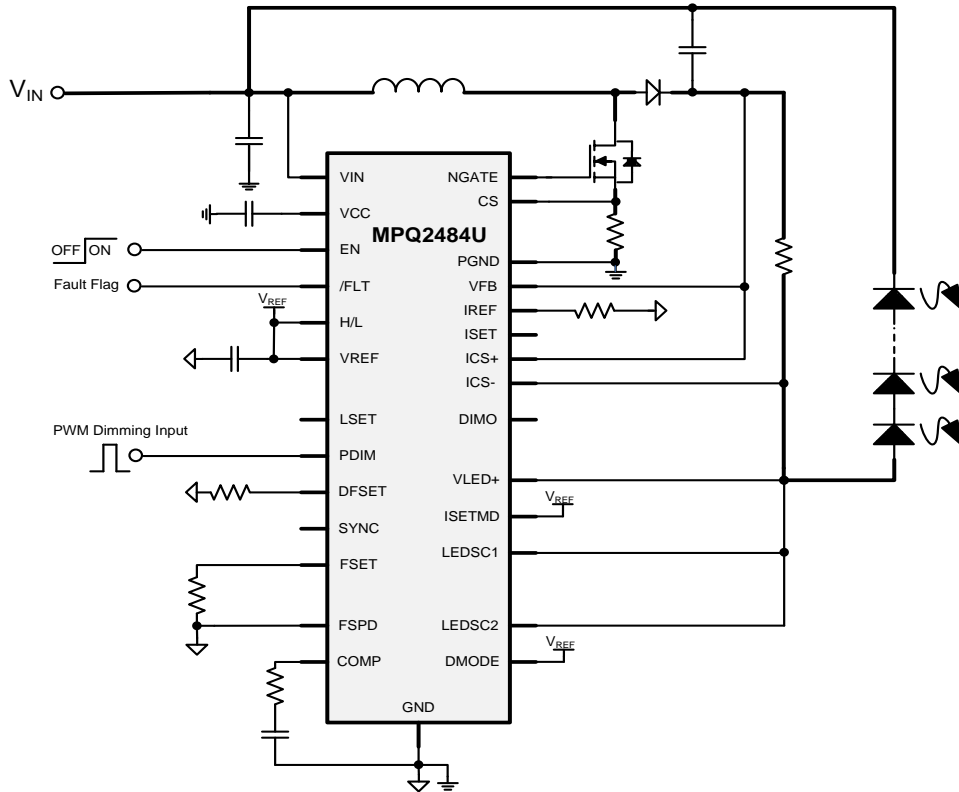


Figure 2: Buck-Boost Configuration

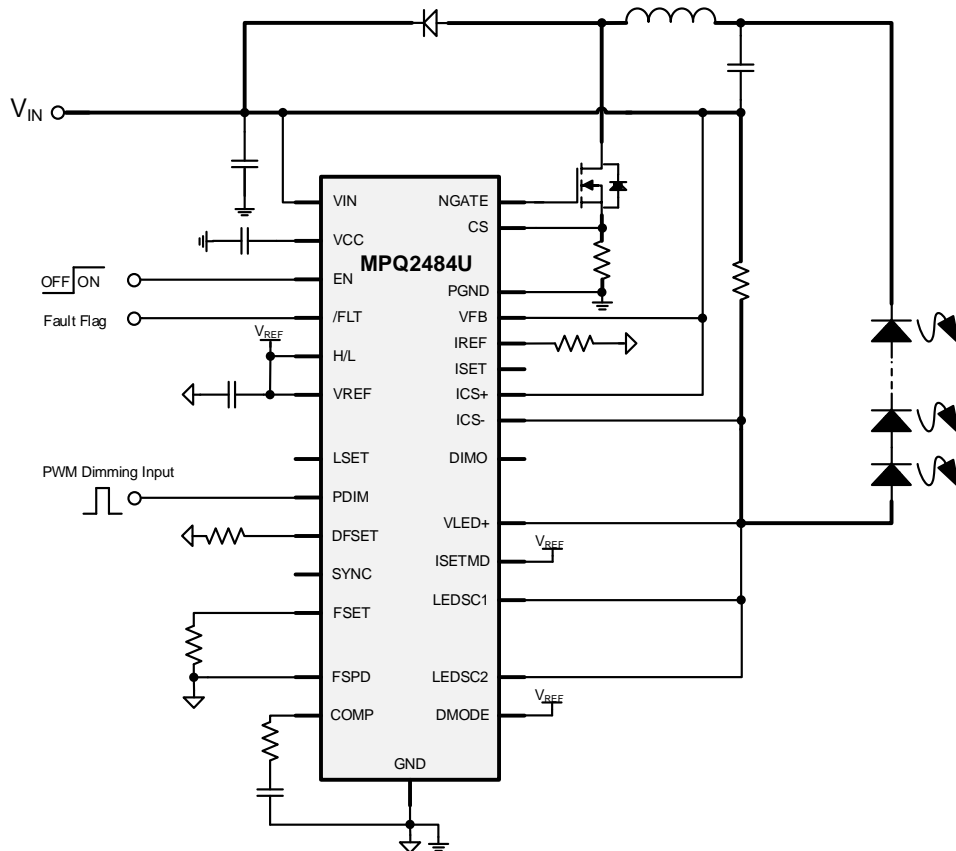


Figure 3: Buck Configuration

ORDERING INFORMATION

Part Number*	Package	Top Marking	MSL Rating**
MPQ2484UGF-AEC1	TSSOP-28EP	See Below	Level 2a

*For Tape & Reel, add suffix -Z (e.g. MPQ2484UGF-AEC1-Z).

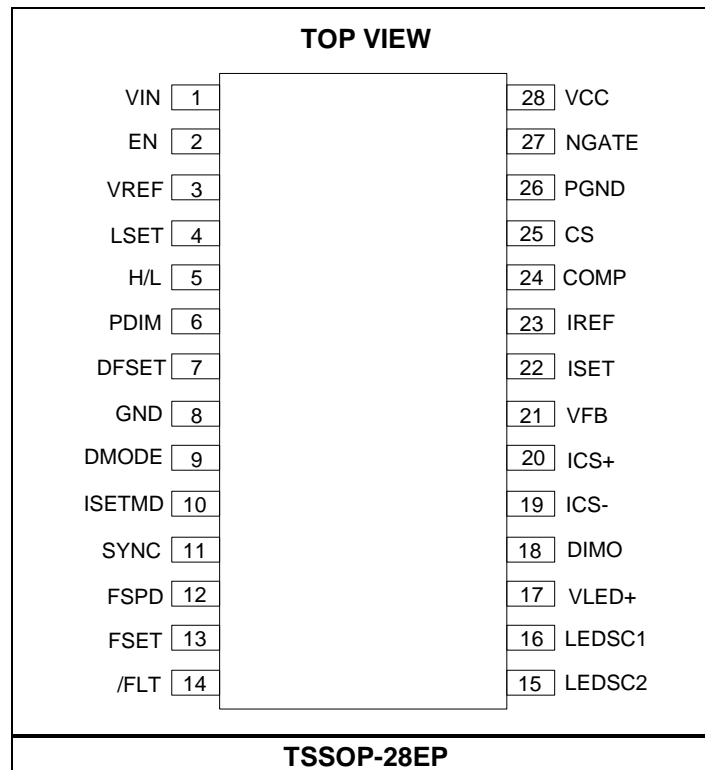
**Moisture Sensitivity Level Rating

TOP MARKING (MPQ2484UGF-AEC1)

MPSYYWW
MP2484U
LLLLLLLLL

MPS: MPS prefix
 YY: Year code
 WW: Week code
 MP2484U: Part number
 LLLLLLLLL: Lot number

PACKAGE REFERENCE



PIN FUNCTIONS

Pin #	Name	Description
1	VIN	Power supply input. Connect a bypass capacitor from VIN to PGND to reduce noise.
2	EN	On/off control input and custom input UVLO setting. The EN pin can be driven by an external logic signal to enable and disable the chip. Pull EN above 1.3V to enable the part; pull it below 0.4V to shut down the part. Set a configurable input voltage (V_{IN}) under-voltage lockout (UVLO) threshold by tying a resistor divider from the input to the EN pin. Do not float EN.
3	VREF	2.37V reference output. VREF is the reference for LED short detection. Bypass VREF to GND with an external 1nF to 10nF ceramic capacitor.
4	LSET	Dimming duty setting for two-step dimming. If the H/L pin is pulled down to ground, the LSET pin's voltage determines the two-step dimming duty cycle. A resistor divider is tied from VREF to LSET to set the two-step dimming threshold. If two-step dimming mode is not used, float the LSET pin.
5	H/L	Two-step dimming control input. If two-step dimming is selected and the H/L pin is logic high, then the LED output current is set to full scale (no dimming). If the H/L pin is logic low, then the LSET voltage sets the two-step dimming threshold. If two-step dimming mode is not used, connect the H/L pin to VREF. Do not float H/L.
6	PDIM	PWM dimming pulse input. If PWM dimming is selected, connect the H/L pin to VREF and apply a PWM signal to the PDIM pin for LED dimming. When PDIM is pulled down to logic low, switching stops and DIMO pulls high to turn off the dimming P-channel MOSFET. Connect a ceramic bypass capacitor from the PDIM pin to GND when two-step dimming is activated.
7	DFSET	Two-step dimming frequency setting. Connect an external capacitor from the DFSET pin to GND. The internal source/sink current source charges and discharges the capacitor repeatedly to generate a stable triangular wave. The LSET level is compared to the triangular wave to output a PWM dimming signal. If PWM dimming is used, tie the DFSET pin to ground using a 7.14k Ω to 8.46k Ω resistor. An 8.06k Ω resistor is recommended.
8	GND	Signal ground.
9	DMODE	Dimming mode control input. If the DMODE pin is pulled down to GND, place an additional P-channel MOSFET in series with the LED string to improve dimming performance. This additional MOSFET can also act as a protection MOSFET in buck-boost and boost mode. If this pin is logic high, the P-channel MOSFET driver is disabled. Do not float DMODE.
10	ISETMD	Current-sense reference selection input. If the ISETMD pin is logic high, the LED current-setting reference voltage (ICS+ - ICS-) is set between 0mV and 100mV when the ISET voltage (V_{ISET}) rises from 0.6V to 1.2V. This supports thermal derating when an NTC resistor is tied from ISET to GND. If the ISETMD pin is pulled down to GND, the LED current can be set at up to 200% of the nominal value when V_{ISET} rises from 0.6V to 1.8V. This feature can be used for analog dimming.
11	SYNC	Synchronization input. If an external clock pulse signal is connected to the SYNC pin, the frequency setting function on the FSET pin is disabled, and the chip synchronizes its switching with the external clock. Ensure that the SYNC high level exceeds 1.4V and that the low level is below 0.6V. Float SYNC if external synchronization is not used.
12	FSPD	Frequency spread spectrum (FSS) output ramp. Connect a capacitor from the FSPD pin to GND, and connect a resistor between the FSPD and FSET pins to dither the switching frequency (f_{sw}) for spread spectrum. Remove the resistor if FSS is disabled. For more details, see the Frequency Spread Spectrum section on page 44.
13	FSET	Switching frequency (f_{sw}) setting. Connect an external resistor from FSET to GND to set the internal f_{sw} . R_{FSET} (k Ω) = 8333 / f_{sw} (kHz). Do not float FSET.

PIN FUNCTIONS (continued)

Pin #	Name	Description
14	/FLT	Fault flag indicator output. The /FLT pin is an active-low, open-drain output. Connect an external pull-up resistor to this pin. If a fault status is activated, /FLT is pulled down to GND. If the system recovers and no fault status is detected for 30 μ s, then the /FLT pin is released and acts as an open drain.
15	LEDSC2	One or more LEDs short sense input 2. The LEDSC2 pin senses the LED string's voltage drop via a resistor divider. Short LEDSC2 and LEDSC1 to LED+ if this protection is not used.
16	LEDSC1	One or more LEDs short sense input 1. The LEDSC1 pin senses a single LED's voltage drop via a resistor divider. Short LEDSC1 and LEDSC2 to LED+ if this protection is not used.
17	VLED+	LED string anode input. The VLED+ pin is used for fault detection with other pins. If an external dimming P-channel MOSFET is not connected, then short VLED+ to ICS-.
18	DIMO	Dimming P-channel MOSFET gate driver output. If the dimming P-channel MOSFET is connected, then the DIMO pin drives the external P-channel MOSFET as a dimming switch. Float DIMO if the external P-channel MOSFET is not connected.
19	ICS-	High-side LED current-sense negative input.
20	ICS+	High-side LED current-sense positive input. For full-scale LED current control, the voltage between ICS+ and ICS- is regulated to 100mV.
21	VFB	LED string voltage feedback input. Connect a resistor divider from ICS+ to the LED string cathode. The VFB pin is tied to the tap of the resistor divider to sense the LED string voltage for over-voltage protection (OVP).
22	ISET	LED current setting. Connect an external resistor from ISET to ground. V_{ISET} can set the reference voltage (V_{REF}) for the LED current regulator. When ISETMD is pulled down to GND and V_{ISET} rises from 0.6V to 1.8V, V_{REF} rises from 0mV to 200mV. This feature can be used after setting a resistor on the LED light load, which allows the LED current to be adjusted. When ISETMD is pulled high and V_{ISET} rises from 0.6V to 1.2V, V_{REF} rises from 0mV to 100mV. If the ISET pin is left floating, the current reference is fixed at 100mV.
23	IREF	Biased current setting for ISET. The IREF pin sets the bias current ($I_{ISET} = 100 \times I_{IREF}$) for the ISET resistor to improve accuracy. Tie a resistor from IREF to ground. Do not float IREF.
24	COMP	Compensation connection. The COMP pin is the internal error amplifier's (EA's) output. Connect a resistor and capacitor network to this pin for system stability.
25	CS	N-channel MOSFET current-sense input. Tie a current-sense resistor from the N-channel MOSFET source to PGND to sense the switching current and set the current limit. Add a resistor/capacitor network between CS and the current-sense resistor to configure the slope compensation.
26	PGND	Power ground. Ground return for the N-channel MOSFET's current sense.
27	NGATE	Power N-channel MOSFET gate driver output. Connect NGATE to the gate of the N-channel MOSFET.
28	VCC	8.5V internal regulator output. VCC supplies power to both control blocks and the N-channel MOSFET's gate driver. Bypass VCC to PGND with an external ceramic capacitor.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

VIN to PGND	-0.3V to +50V
VFB to PGND	-0.3V to +80V
ICS+, ICS-, DIMO to PGND	-0.3V to +80V
VFB to ICS+	-6V to +6V
ICS- to ICS+	-6V to +0.3V
DIMO to ICS+	-12V to +0.3V
VLED+ to PGND	-0.3V to +80V
VLED+ to ICS+	-90V to +0.3V
LEDSC1, LEDSC2 to PGND	-0.3V to +80V
LEDSC1 to LEDSC2	-6V to +6V
VCC to PGND	-0.3V to +12V
NGATE to PGND	-0.3V to (V _{CC} + 0.3V)
CS to PGND	-0.3V to +6V
PGND to GND	-0.3V to +0.3V
All other pins to GND	-0.3V to +6V
Continuous power dissipation	(T _A = 25°C) ⁽²⁾
TSSOP-28EP	3.9W
Junction temperature	150°C
Lead temperature	260°C
Storage temperature	-65°C to +150°C

ESD Ratings

Human body model (HBM)	Class 2 ⁽³⁾
Charged device model (CDM)	Class C2 ⁽⁴⁾

Recommended Operating Conditions

Supply voltage (V _{IN})	4.5V to 45V
Max boost voltage ICS+ to PGND	75V
Operating junction temp (T _J)	-40°C to +150°C

Thermal Resistance ⁽⁵⁾	θ_{JA}	θ_{JC}
TSSOP-28EP		
JESD51-7	32	6
	°C/W ⁽⁵⁾	

Notes:

- 1) Absolute maximum ratings are rated under room temperature unless otherwise noted. Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature, T_J (MAX), the junction-to-ambient thermal resistance, θ_{JA}, and the ambient temperature, T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX) - T_A) / θ_{JA}. Exceeding the maximum allowable power dissipation can cause excessive die temperature, and the device may go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) Per AEC-Q100-002.
- 4) Per AEC-Q100-011.
- 5) Measured on JESD51-7, 4-layer PCB. The values given in this table are only valid for comparison with other packages and cannot be used for design purposes. These values were calculated in accordance with JESD51-7, and simulated on a specified JEDEC board. They do not represent the performance obtained in an actual application, the value of θ_{JC} shows the thermal resistance from junction-to-case bottom.

ELECTRICAL CHARACTERISTICS

$V_{IN} = 12V$, $V_{EN} = 2V$, $T_J = -40^{\circ}C$ to $+150^{\circ}C$, all voltages with respect to ground, typical values are at $T_J = 25^{\circ}C$, unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
Input Supply Voltage						
Operating input voltage	V_{IN}		4.5		45	V
V_{IN} under-voltage lockout (UVLO) threshold	V_{IN_UVLO}	V_{IN} falling	3.6	3.9	4.2	V
V_{IN} UVLO hysteresis	$V_{IN_UVLO_HYS}$			250	500	mV
Input Supply Current						
Shutdown current	I_{SD}	$V_{EN} = 0V$, ICS+ floating		1	5	μA
Quiescent current (normal)	I_Q	No switching		0.7	1	mA
VCC Regulator						
Regulator output voltage	V_{CC}	$10V \leq V_{IN} \leq 15V$, $0.1mA \leq I_{CC} \leq 50mA$ $15V \leq V_{IN} \leq 45V$, $0.1mA \leq I_{CC} \leq 35mA$	7.8	8.5	9.2	V
Dropout voltage	V_{CC_DR}	$V_{IN} = 4.5V$, $I_{CC} = 50mA$		520	1150	mV
Short-circuit current limit	I_{CC_MAX}	$V_{CC} = 0V$	55	100	150	mA
V_{CC} UVLO threshold	V_{CC_UVLO}	V_{CC} falling	3.6	3.9	4.2	V
V_{CC} UVLO hysteresis	$V_{CC_UVLO_HYS}$			235	500	mV
Reference Regulator						
VREF output voltage	V_{REF}	$4.5V \leq V_{IN} \leq 45V$, $0\mu A \leq I_{REF} \leq 100\mu A$	2.31	2.37	2.43	V
Short-circuit current limitation	I_{REF_MAX}	$V_{REF} = 0V$		220		μA
Oscillator						
Switching frequency	f_{SW}		100		2200	kHz
		$R_{FREQ} = 82.5k\Omega$	85	100	125	
		$R_{FREQ} = 17.8k\Omega$	423	470	517	kHz
		$R_{FREQ} = 3.3k\Omega$	1870	2200	2530	
Biased voltage at FSET	V_{FSET}		0.575	0.608	0.63	V
Maximum duty cycle	D_{MAX}	$V_{CS} = 0V$, $V_{ICS+} - V_{ICS-} = 0.09V$	92	95	98	%
Synchronization frequency range	f_{SYNC}	$f_{SYNC} < 2.2MHz$	110%		170%	f_{sw}
SYNC logic high threshold	V_{SYNC_H}	V_{SYNC} rising	1.4			V
SYNC logic low threshold	V_{SYNC_L}	V_{SYNC} falling			0.5	V
SYNC minimal logic high pulse width ⁽⁶⁾	$t_{SYNC_PW_MIN}$		200			ns
Frequency Spread Spectrum (FSS)						
FSPD source current	I_{FSPD_SOURCE}	DIM on, $V_{FSPD} = 0V$	70	100	130	μA
FSPD sink current	I_{FSPD_SINK}	DIM on, $V_{FSPD} = 2.5V$	70	100	130	μA
FSPD high flip threshold	V_{FSPD_H}	DIM on, V_{FSPD} rising	1.1	1.2	1.3	V
FSPD low flip threshold	V_{FSPD_L}	DIM on, V_{FSPD} falling	0.52	0.6	0.68	V

ELECTRICAL CHARACTERISTICS (continued)

$V_{IN} = 12V$, $V_{EN} = 2V$, $T_J = -40^{\circ}C$ to $+150^{\circ}C$, all voltages with respect to ground, typical values are at $T_J = 25^{\circ}C$, unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
Enable (EN)						
Logic enable threshold	$V_{EN_LOGIC_H}$	V_{EN} rising	1.3			V
Logic disable threshold	$V_{EN_LOGIC_L}$	V_{EN} falling			0.4	V
System enable threshold	$V_{EN_SYS_ON}$	V_{EN} rising	1.42	1.5	1.58	V
Pull-up hysteresis current	$I_{EN_SYS_HYS}$	After the converter works	200	630	1000	nA
Hysteresis voltage	$V_{EN_SYS_HYS}$		50	150	300	mV
N-Channel MOSFET Driver						
NGATE output voltage	V_{NGATE}	$V_{CC} = 8.5V$	8	8.5		V
		$V_{CC} = V_{CC_UVLO} + 50mV$	3.5			V
NGATE pull-up resistor	R_{PULL_UP}	$V_{CC} = 8.5V$, $V_{NGATE} = 0V$		900	2000	m Ω
NGATE pull-up resistor	R_{PULL_UP}	$V_{CC} = V_{NGATE} = 8.5V$		1300	2500	m Ω
NGATE rising time ⁽⁶⁾	t_{R_NG}	$C_{NGATE} = 10nF$		30		ns
NGATE falling time ⁽⁶⁾	t_{F_NG}	$C_{NGATE} = 10nF$		30		ns
N-Channel MOSFET Current Sense Comparator						
Leading-edge blanking time	t_{CS_LEB}			90		ns
Current-sense clamp voltage	V_{CS_CLAMP}	Cycle-by-cycle limit	360	400	440	mV
Slope compensation ramp peak current	I_{SLOP_PK}	Ramp peak current during each switching cycle	37	50	60	μA
Dimming P-Channel MOSFET Driver						
Biased voltage UVLO threshold	V_{ICS+_UVLO}	V_{ICS+} falling	7.9	8.5	9.1	V
Biased voltage UVLO hysteresis	V_{ICS+_HYS}		100	200	300	mV
DIMO lowest output voltage with respect to V_{ICS+}	V_{DIMO_MIN}	$12V < V_{ICS+} < 75V$	-12	-11	-10	V
		$V_{ICS+} = V_{ICS+_UVLO} + 50mV$			-6.5	V
DIMO peak source current	I_{DIMO_SOURCE}	$V_{DIMO} - V_{ICS+} = -8.5V$	25	50	80	mA
DIMO peak sink current	I_{DIMO_SINK}	$V_{DIMO} = V_{ICS+}$	30	50	65	mA
LED Current Regulation						
Feedback reference voltage	V_{ICS_FB}	100% scale, $\pm 5\%$	93	100	107	mV
ICS+ bias current	I_{CS+}	DIM off, $V_{ICS+} = 75V$		170	250	μA
ICS- bias current	I_{CS-}		-200		+200	nA
Biased voltage at IREF	V_{IREF}		0.785	0.805	0.825	V
Current gain	I_{SET} / I_{REF}		95	100	105	
ISET max current setting threshold	V_{ISET_MAX}	$V_{ICS_FB} = 200mV$	1.4	1.8	2.2	V
ISET min current setting threshold	V_{ISET_MIN}	$V_{ICS_FB} = 10mV$	0.5	0.63	0.73	V
VLED+ bias current	I_{VLED+}		40	75	100	μA
Compensation						
Error amplifier (EA) transconductance	G_{EA}		3.1	4.5	5.9	mA/V

ELECTRICAL CHARACTERISTICS (continued)

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Parameters	Symbol	Condition	Min	Typ	Max	Units
COMP source current	I_{COMP_SOURCE}	$V_{COMP} = 0V$	200	570	1000	μA
COMP sink current	I_{COMP_SINK}	$V_{COMP} = 4.5V$	200	570	1000	μA
Two-Step Dimming						
H/L high-level threshold	V_{H/L_H}	$V_{H/L}$ rising	1.4			V
H/L low-level threshold	V_{H/L_L}	$V_{H/L}$ falling			0.6	V
DFSET source current	I_{DFSET_SOURCE}	Triangular wave, $V_{DFSET} = 0V$	70	100	130	μA
DFSET sink current	I_{DFSET_SINK}	Triangular wave, $V_{DFSET} = 1.5V$	70	100	130	μA
DFSET high flip threshold	V_{DFSET_H}	V_{DFSET} rising	1.122	1.2	1.278	V
DFSET low flip threshold	V_{DFSET_L}	V_{DFSET} falling	0.56	0.6	0.64	V
PWM Dimming (Tie an 8.06kΩ Resistor from DFSET to Ground, or Set $V_{DFSET} = 1V$)						
PDIM pull-up current	I_{PDIM}	$V_{H/L} = 2V$, $V_{PDIM} = 0V$		3	5	μA
PDIM logic high threshold	V_{PDIM_H}	V_{PDIM} rising	$V_{DFSET} + 100mV$			V
PDIM logic low threshold	V_{PDIM_L}	V_{PDIM} falling			$V_{DFSET} - 100mV$	V
PDIM to DIMO turn-on delay	$t_{PWM_DELAY_ON}$	$C_{DIMO_ICS+} = 7nF$		3		μs
PDIM to DIMO turn-off delay	$t_{PWM_DELAY_OFF}$	$C_{DIMO_ICS+} = 7nF$		2		μs
Current-Sense (CS) Reference Selection						
ISETMD logic high threshold	V_{ISETMD_H}	V_{ISETMD} rising	1.4			V
ISETMD logic low threshold	V_{ISETMD_L}	V_{ISETMD} falling			0.6	V
ISETMD pull-up current	I_{ISETMD}	$V_{ISETMD} = 0V$		3	5	μA
Dimming Mode Selection						
DMODE logic high threshold	V_{DMODE_H}	V_{DMODE} rising	1.4			V
DMODE logic low threshold	V_{DMODE_L}	V_{DMODE} falling			0.6	V
DMODE pull-up current	I_{DMODE}	$V_{DMODE} = 0V$		3	5	μA
Over-Voltage Protection (OVP) (without Fault Flag Indication)						
OVP threshold with respect to V_{ICS+}	V_{FB_OVP}	$(V_{FB} - V_{ICS+})$ falling	-1.24	-1.17	-1.1	V
OVP hysteresis	$V_{FB_OVP_HYS}$		50	150	250	mV
VFB bias current	I_{VFB}		-65		+65	nA
Under-Current Protection (UCP) (for OLP and SCP, with Fault Flag Indication)						
UCP threshold with respect to V_{ICS+}	V_{UCP}	$V_{CC_MODE} = 0V$, $(V_{ICS-} - V_{ICS+})$ rising	-70	-50	-30	mV
Short-Circuit Protection (SCP) (with Fault Flag Indication)						
SCP threshold with respect to V_{ICS+}	V_{SCP}	$(V_{ICS-} - V_{ICS+})$ falling	-325	-300	-275	mV
VLED+ short threshold	V_{LED+_SCP}	V_{LED+} falling	1.3	1.5	1.7	V
		$(V_{LED+} - V_{IN})$ falling	1.1	1.5	2	V
		$(V_{LED+} - V_{IN})$ is almost equal to 0V	-0.45	0	+0.1	V

ELECTRICAL CHARACTERISTICS (continued)

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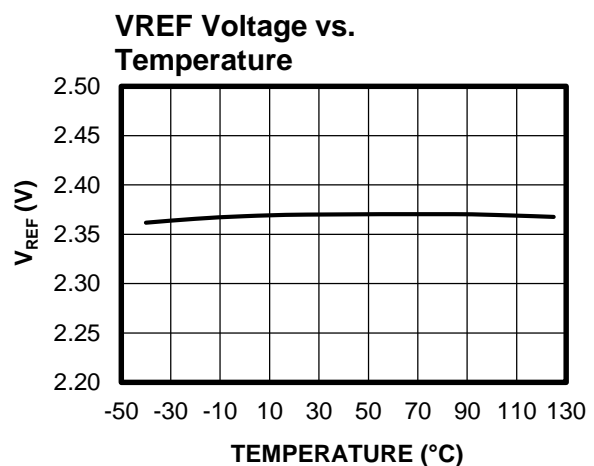
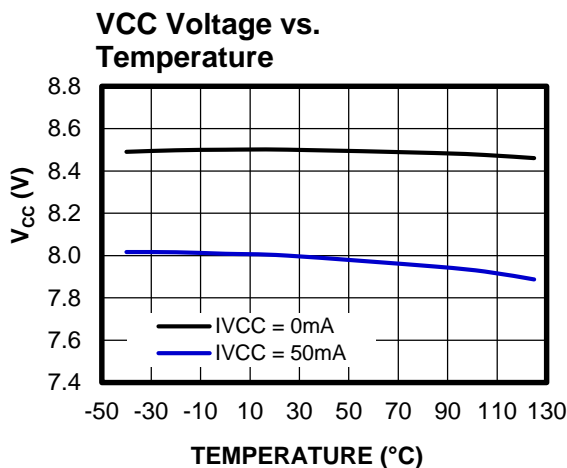
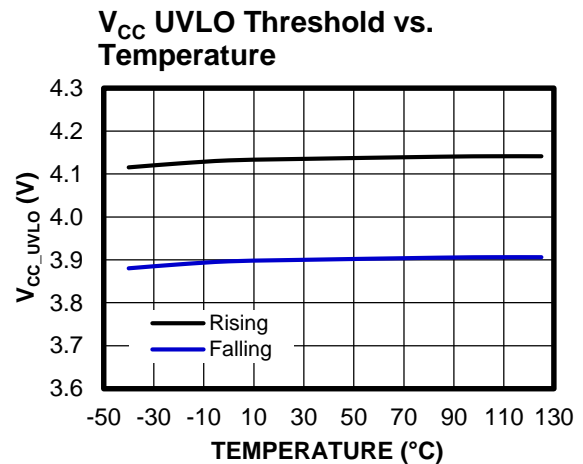
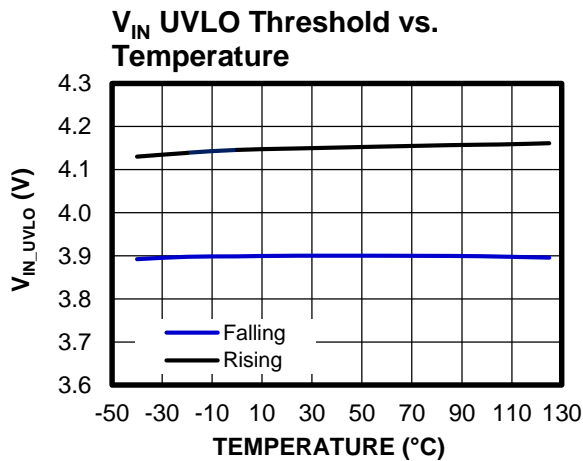
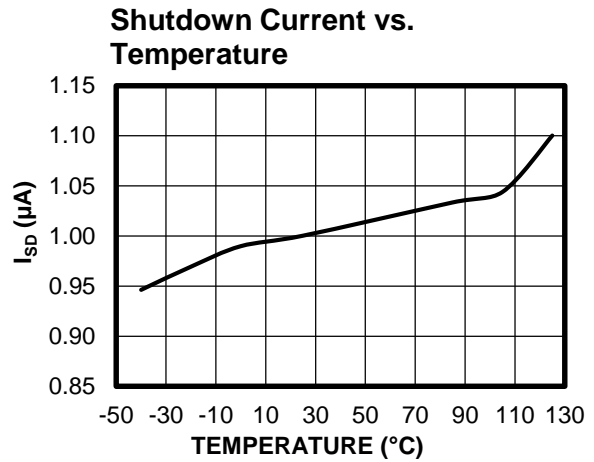
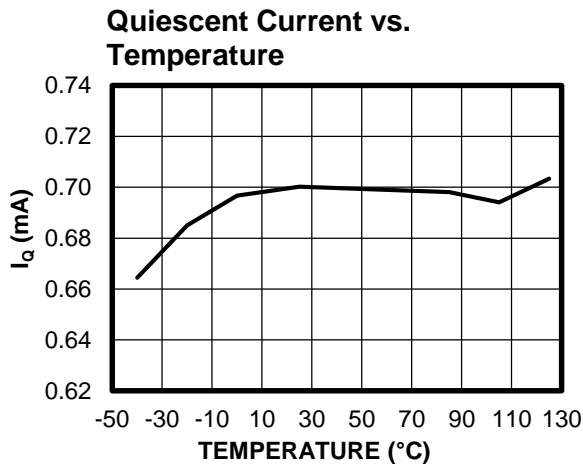
Parameters	Symbol	Condition	Min	Typ	Max	Units
SCP fault activation delay time (counter increases only when dimming is on)	t_{SCP_DELAY}	Only level I		4096		Clock cycles
		Level I and VLED+ short or level II		32		Clock cycles
Short One or More LEDs Protection (Activated and with Fault Flag Indication in $V_{DMODE} = 2V$)						
LED short threshold	V_{LED_SHORT}	Level I, $ V_{LEDSC1} - V_{LEDSC2} $ rising	20	80	150	mV
		Level II, $ V_{LEDSC1} - V_{LEDSC2} $ rising	70	180	270	mV
LED short fault activation delay time (counter increases only when dimming is on)	$t_{LED_SHORT_DELAY}$	Level I		4096		Clock cycles
		Level II		32		Clock cycles
Thermal Shutdown						
Thermal shutdown threshold ⁽⁶⁾	T_{SD}	T_J rising		170		$^{\circ}C$
Thermal shutdown hysteresis ⁽⁶⁾	T_{HYS}			20		$^{\circ}C$
Fault Recovery Timer						
Hiccup delay time (counter increases when dimming is on)	t_{HICCUP}	After a fault status is activated, except OTP		8192		Clock cycles
Fault Flag (Open Drain)						
/FLT output low voltage	V_{FLT_L}	$I_{FLT_SINK} = 1mA$			200	mV
/FLT leakage current	I_{FLT_LKG}	$V_{FLT} = 5V$			1	μA

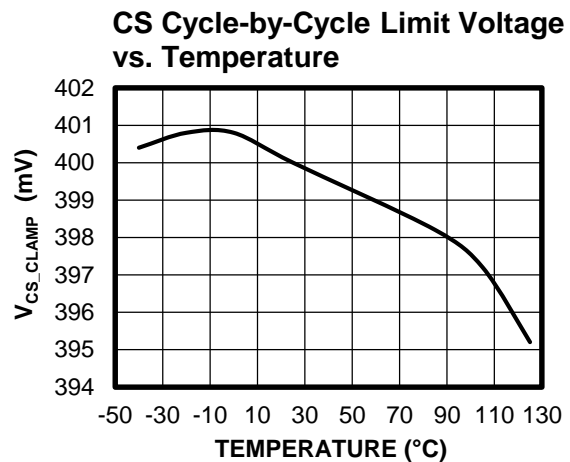
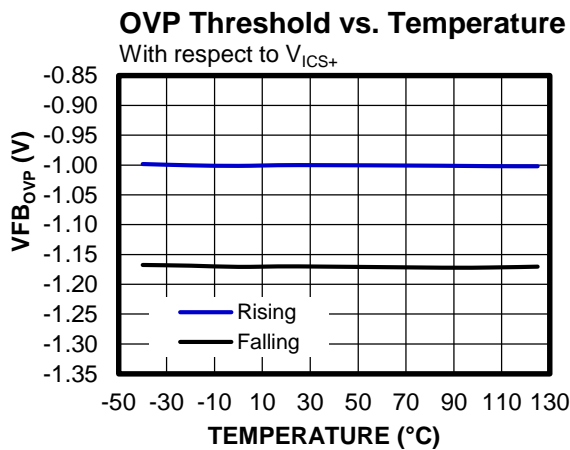
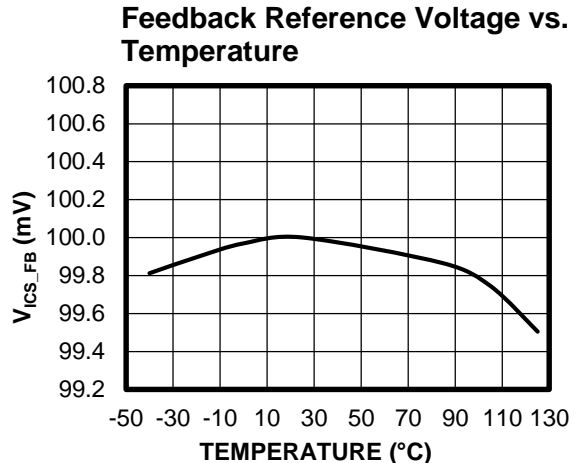
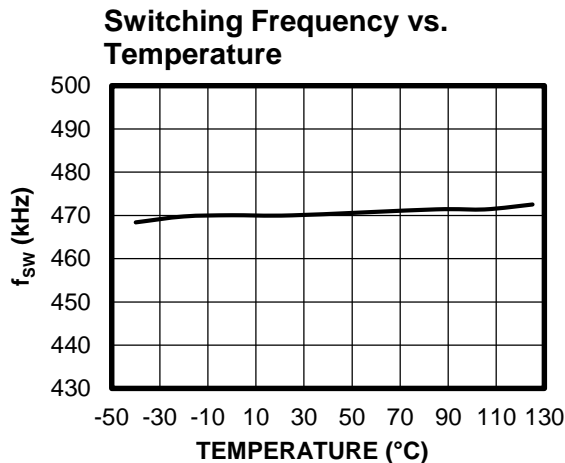
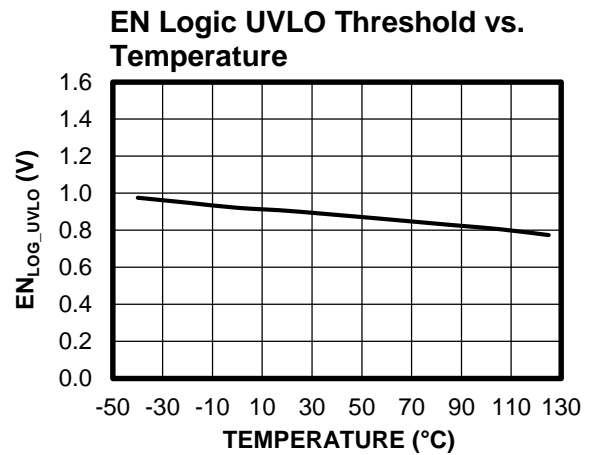
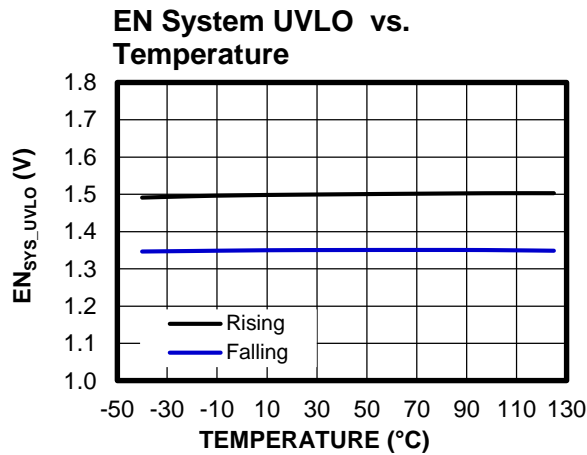
Note:

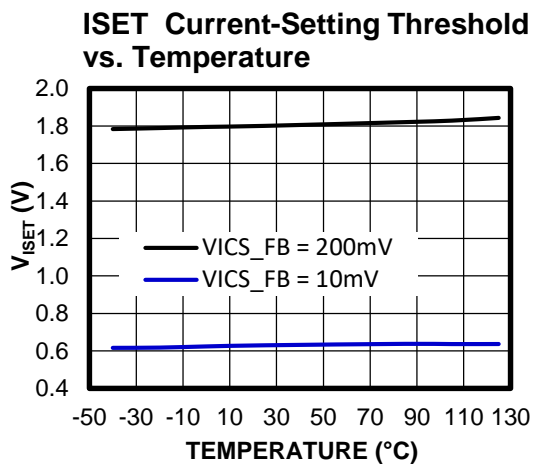
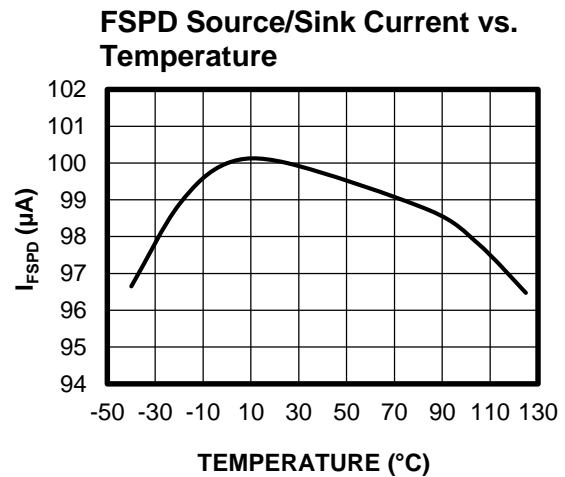
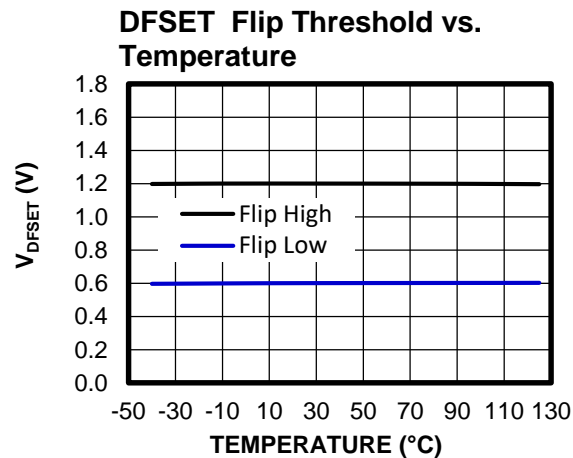
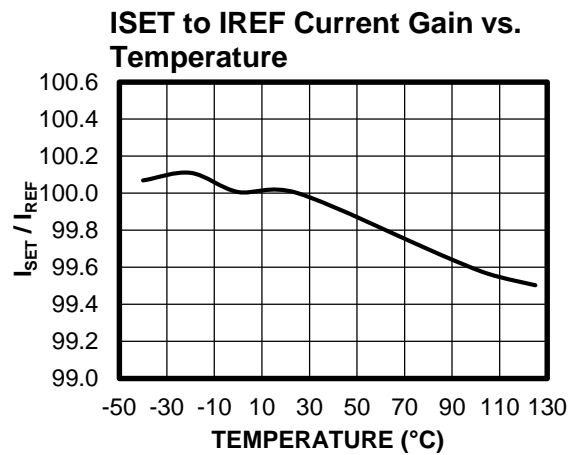
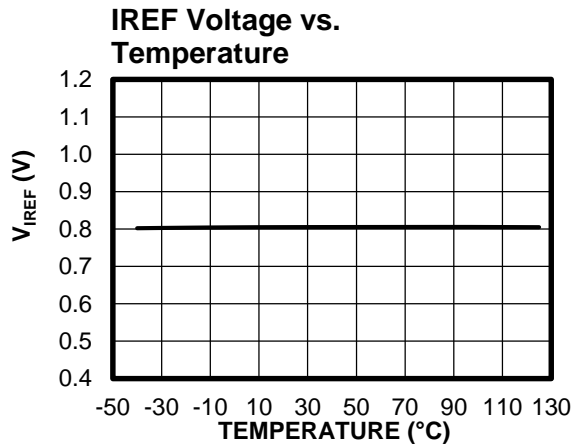
6) Not tested in production. Guaranteed by design and characterization.

TYPICAL CHARACTERISTICS

$V_{IN} = 12V$, $T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted.

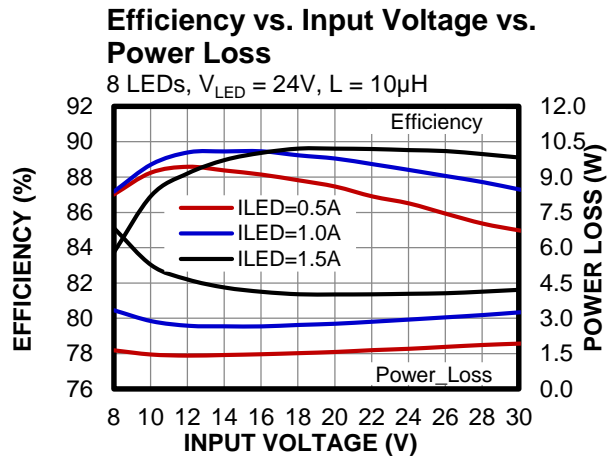


TYPICAL CHARACTERISTICS (continued)
 $V_{IN} = 12V$, $T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted.


TYPICAL CHARACTERISTICS (continued)
 $V_{IN} = 12V$, $T_J = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted.


TYPICAL PERFORMANCE CHARACTERISTICS

Buck-boost mode, 8 LEDs ($V_{LED} = 24V$), $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

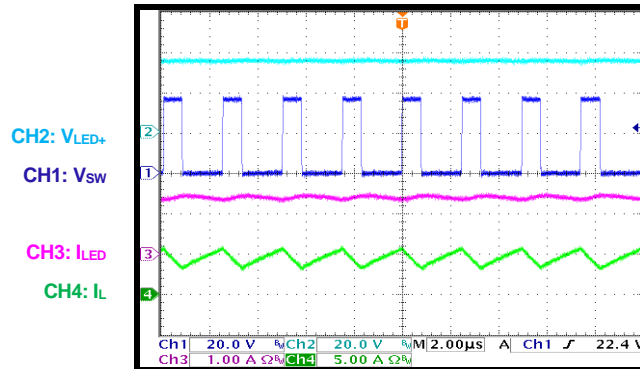


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

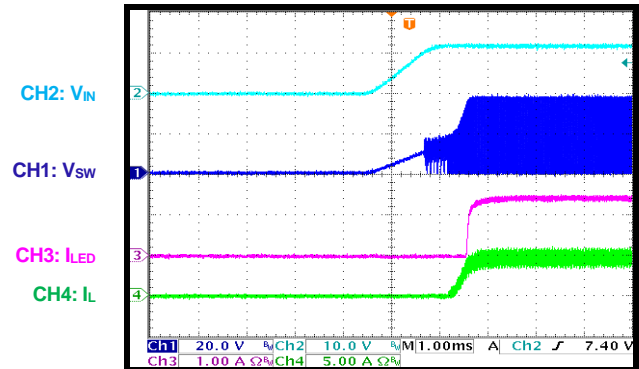
Steady State

$I_{LED} = 1.5A$



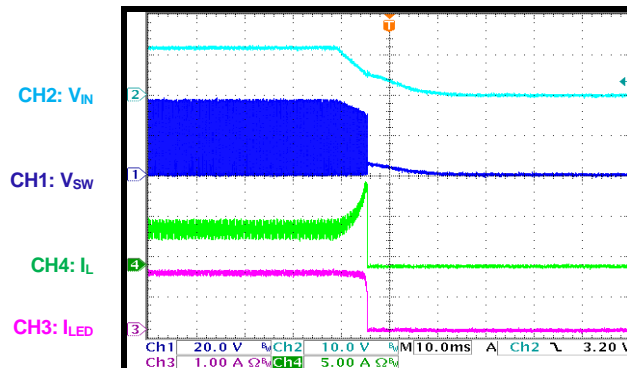
Start-Up through VIN

$I_{LED} = 1.5A$



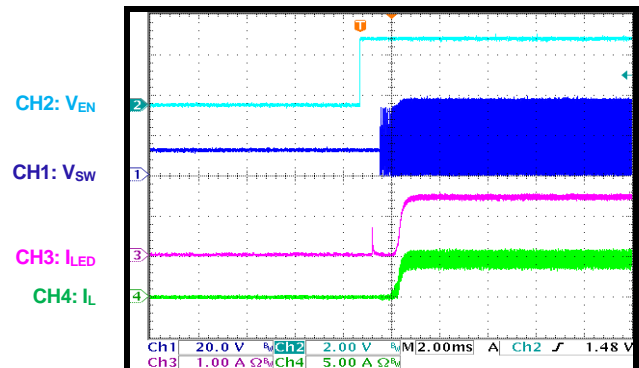
Shutdown through VIN

$I_{LED} = 1.5A$



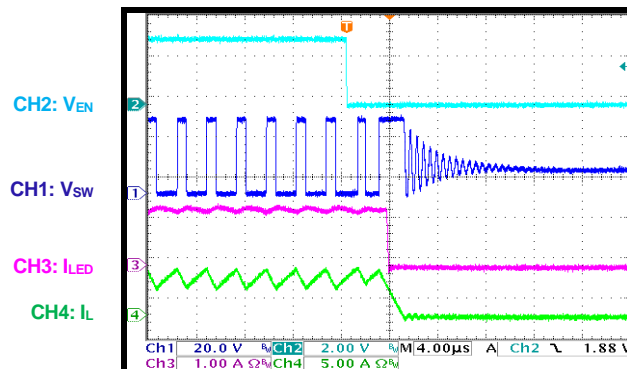
Start-Up through EN

$I_{LED} = 1.5A$



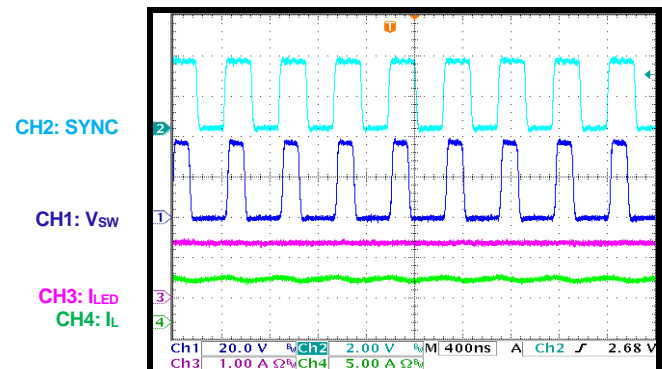
Shutdown through EN

$I_{LED} = 1.5A$



SYNC Function

SYNC frequency = 2.2MHz, steady state

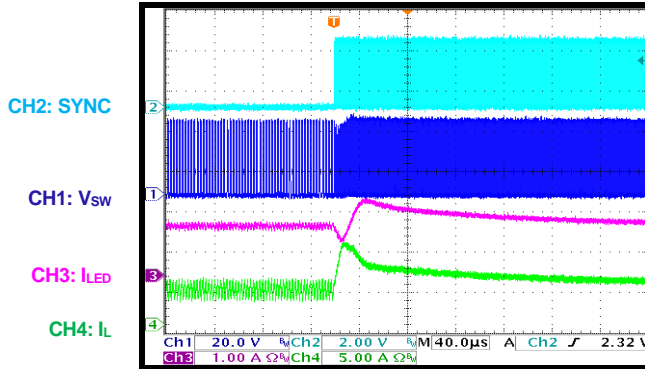


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

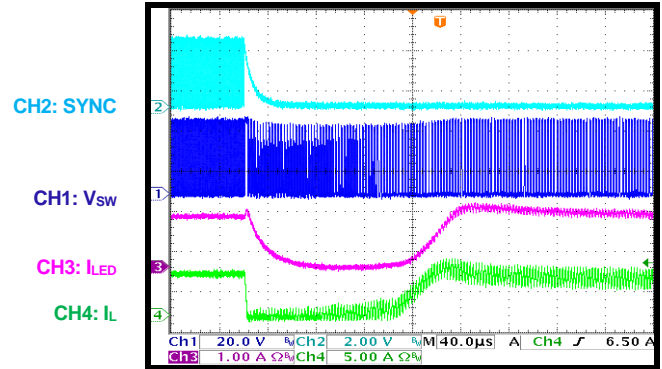
SYNC In

SYNC frequency = 2.2MHz



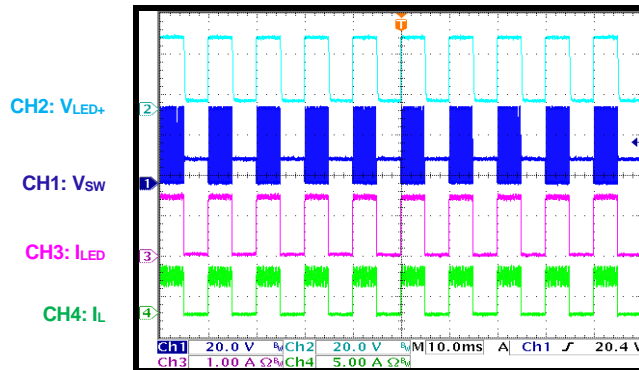
SYNC Out

SYNC frequency = 2.2MHz



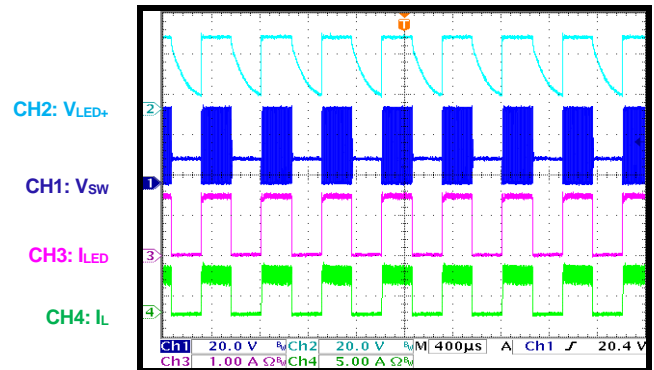
PWM Dimming

Dimming frequency = 100Hz, steady state



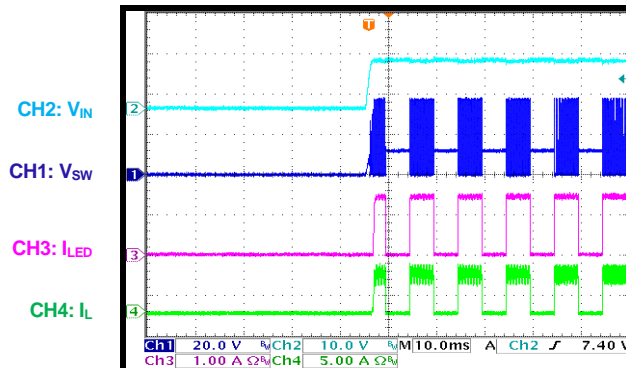
PWM Dimming

Dimming frequency = 2kHz, steady state



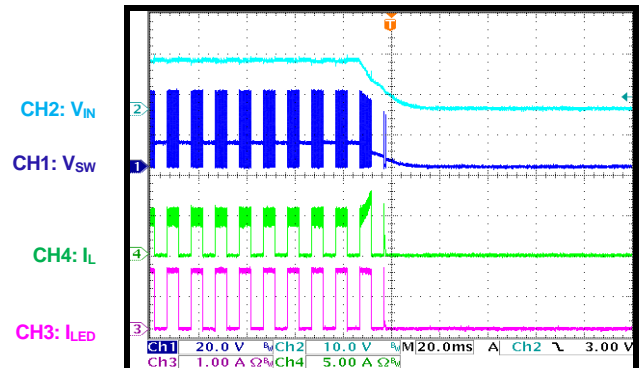
PWM Dimming

Start-up through VIN



PWM Dimming

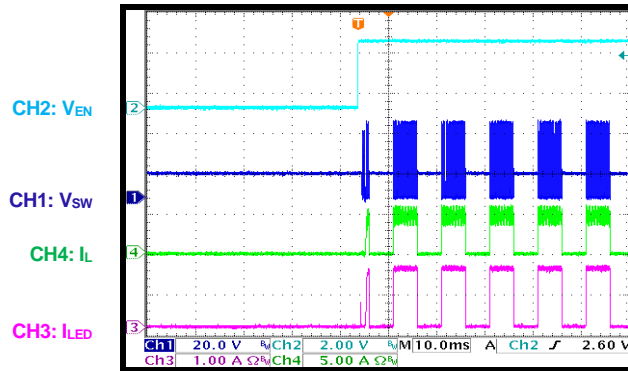
Shutdown through VIN



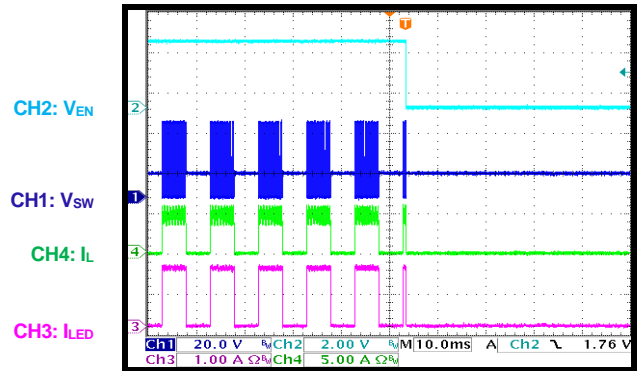
TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

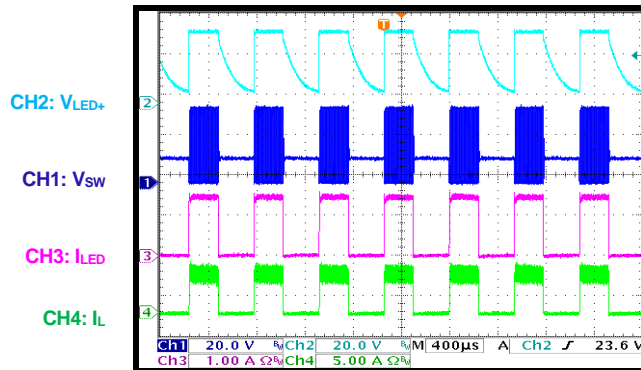
PWM Dimming
Start-up through EN



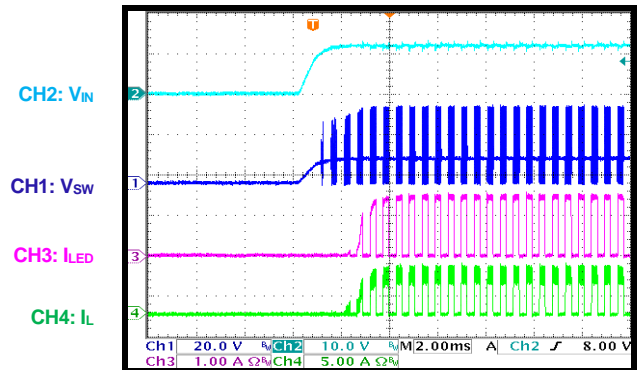
PWM Dimming
Shutdown through EN



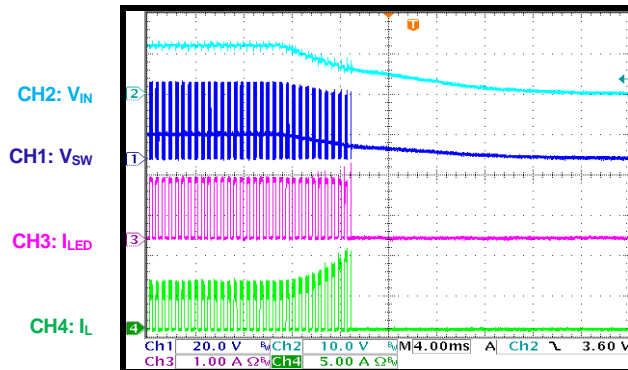
Two-Step Dimming
Dimming frequency = 1.8kHz, steady state



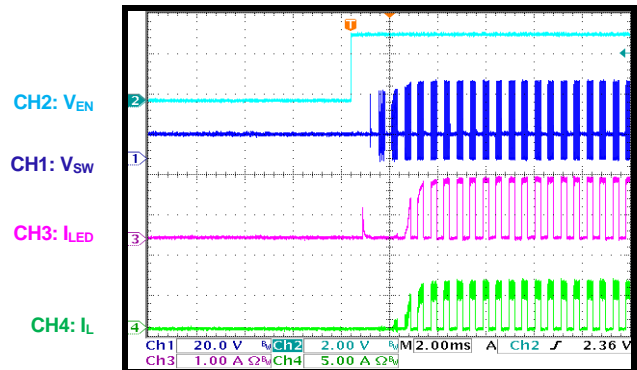
Two-Step Dimming
Start-up through VIN



Two-Step Dimming
Shutdown through VIN



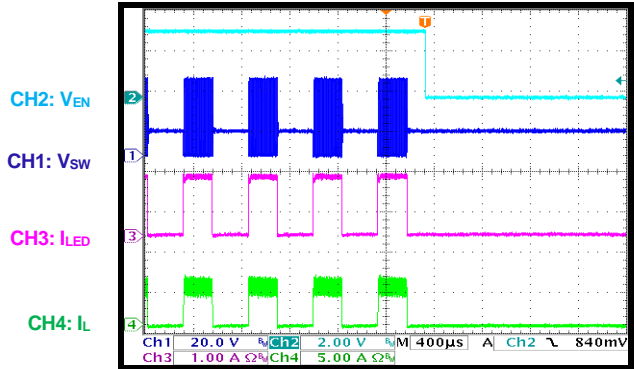
Two-Step Dimming
Start-up through EN



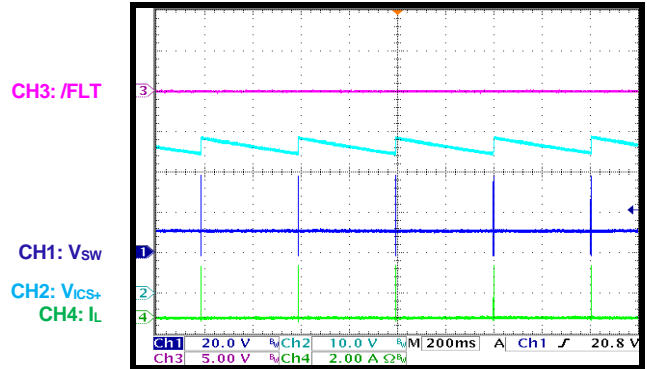
TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

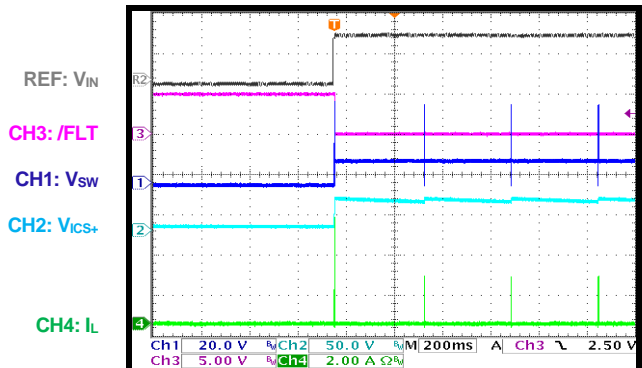
Two-Step Dimming
Shutdown through EN



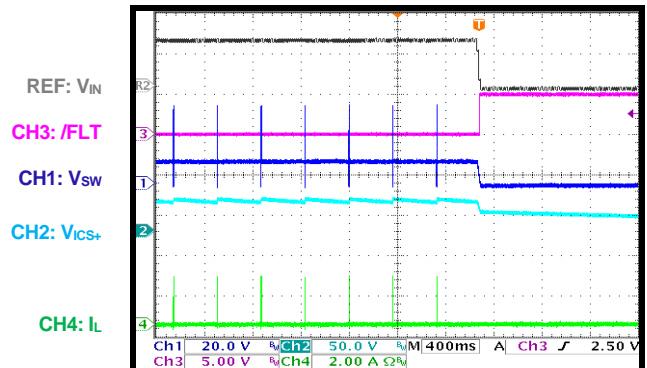
No Dimming
LED open fault, steady state



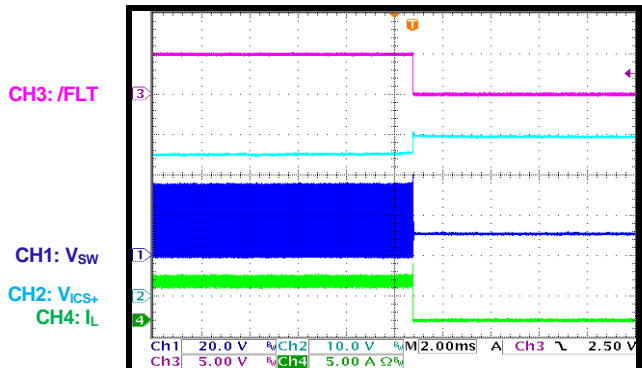
No Dimming
LED open fault, start-up



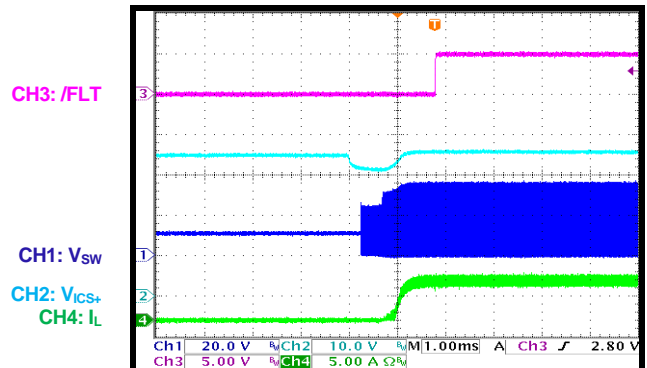
No Dimming
LED open fault, shutdown



No Dimming
LED open fault entry



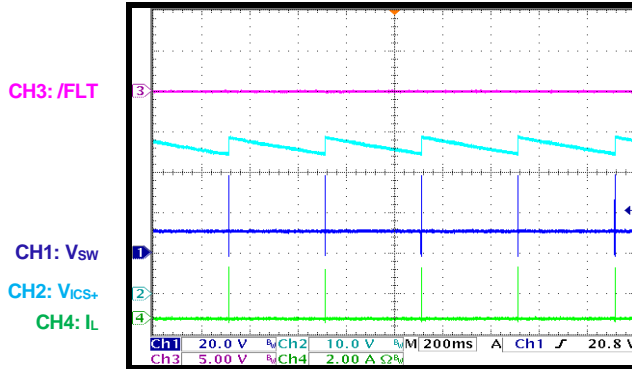
No Dimming
LED open fault recovery



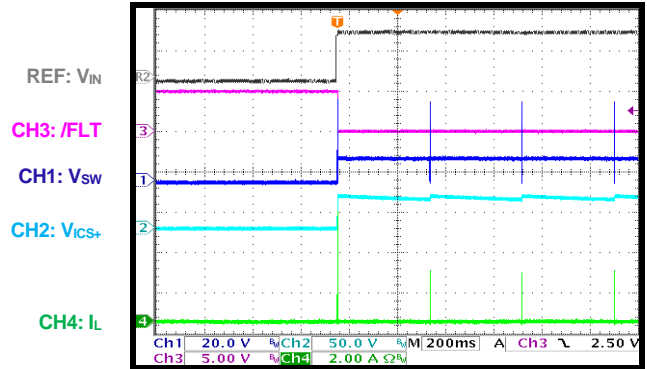
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

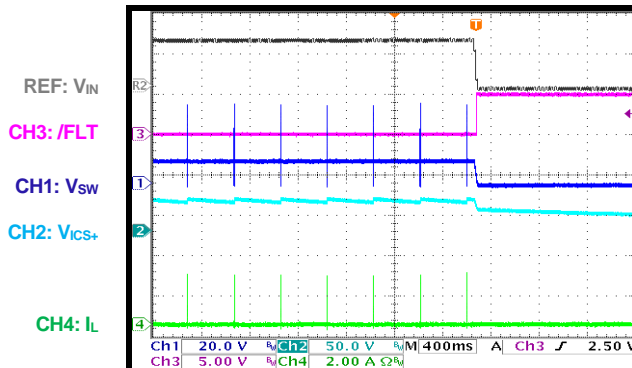
PWM Dimming
LED open fault, steady state



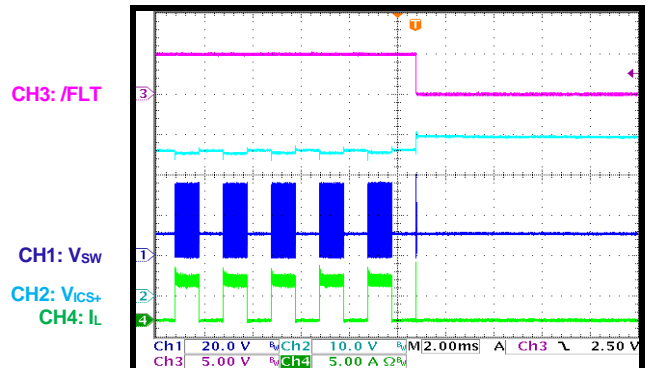
PWM Dimming
LED open fault, start-up



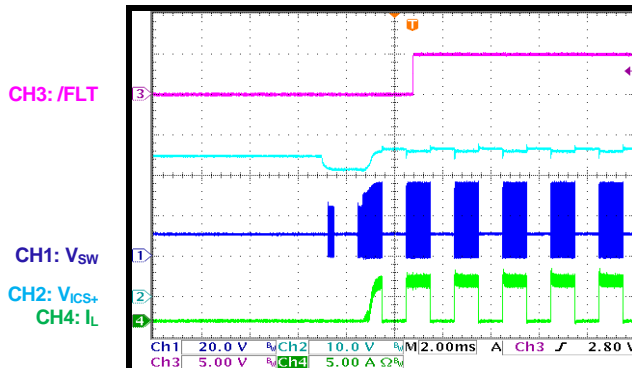
PWM Dimming
LED open fault, shutdown



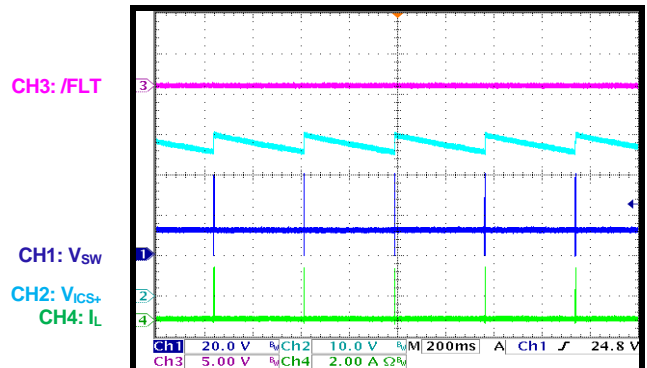
PWM Dimming
LED open fault entry



PWM Dimming
LED open fault recovery

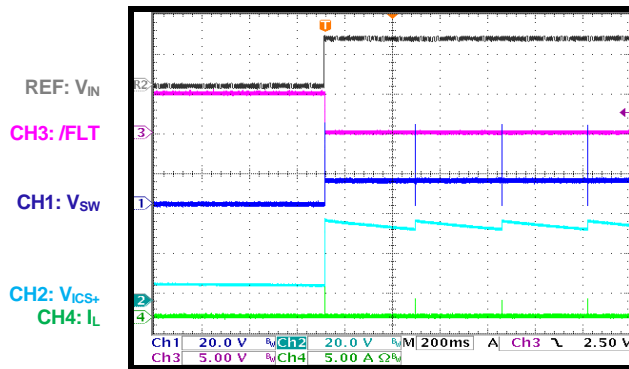
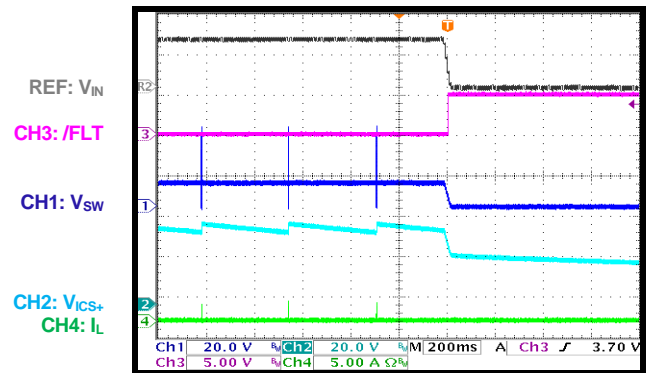
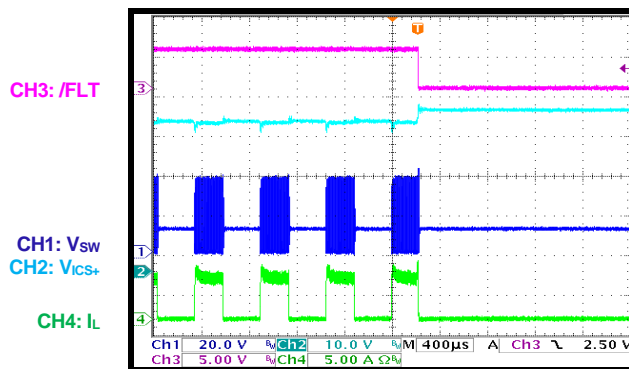
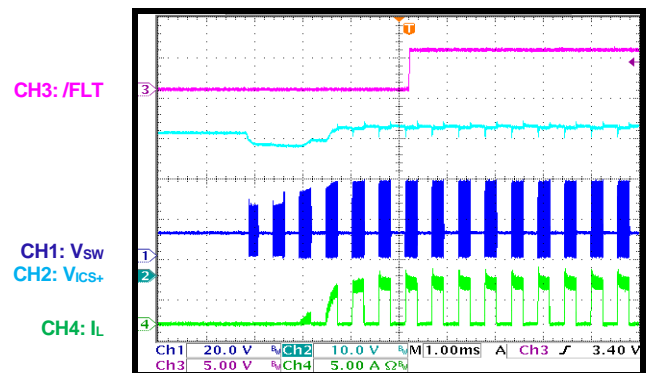
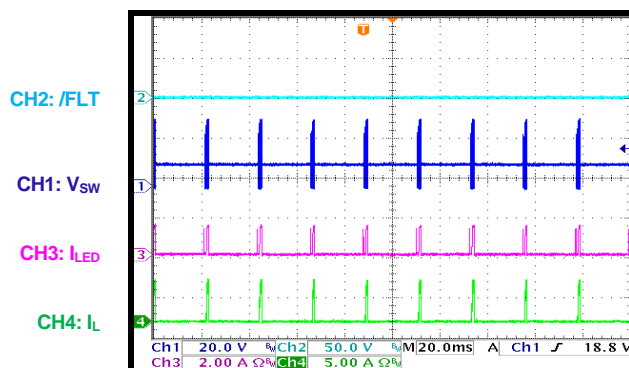
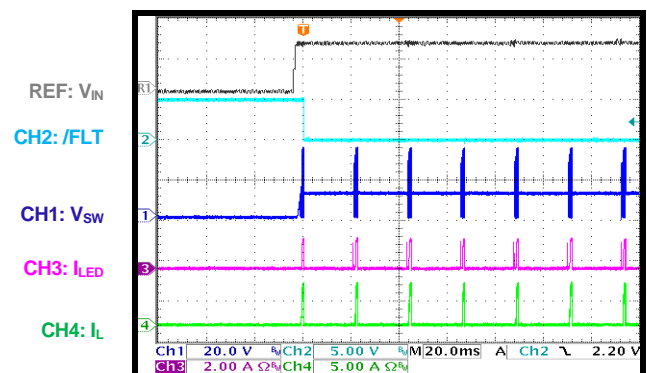


Two-Step Dimming
LED open fault, steady state



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Buck-boost mode, 8 LEDs ($V_{LED} = 24V$), $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

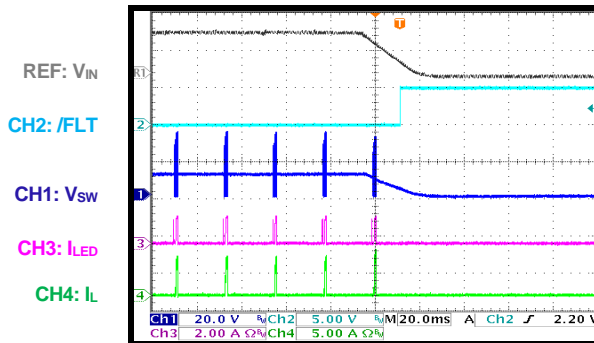
Two-Step Dimming
 LED open fault, start-up

Two-Step Dimming
 LED open fault, shutdown

Two-Step Dimming
 LED open fault entry

Two-Step Dimming
 LED open fault recovery

No Dimming
 One or more LED short faults, steady state

No Dimming
 One or more LED short faults, start-up


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

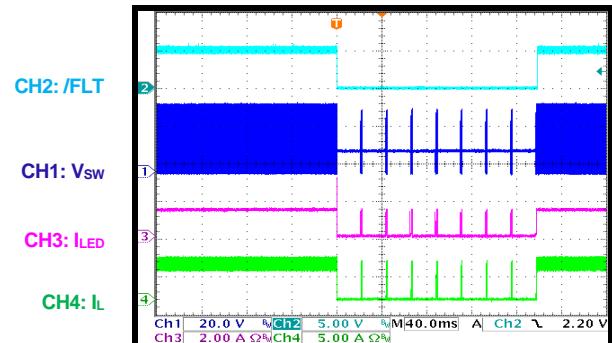
No Dimming

One or more LED short faults, shutdown



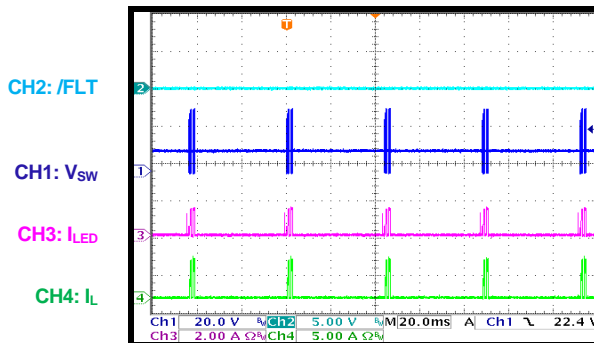
No Dimming

One or more LED short faults entry and recovery



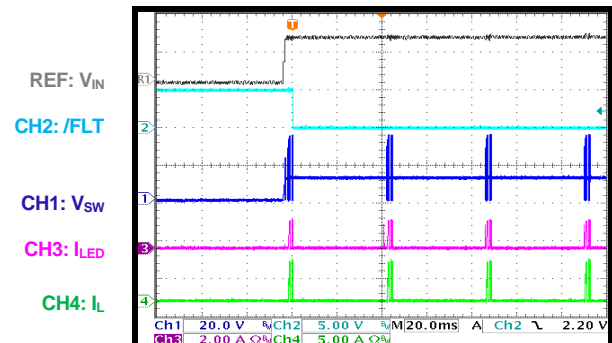
PWM Dimming

One or more LED short faults, steady state



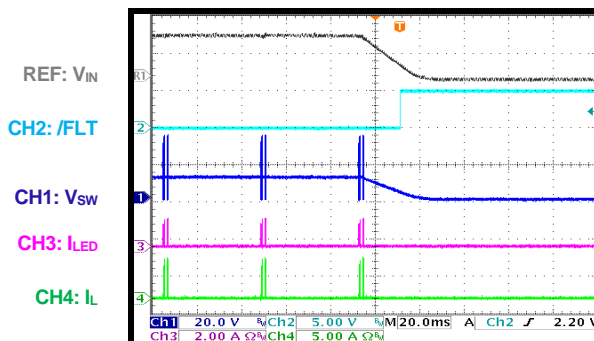
PWM Dimming

One or more LED short faults, start-up



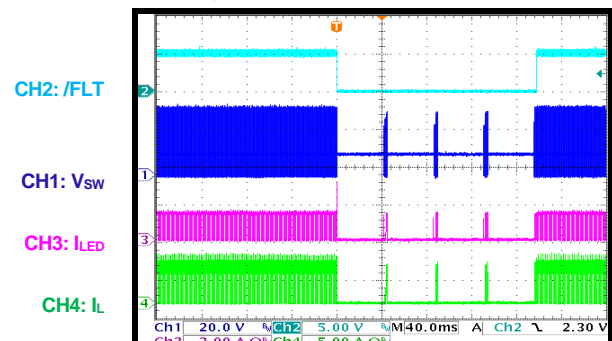
PWM Dimming

One or more LED short faults, shutdown



PWM Dimming

One or more LED short faults entry and recovery

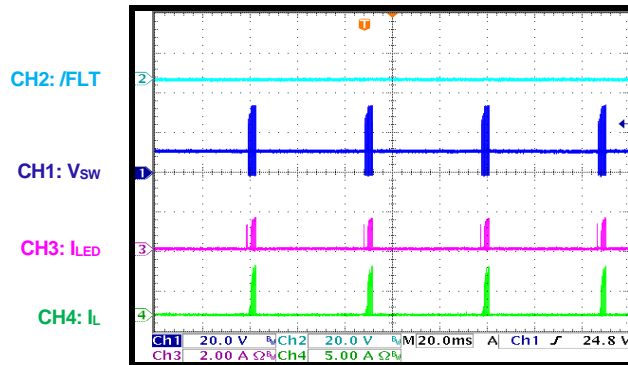


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

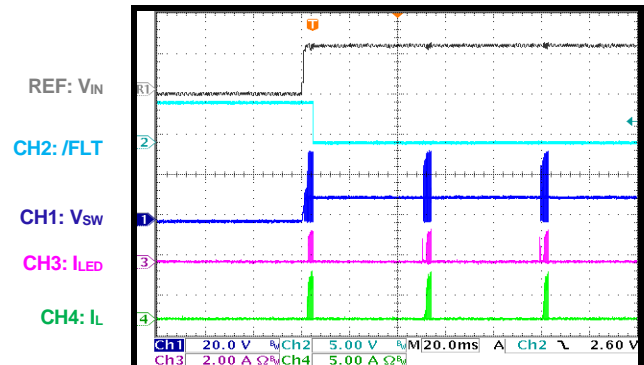
Two-Step Dimming

One or more LED short faults, steady state



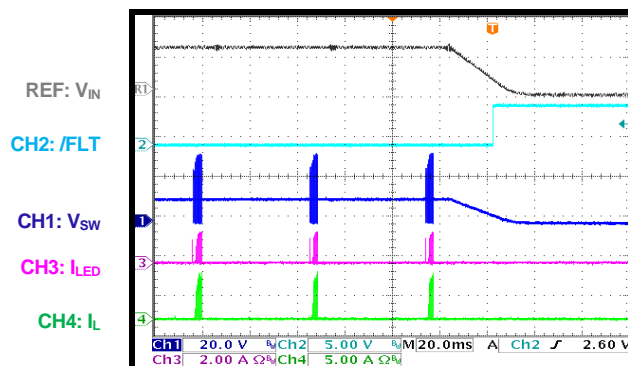
Two-Step Dimming

One or more LED short faults, start-up



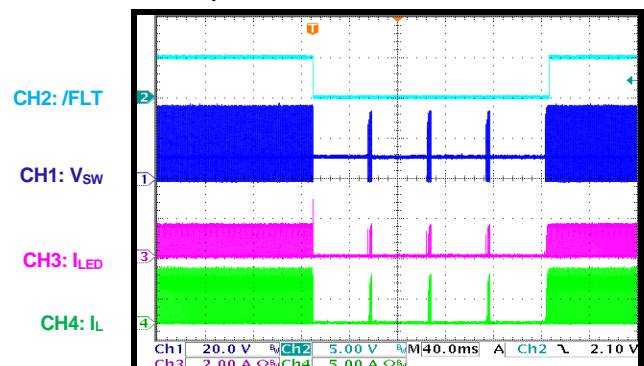
Two-Step Dimming

One or more LED short faults, shutdown



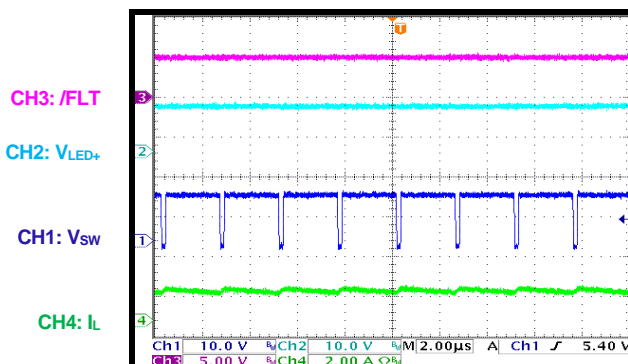
Two-Step Dimming

One or more LED short faults entry and recovery



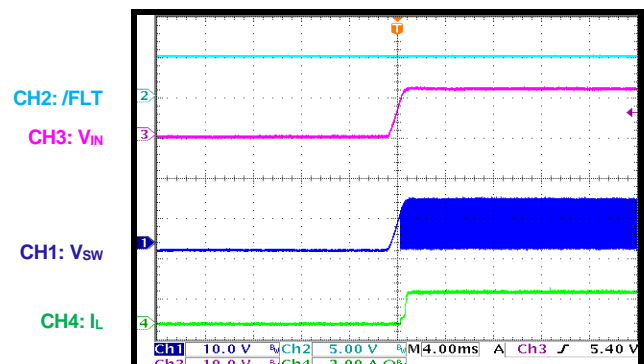
No Dimming

LED+ to LED- short, steady state



No Dimming

LED+ to LED- short, start-up

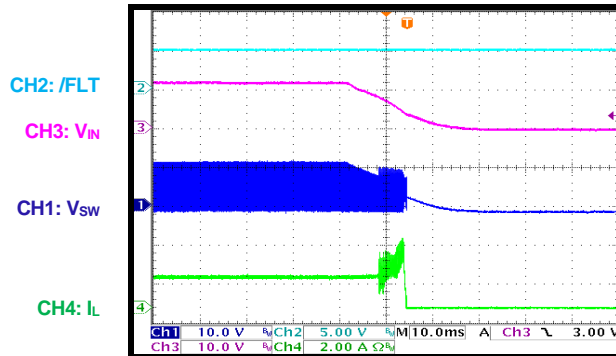


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

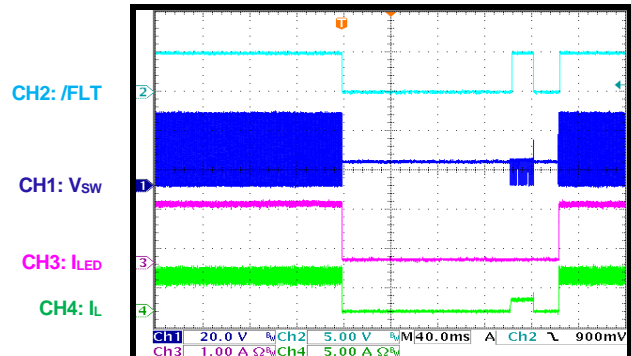
 Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

No Dimming

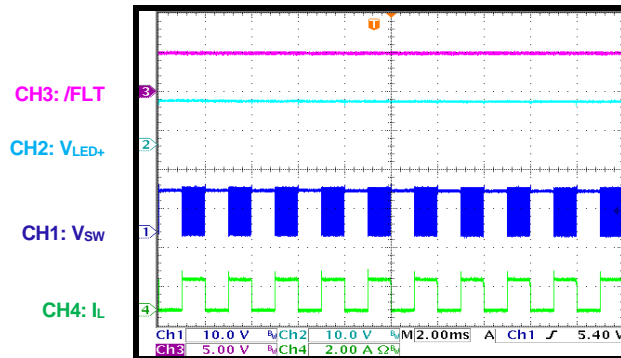
LED+ to LED- short, shutdown


No Dimming

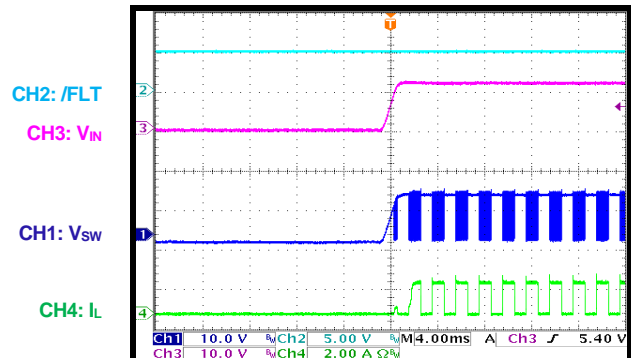
LED+ to LED- short entry and recovery


PWM Dimming

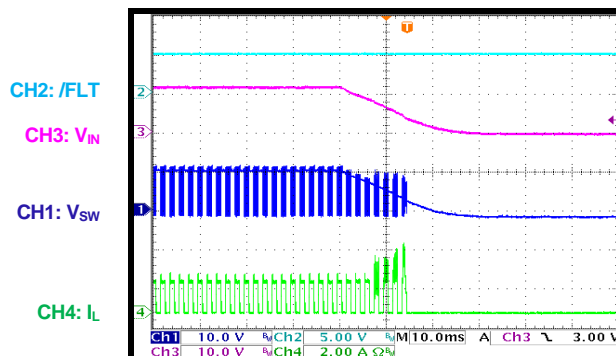
LED+ to LED- short, steady state


PWM Dimming

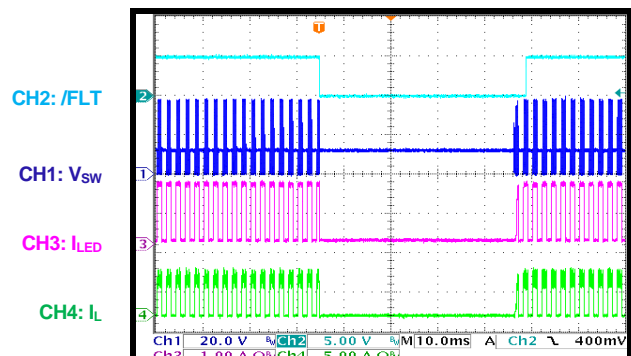
LED+ to LED- short, start-up


PWM Dimming

LED+ to LED- short, shutdown

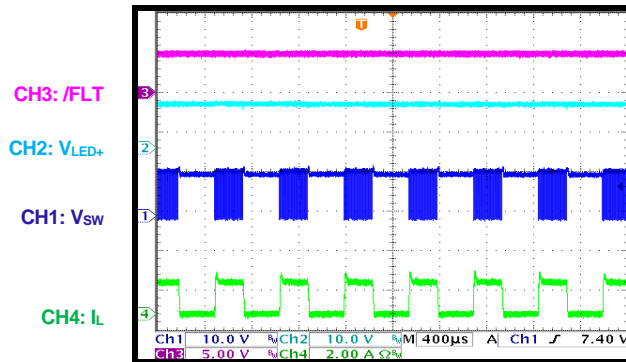
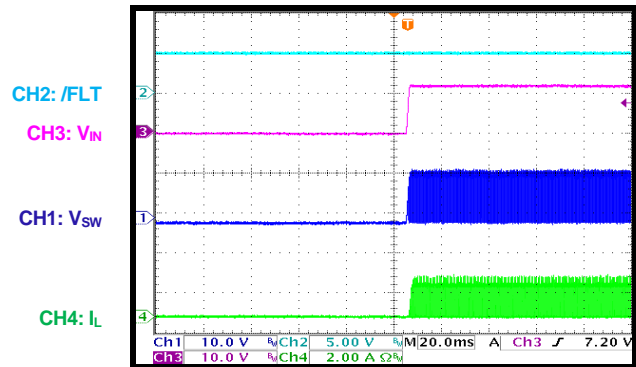
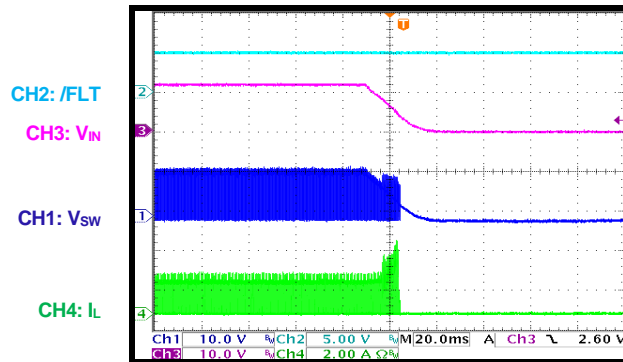
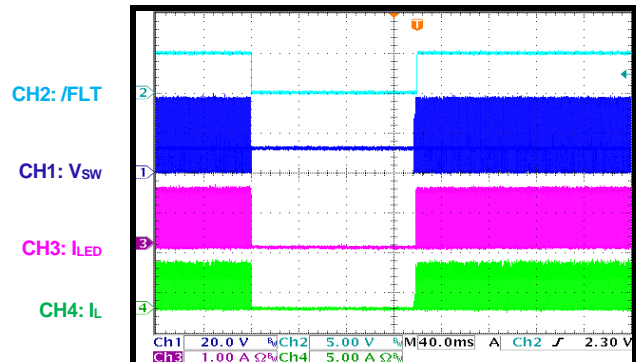
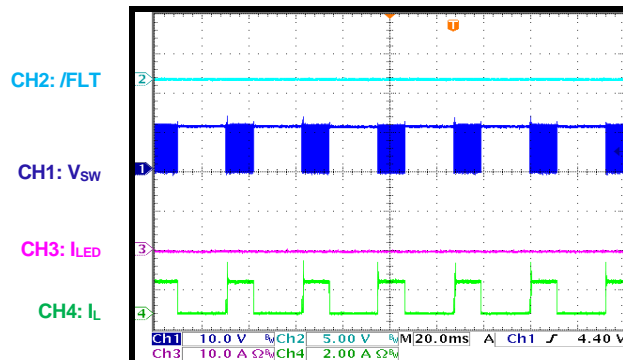
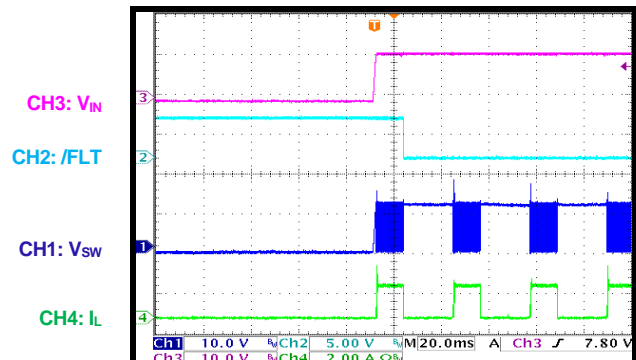

PWM Dimming

LED+ to LED- short entry and recovery



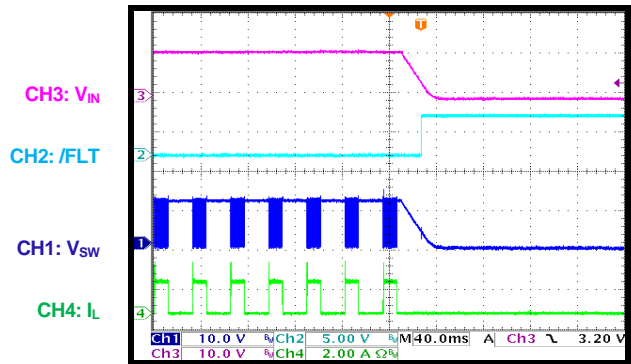
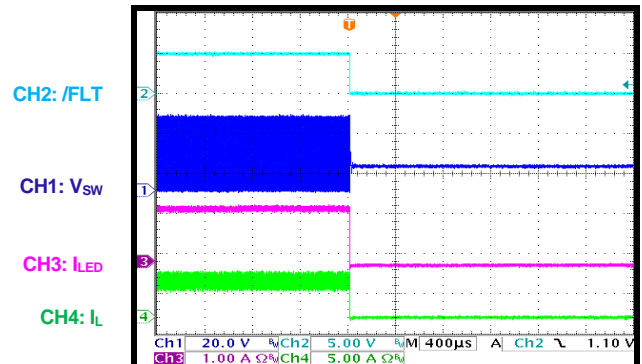
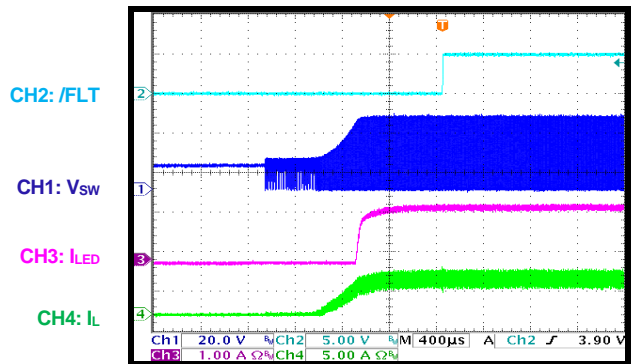
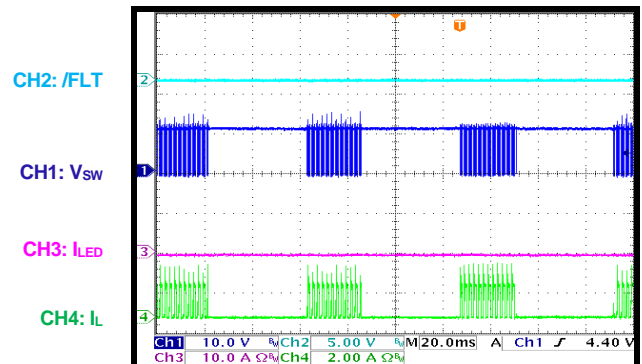
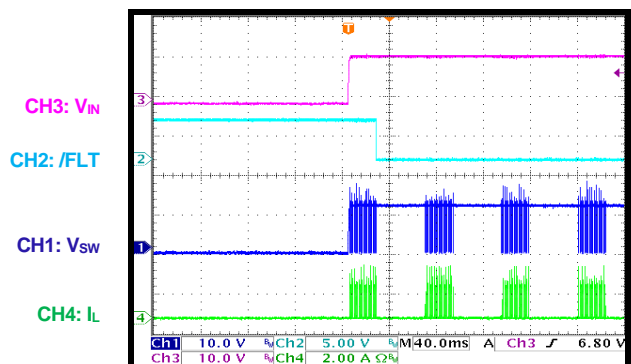
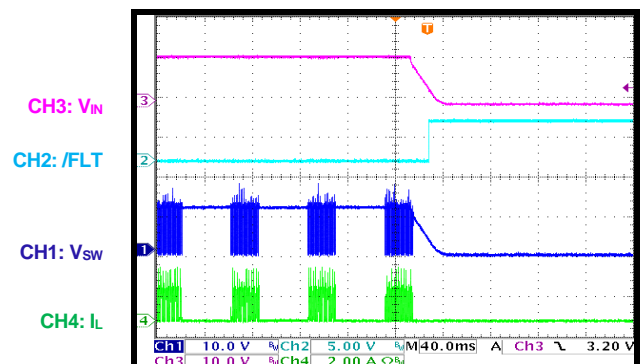
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

Two-Step Dimming
 LED+ to LED- short, steady state

Two-Step Dimming
 LED+ to LED- short, start-up

Two-Step Dimming
 LED+ to LED- short, shutdown

Two-Step Dimming
 LED+ to LED- short entry and recovery

No Dimming
 LED+ to PGND short, steady state

No Dimming
 LED+ to PGND short, start-up


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

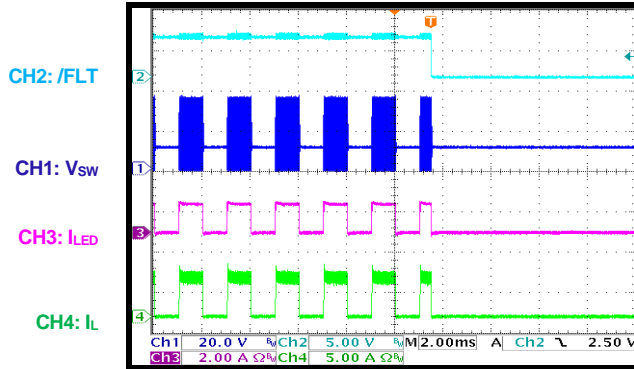
No Dimming
 LED+ to PGND short, shutdown

No Dimming
 LED+ to PGND short entry

No Dimming
 LED+ to PGND short recovery

PWM Dimming
 LED+ to PGND short, steady state

PWM Dimming
 LED+ to PGND short, start-up

PWM Dimming
 LED+ to PGND short, shutdown


TYPICAL PERFORMANCE CHARACTERISTICS

Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

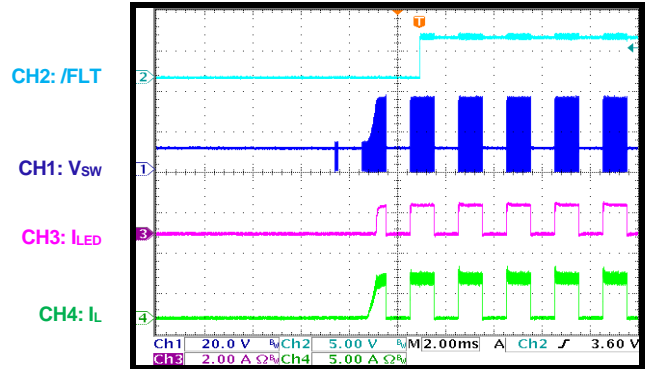
PWM Dimming

LED+ to PGND short entry



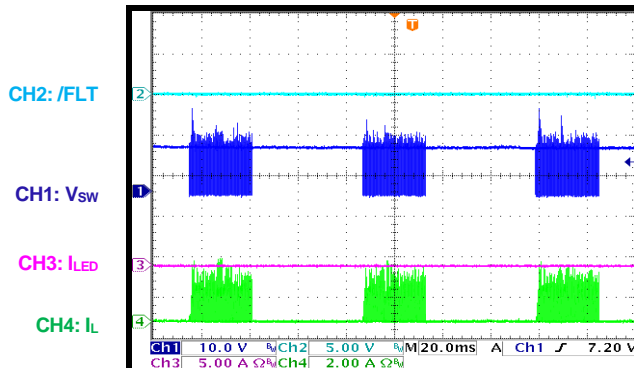
PWM Dimming

LED+ to PGND short recovery



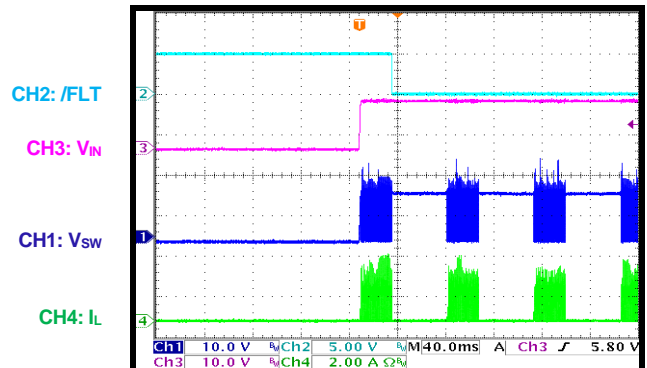
Two-Step Dimming

LED+ to PGND short, steady state



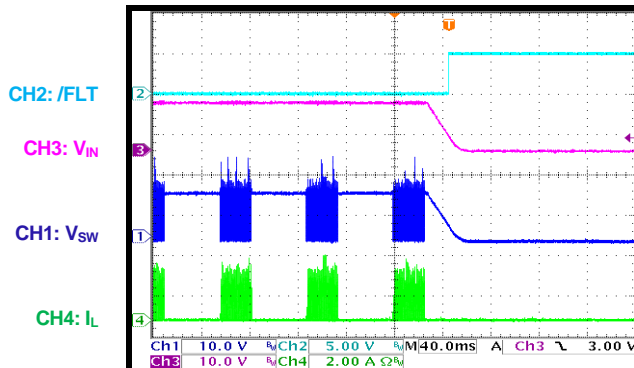
Two-Step Dimming

LED+ to PGND short, start-up



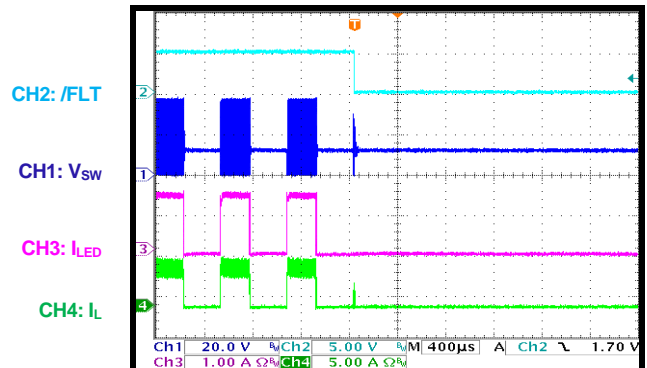
Two-Step Dimming

LED+ to PGND short, shutdown



Two-Step Dimming

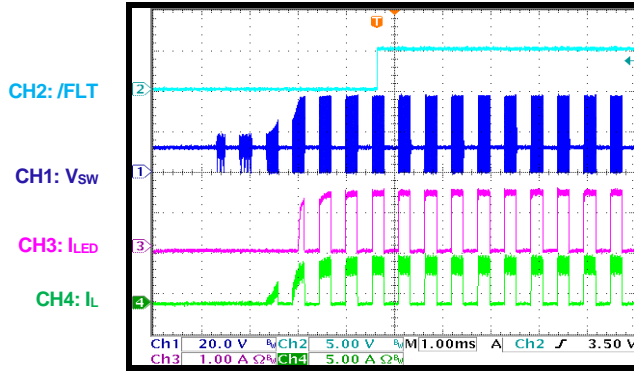
LED+ to PGND short entry



TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

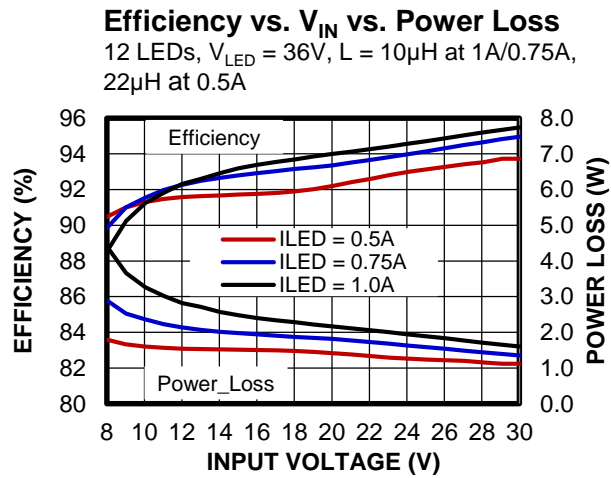
Buck-boost mode, 8 LEDs, $V_{LED} = 24V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

Two-Step Dimming LED+ to PGND short recovery



TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

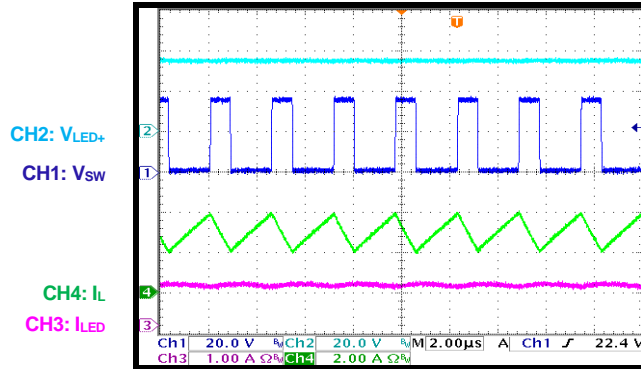


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

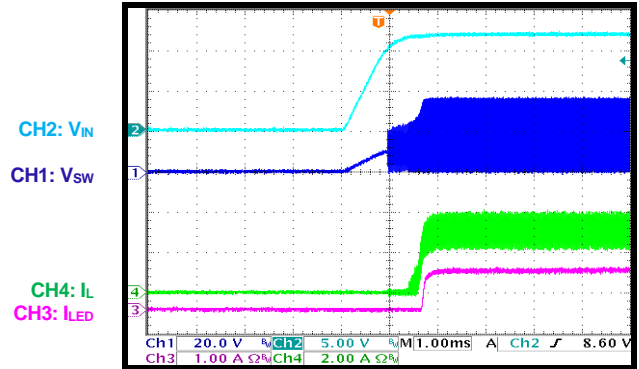
Steady State

$I_{LED} = 1A$



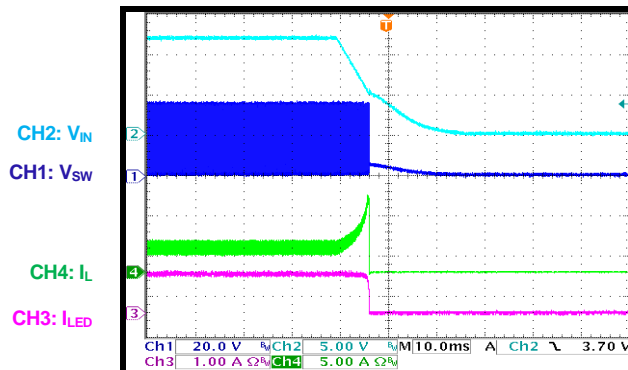
Start-Up through VIN

$I_{LED} = 1A$



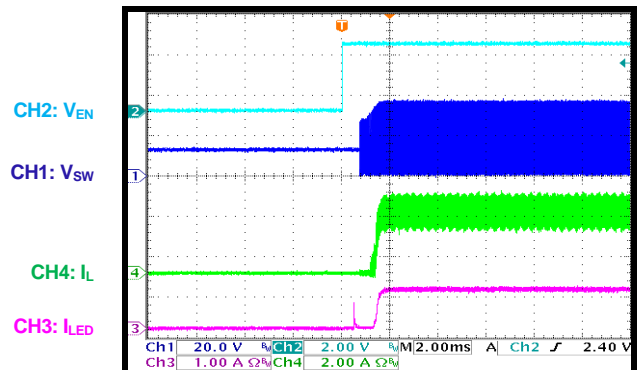
Shutdown through VIN

$I_{LED} = 1A$



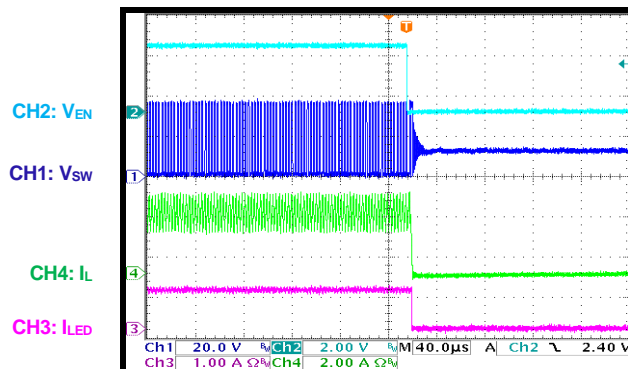
Start-Up through EN

$I_{LED} = 1A$



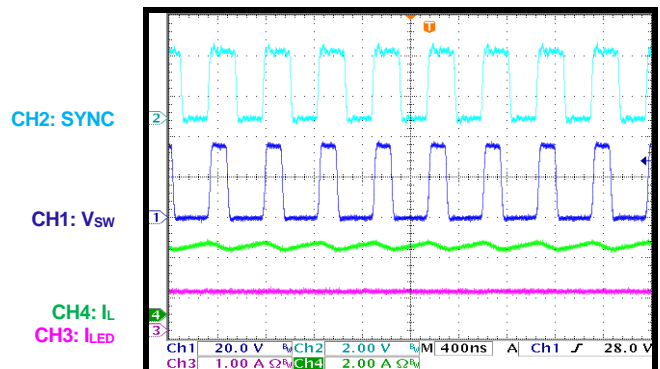
Shutdown through EN

$I_{LED} = 1A$



SYNC Function

SYNC frequency = 2.2MHz, steady state

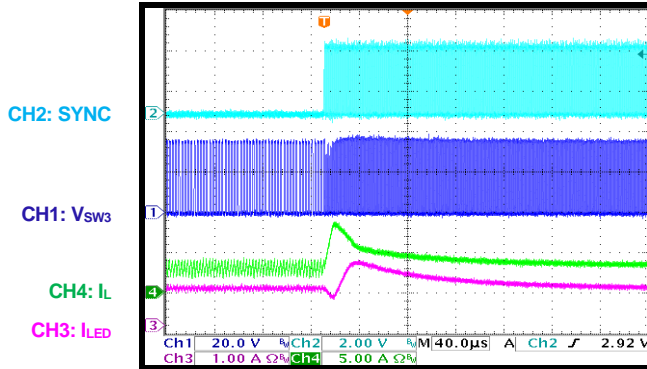


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

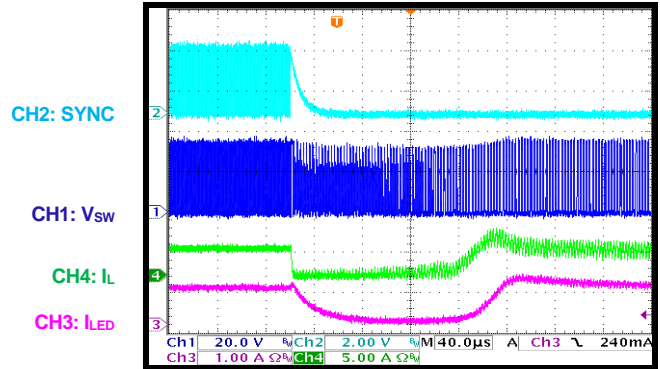
 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

SYNC In

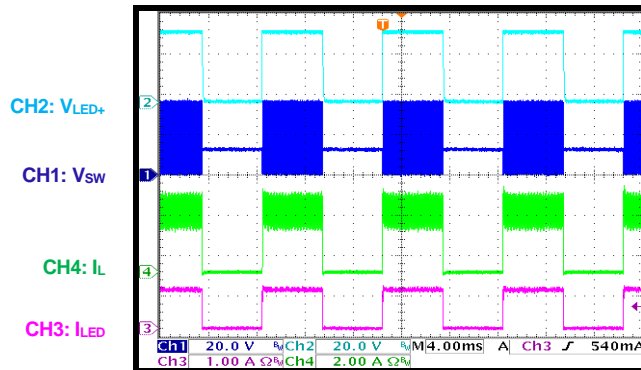
SYNC frequency = 2.2MHz


SYNC Out

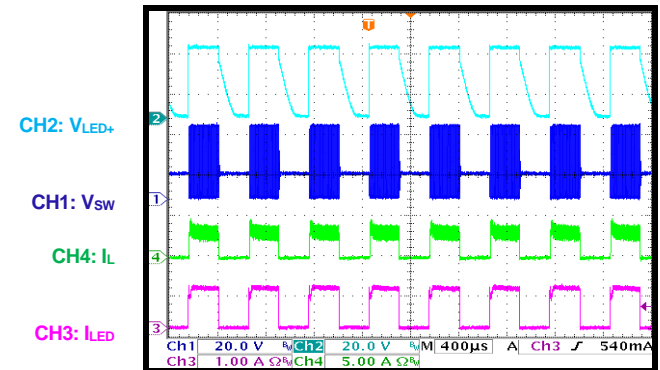
SYNC frequency = 2.2MHz


PWM Dimming

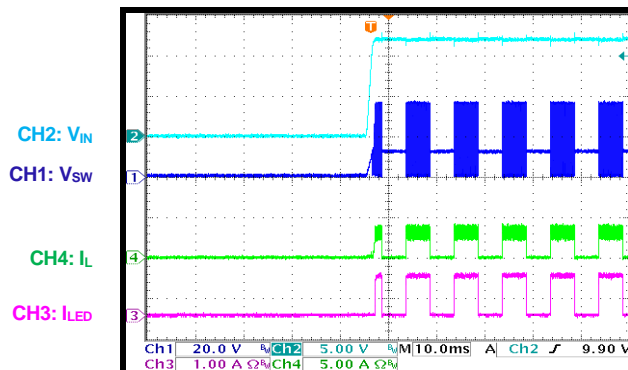
Dimming frequency = 100Hz, steady state


PWM Dimming

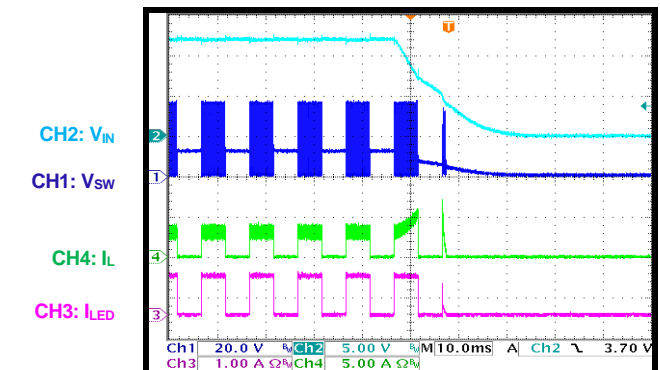
Dimming frequency = 2kHz, steady state


PWM Dimming

Start-up through VIN

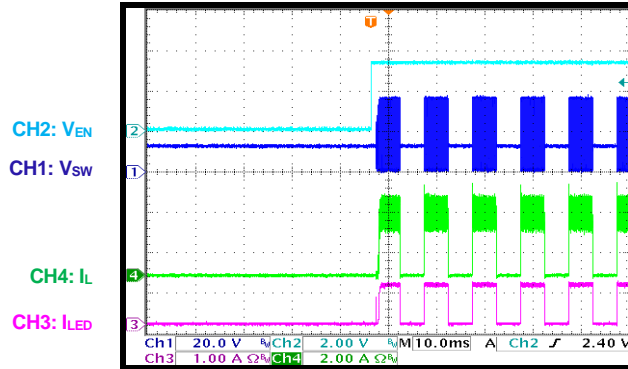
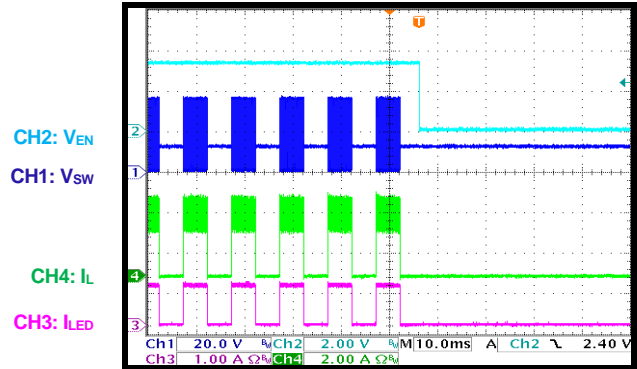
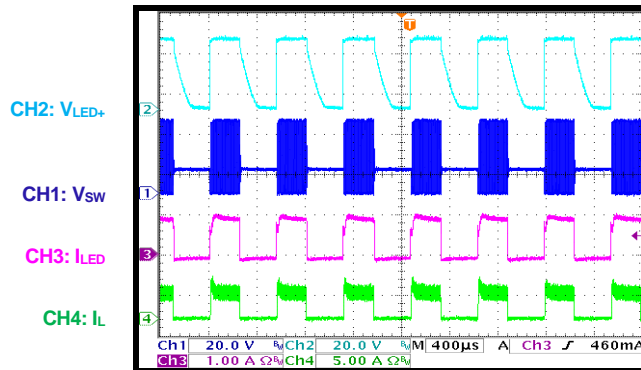
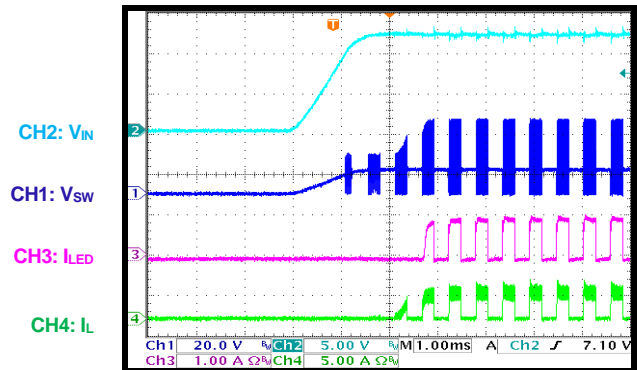
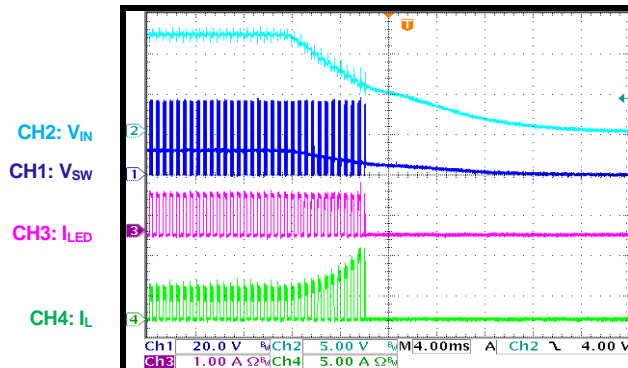
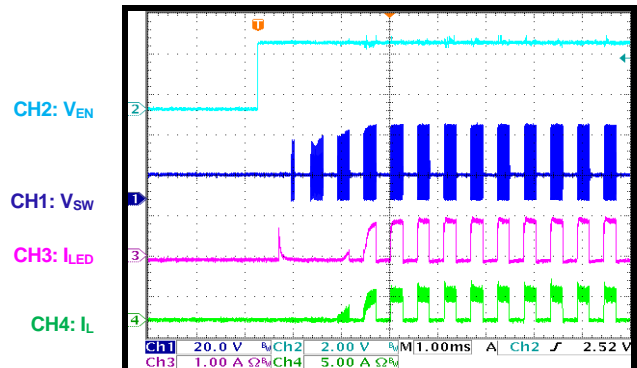

PWM Dimming

Shutdown through VIN



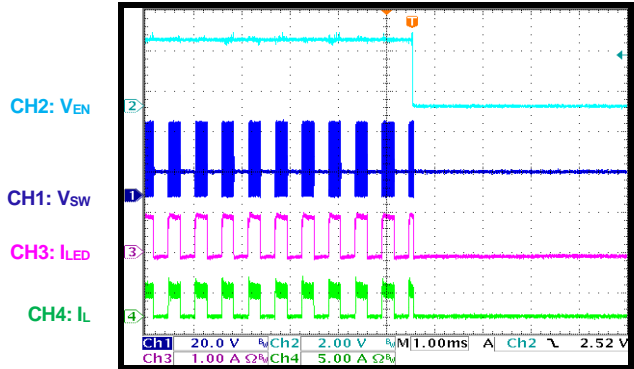
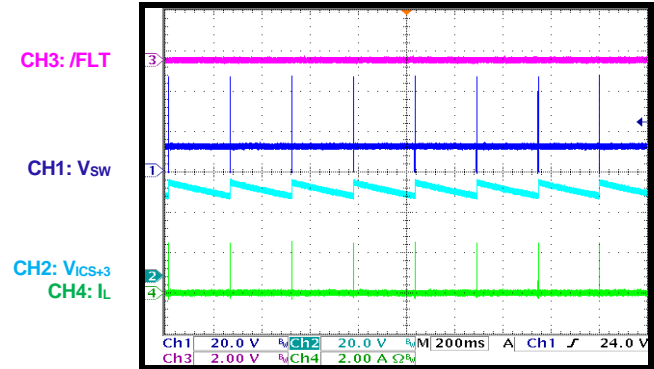
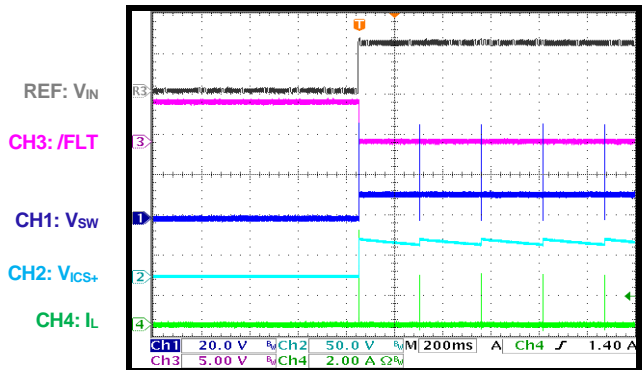
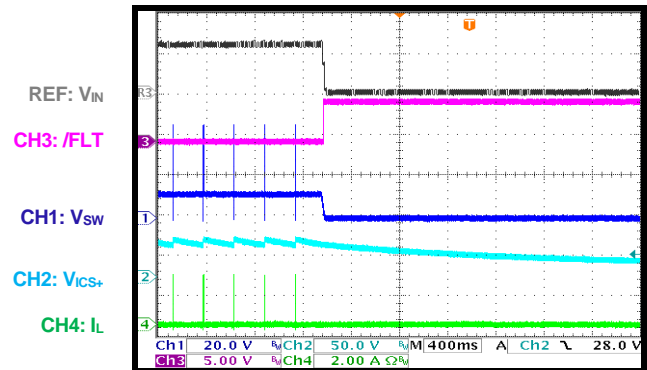
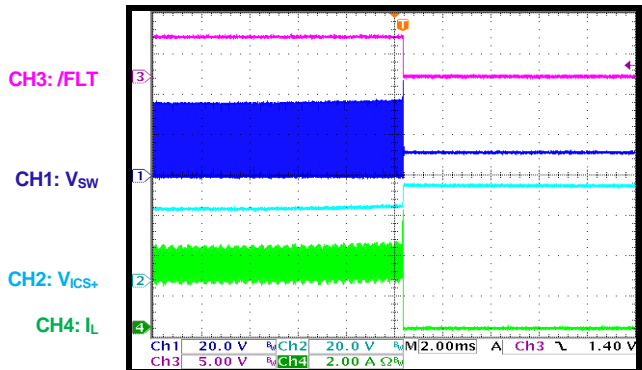
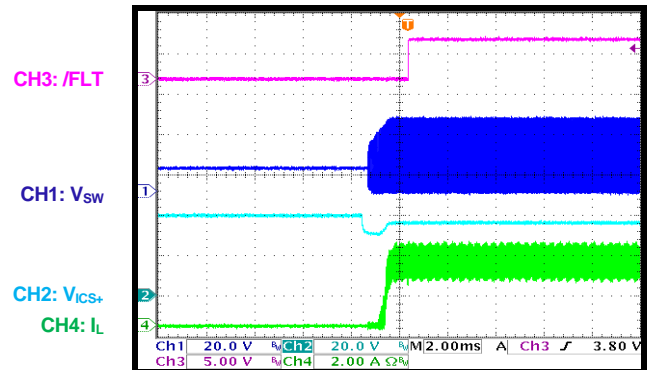
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

PWM Dimming
 Start-up through EN

PWM Dimming
 Shutdown through EN

Two-Step Dimming
 Dimming frequency = 1.8kHz, steady state

Two-Step Dimming
 Start-up through VIN

Two-Step Dimming
 Shutdown through VIN

Two-Step Dimming
 Start-up through EN


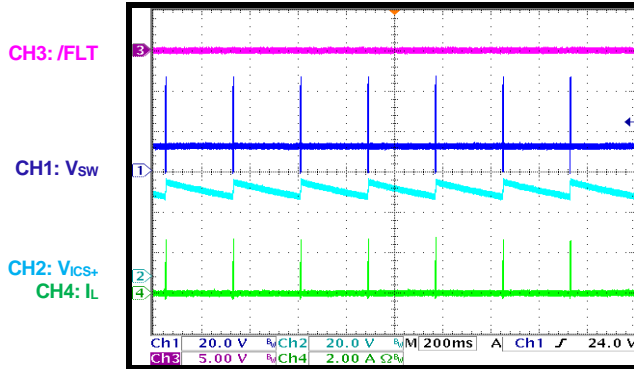
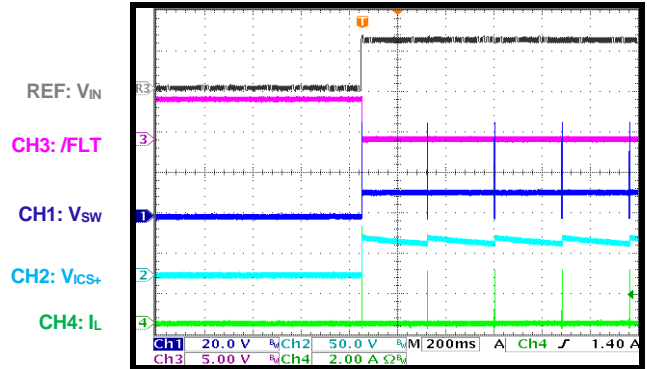
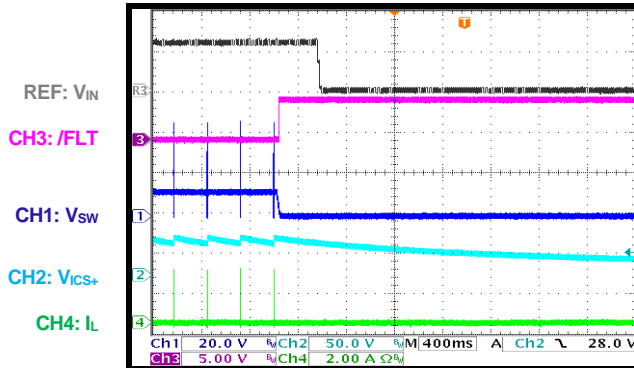
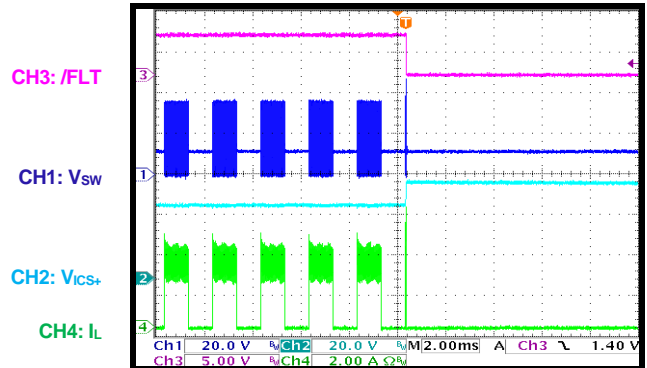
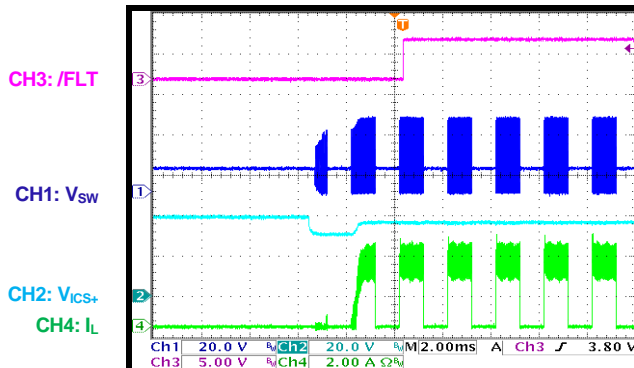
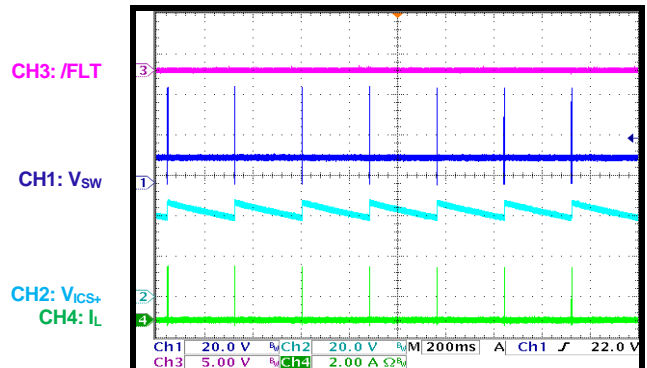
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

Two-Step Dimming
 Shutdown through EN

No Dimming
 LED open, steady state

No Dimming
 LED open fault, start-up

No Dimming
 LED open fault, shutdown

No Dimming
 LED open fault entry

No Dimming
 LED open fault recovery


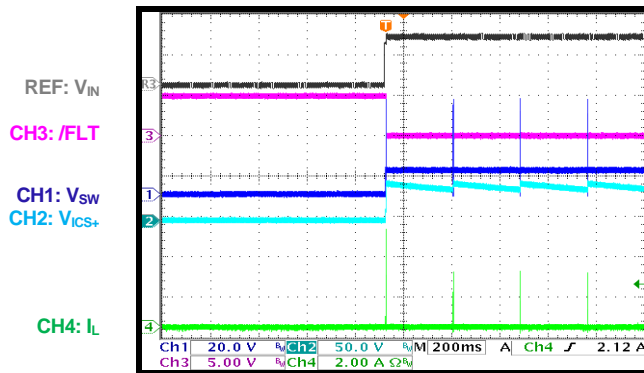
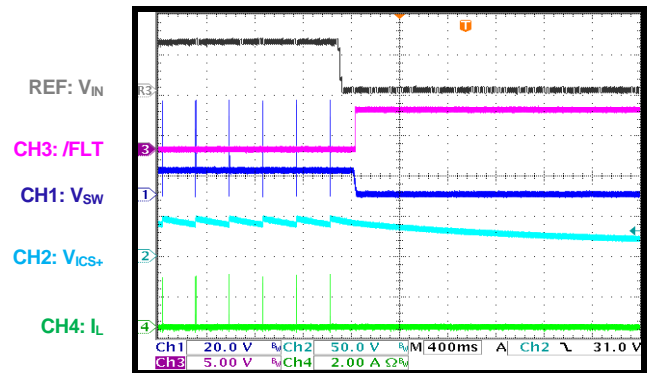
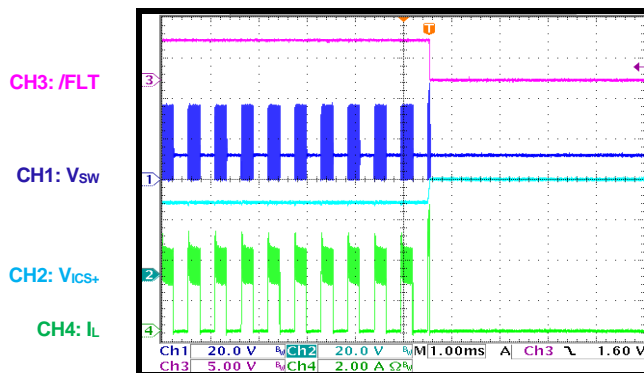
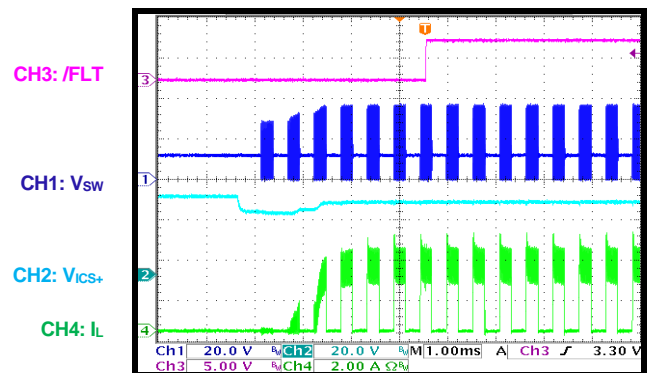
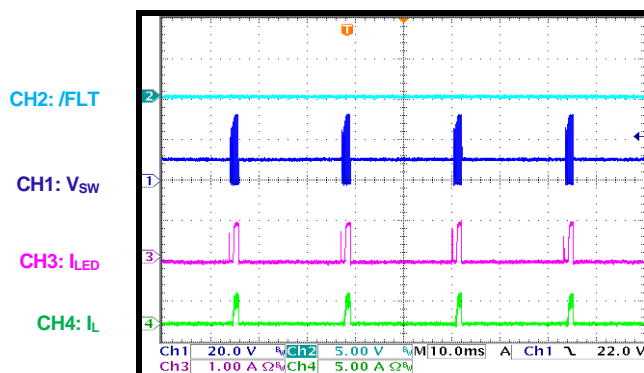
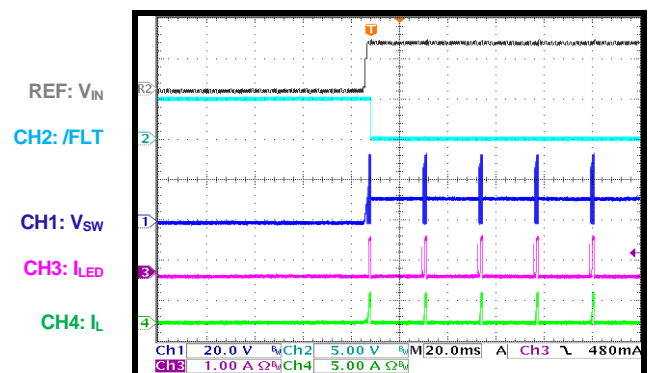
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

PWM Dimming
 LED open fault, steady state

PWM Dimming
 LED open fault, start-up

PWM Dimming
 LED open fault, shutdown

PWM Dimming
 LED open fault entry

PWM Dimming
 LED open fault recovery

Two-Step Dimming
 LED open fault, steady state


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

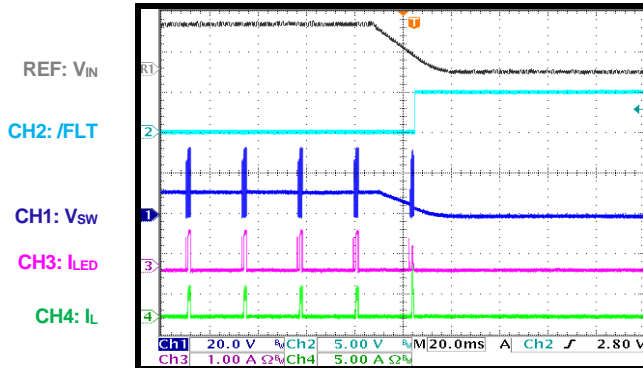
Two-Step Dimming
 LED open fault, start-up

Two-Step Dimming
 LED open fault, shutdown

Two-Step Dimming
 LED open fault entry

Two-Step Dimming
 LED open fault recovery

No Dimming
 One or more LED short fault, steady state

No Dimming
 One or more LED short fault, start-up


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

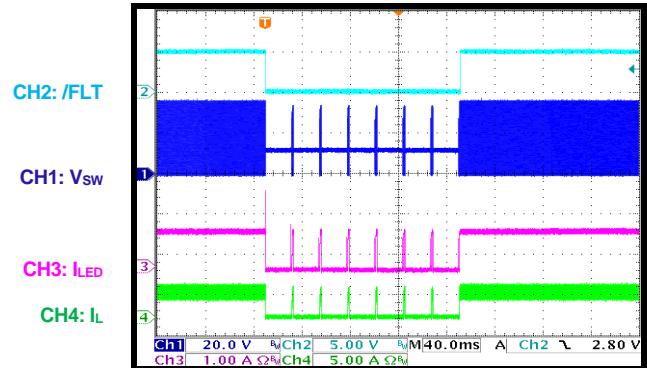
 Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

No Dimming

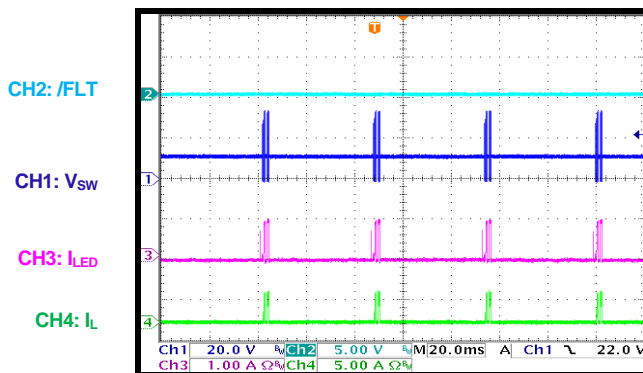
One or more LED short faults, shutdown


No Dimming

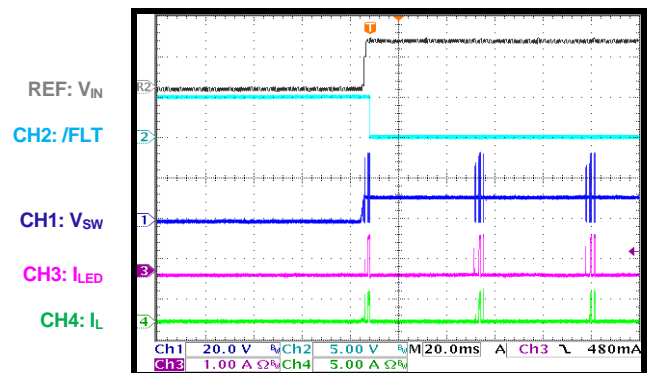
One or more LED short faults entry and recovery


PWM Dimming

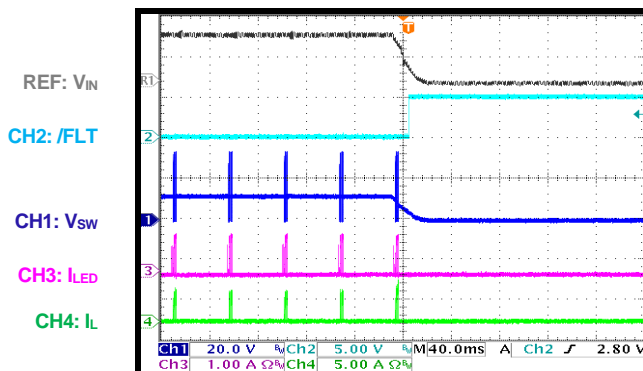
One or more LED short faults, steady state


PWM Dimming

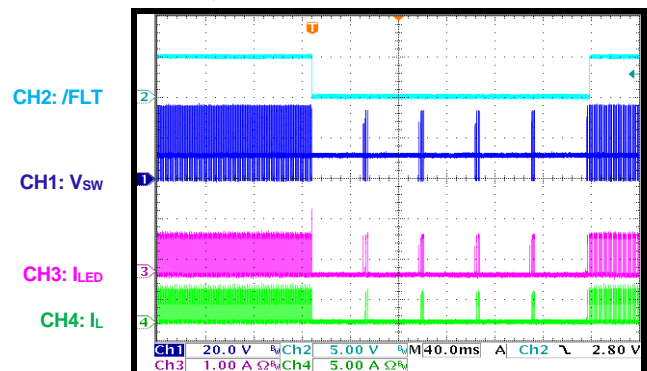
One or more LED short faults, start-up


PWM Dimming

One or more LED short faults, shutdown


PWM Dimming

One or more LED short faults entry and recovery

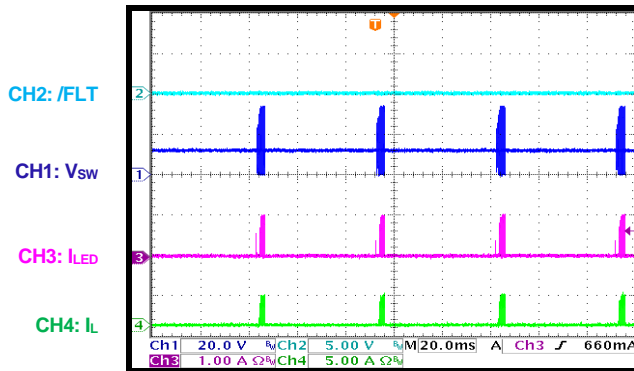


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

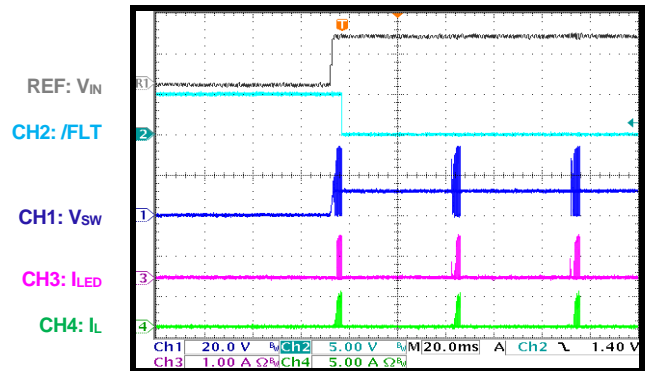
Two-Step Dimming

One or more LED short faults, steady state



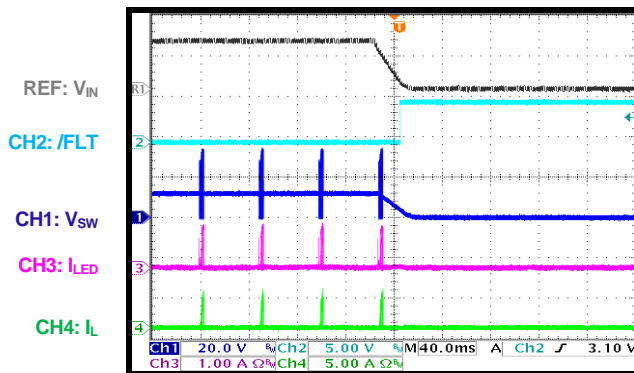
Two-Step Dimming

One or more LED short faults, start-up



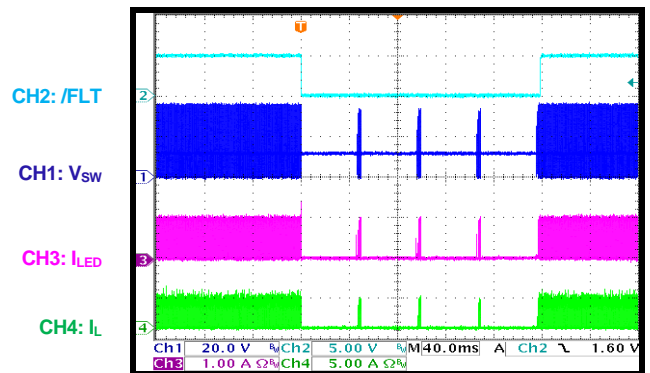
Two-Step Dimming

One or more LED short faults, shutdown



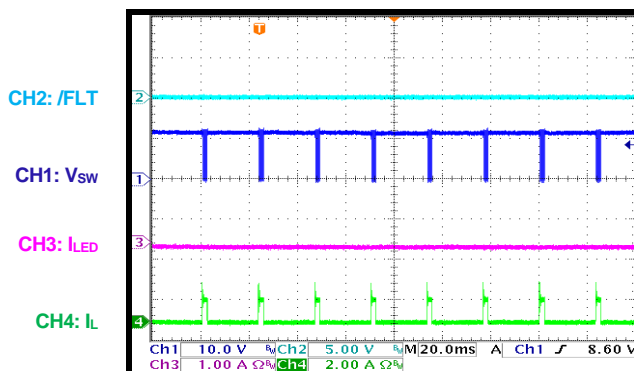
Two-Step Dimming

One or more LED short faults entry and recovery



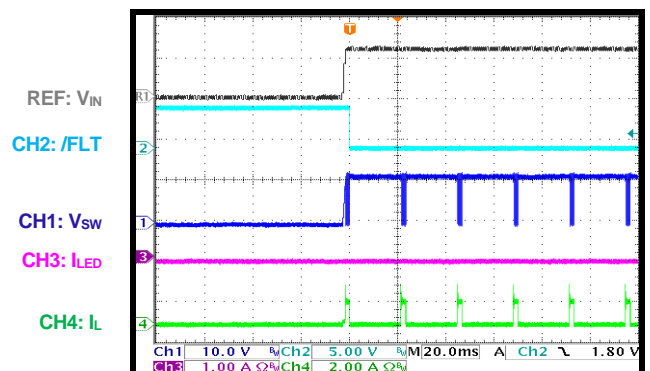
No Dimming

LED+ short to LED-, steady state



No Dimming

LED+ short to LED-, start-up

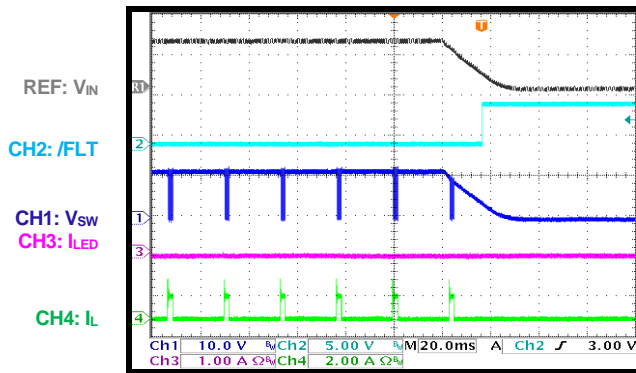


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

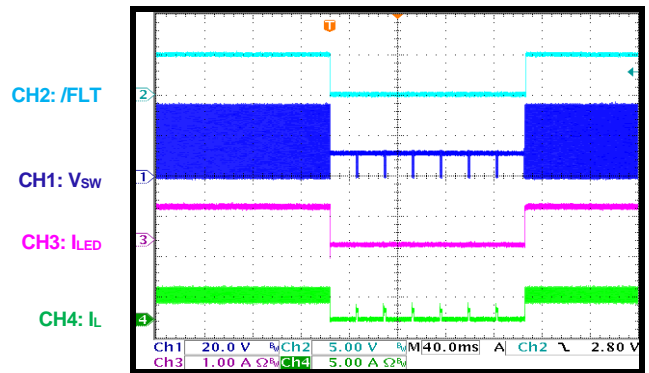
No Dimming

LED+ to LED- short, shutdown



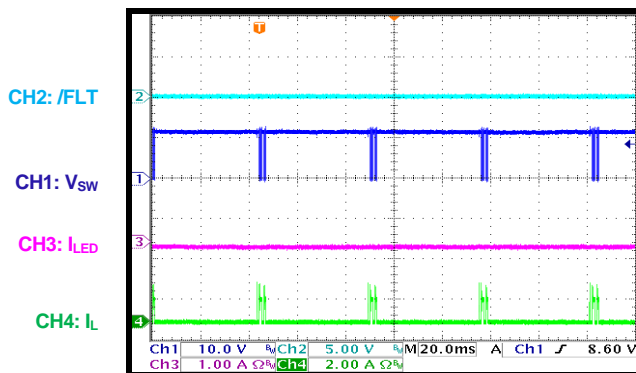
No Dimming

LED+ to LED- short entry and recovery



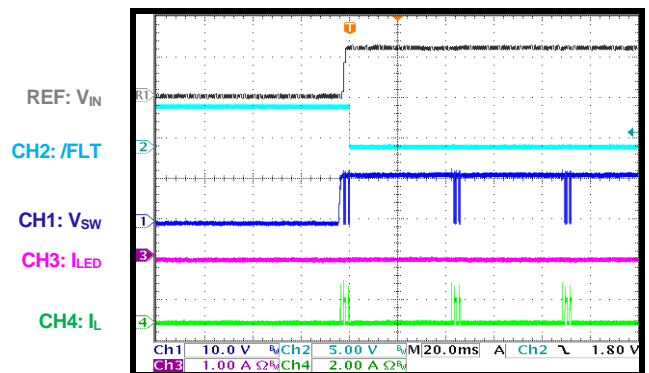
PWM Dimming

LED+ to LED- short, steady state



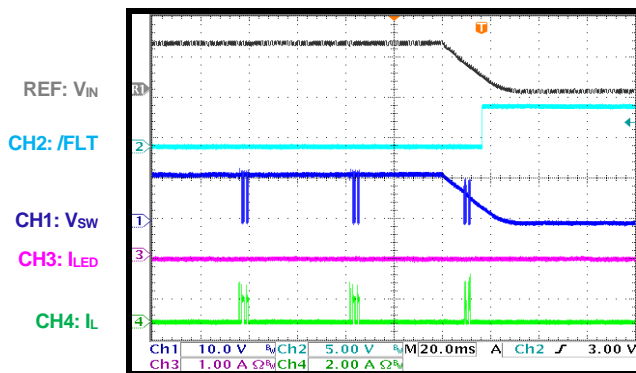
PWM Dimming

LED+ to LED- short, start-up



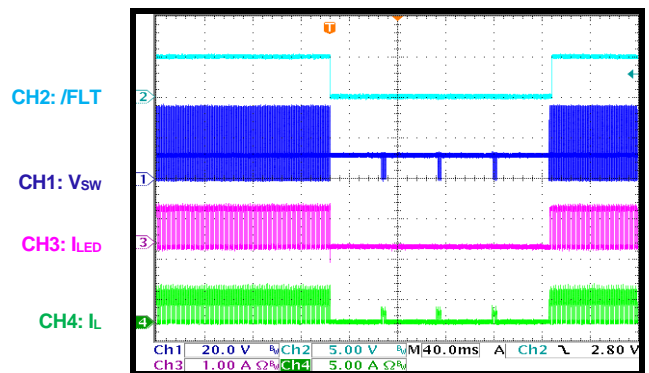
PWM Dimming

LED+ to LED- short, shutdown



PWM Dimming

LED+ to LED- short entry and recovery

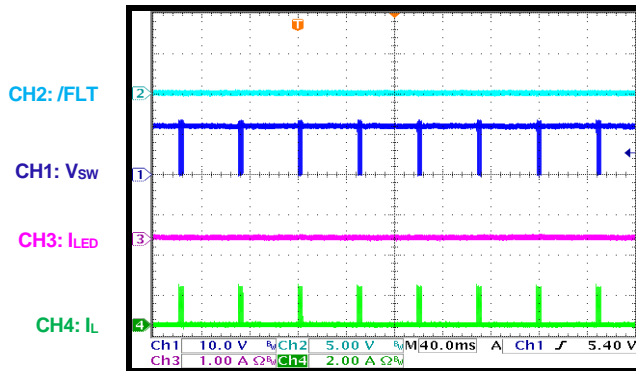


TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

Boost mode, 12 LEDs, $V_{LED} = 36V$, $V_{IN} = 12V$, $f_{SW} = 410kHz$, $L = 10\mu H$, $T_A = 25^\circ C$, unless otherwise noted.

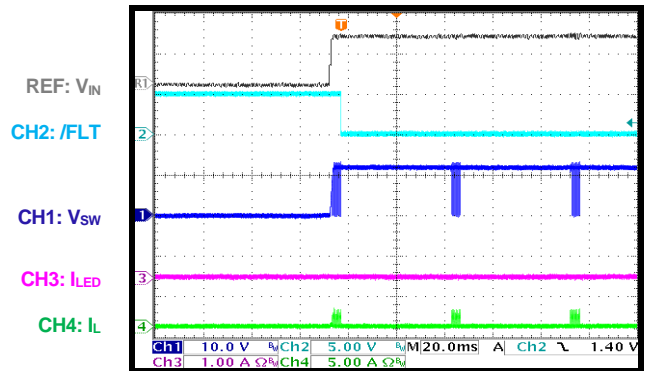
Two-Step Dimming

LED+ to LED- short, steady state



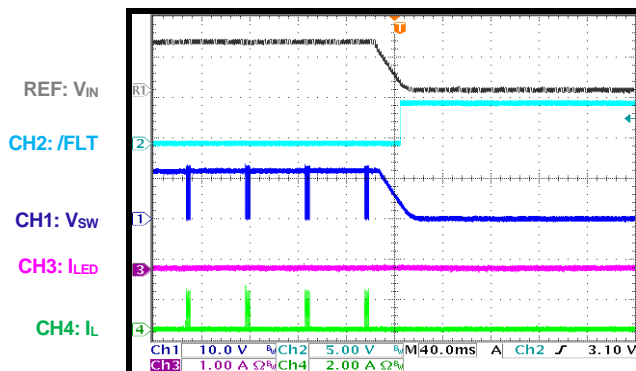
Two-Step Dimming

LED+ to LED- short, start-up



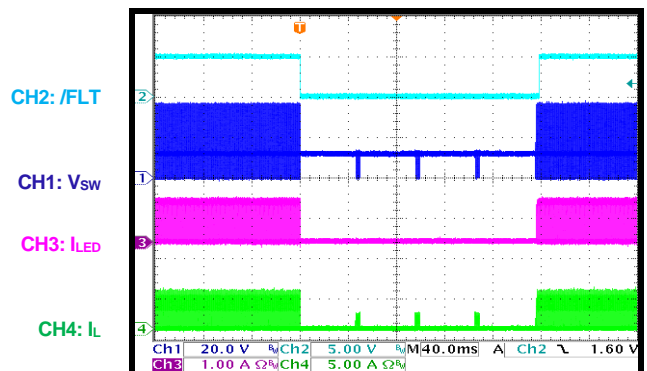
Two-Step Dimming

LED+ to LED- short, shutdown



Two-Step Dimming

LED+ to LED- short entry and recovery



FUNCTIONAL BLOCK DIAGRAM

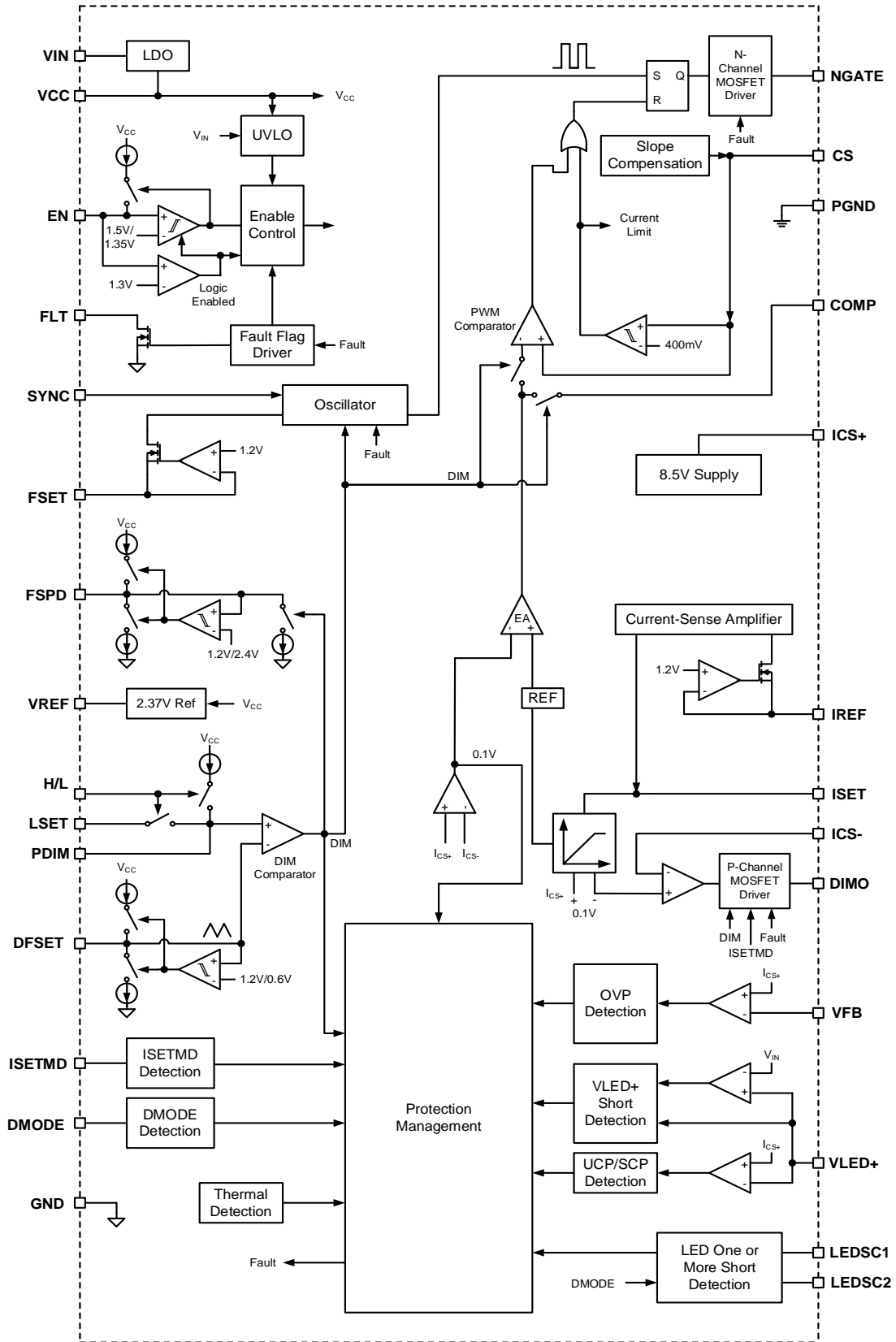


Figure 4: Functional Block Diagram

OPERATION

The MPQ2484U converter can support three single-channel LED driver configurations: boost mode, buck-boost mode, and low-side buck mode.

VCC Regulator

An internal low-dropout (LDO) regulator outputs a nominal 8.5V VCC supply voltage (V_{CC}) from the VIN pin. This supplies power for both control blocks, as well as the N-channel MOSFET gate driver. The VCC regulator features a 100mA current limit to prevent short circuits on the VCC rail. Place a 1 μ F to 10 μ F, low-ESR ceramic bypass capacitor from VCC to PGND.

The VCC supply cannot maintain an 8.5V output once V_{IN} drops below 8.5V. VCC can only be powered from VIN if V_{IN} exceeds 8.5V, with the highest driver capacity possible. When V_{IN} is below 8.5V, choose a MOSFET with a lower V_{GS_TH} . VCC can also be powered by an external auxiliary supply that meets its voltage limit.

Under-Voltage Lockout (UVLO)

Under-voltage lockout (UVLO) prevents the device (and certain blocks) from operating at an insufficient supply voltage. There are three internal, fixed UVLO comparators that monitor V_{IN} , V_{CC} , and V_{ICS+} .

If either V_{IN} or V_{CC} falls below their respective UVLO threshold, the MPQ2484U stops switching. Because the dimming P-channel MOSFET driver is powered from V_{ICS+} , this MOSFET shuts down if V_{ICS+} drops below its UVLO threshold.

If V_{IN} falls below 3.9V, all switching is disabled. Then the COMP voltage (V_{COMP}) is pulled down until V_{IN} exceeds 4.15V.

Similarly, if V_{CC} drops below 3.9V, then switching is disabled and V_{COMP} is pulled down until V_{CC} exceeds 4.135V.

Since V_{CC} is the internal LDO output from VIN, the actual V_{CC} is determined by V_{IN} and the VCC regulator's dropout voltage. The dropout voltage depends on the load current drawn from VCC. For applications with a higher switching frequency (f_{SW}) or larger MOSFET driving capacity demand, there may be a rise in the

VCC regulator's dropout voltage. If this occurs, V_{CC} may reach its UVLO threshold before V_{IN} when V_{IN} drops.

If the converter's output voltage (V_{ICS+}) drops below 8.5V, then DIMO is pulled up to ICS+ to turn off the dimming P-channel MOSFET until V_{ICS+} exceeds 8.7V. If V_{ICS+} UVLO occurs, the device's performance is not affected.

In buck mode, V_{ICS+} provides the input voltage, so ensure that V_{IN} exceeds V_{ICS+_UVLO} if the P-channel MOSFET is supposed to act as a dimming MOSFET. Note that the device can still operate in dimming mode without the dimming MOSFET. A dimming P-channel MOSFET is recommended for buck mode.

On/Off Control and Custom Input Under-Voltage Lockout (UVLO)

When EN is driven above its logic threshold, the VCC regulator is activated. Once V_{CC} exceeds its UVLO threshold, it starts to provide power to the internal control circuitry, and the integrated EN comparator begins operating.

If the EN voltage (V_{EN}) exceeds the comparator's upper threshold (typically 1.5V), the converter is enabled, and soft start (SS) begins. If V_{EN} falls below the comparator's lower threshold, then the converter stops switching; however, the VCC regulator and control circuitry continue working until the EN pin is pulled below its logic threshold (<0.4V). Then the chip enters shutdown mode while consuming a tiny input current.

In addition to providing standard on/off logic control, the integrated EN comparator allows the EN pin to set a custom input UVLO threshold by placing an external resistor divider from VIN to GND (see Figure 5).

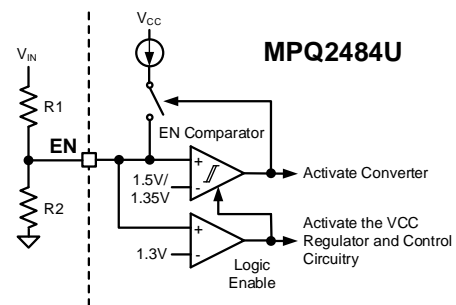


Figure 5: Custom Input UVLO Set by EN

V_{EN} is achieved via the resistor divider ratio from V_{IN} . When V_{EN} reaches the UVLO rising threshold for the integrated EN comparator (about 1.5V), the converter starts switching. Meanwhile, an internal 0.63 μ A pull-up current source is enabled to source current out of the EN pin.

When V_{IN} drops to disable the converter, V_{EN} must drop below the EN comparator's UVLO threshold. This means that V_{IN} must stay above the UVLO threshold to overcome the hysteresis from the 0.63 μ A pull-up current, as well as the inherent 150mV hysteresis of the EN comparator. As a result, the actual hysteresis can be set independently without changing the rising UVLO threshold.

Start-Up

If both V_{IN} and V_{EN} exceed their UVLO rising thresholds, the internal LDO starts to charge the V_{CC} capacitor. As V_{CC} rises to reach its V_{CC} UVLO threshold, the internal control circuitry and reference block operate. Once V_{IN} , V_{CC} , and V_{EN} are enabled, the MPQ2484U begins switching. Internal soft start (SS) is implemented to prevent the converter's output voltage and current from overshooting during start-up. Once V_{ICS+} exceeds its UVLO threshold, the P-channel MOSFET is used as a dimming switch.

VREF Output

The MPQ2484U provides a 2.37V reference voltage (V_{REF}) on the VREF pin. Connect a 1nF to 10nF ceramic capacitor from VREF to GND. This reference can only source up to 80 μ A of current. V_{REF} can set the LSET level via a resistor divider for two-step dimming, or it can work as the pull-up source for the control pins to set a logic high input. V_{REF} is also the reference voltage for one or more internal LED shorts detection. If V_{REF} drops below its threshold, a short is triggered.

High-Side Current-Sense (CS) Reference Setting

The LED current is sensed by the high-side (HS) current-sense (CS) resistor connected between ICS+ and ICS-. In boost or buck-boost mode, the ICS+ pin is tied to the output of the converter; in buck mode, it is connected to the input. The ICS- pin, which is on the other side of the CS resistor, goes to the source of the P-

channel MOSFET. If there is no external dimming MOSFET, then ICS- is directly connected to the LED string anode (VLED+). The chip regulates the voltage across the sensing resistor to 100mV if the ISET voltage (V_{ISET}) exceeds 2.2V.

The MPQ2484U features a configurable LED current reference by monitoring the voltage on the setting resistor connected between ISET and ground. This resistor can be placed on an LED light board to adjust the current. To reduce the noise created by a long connection wire, it is recommended to place a small capacitor close to the ISET pin.

The biased current can also be tuned by tying a resistor from IREF ($I_{REF} = V_{IREF} / R_{IREF}$) to ground. The current through the IREF resistor configures the biased current on ISET ($I_{SET} = 100 \times I_{REF}$). This means that changing the value of the setting resistor can adjust the LED current reference. For the relationship between V_{ISET} and the internal reference voltage, see the Mode and Current-Sense Reference Selection section on page 43.

Power Converter

Typically, the converter works in fixed-frequency, peak current control mode. At the beginning of each switching cycle, the N-channel MOSFET turns on at the rising edge of the clock. A resistor tied from the CS pin to GND senses the N-channel MOSFET's current signal.

To prevent subharmonic oscillations when the duty cycle exceeds 50%, a stabilizing ramp is added to the N-channel MOSFET current-sense signal to generate the peak inductor current information. When the peak inductor current reaches the value set by V_{COMP} (which is the output voltage of the EA), then the N-channel MOSFET turns off until the next switching clock begins. The current is also limited by the 400mV clamped voltage on the VCS pin. This sets the converter's maximum power.

Error Amplifier (EA)

The MPQ2484U converter incorporates a low-offset error amplifier (EA) to provide compensation for the control loop. The feedback signal and reference voltage provide

two different modes to regulate the LED current. The feedback signal switches to the voltage on the HS CS resistor between ICS+ and ICS-. V_{REF} is about 100mV, but it can be adjusted via the ISET pin.

The internal EA outputs an amplified signal to the external compensation network. This signal is the difference between V_{REF} and the feedback voltage (V_{FB}), and it indicates V_{COMP} . V_{COMP} is connected to the PWM comparator to control the N-channel MOSFET's peak current, which is sensed by a sensing resistor connected between the source of N-channel MOSFET and ground. During the N-channel MOSFET's turn-on time, the CS pin outputs a current ramp. The current then flows through a resistor (R_{CS}) that is placed between the CS pin and the N-channel FET current-sense resistor. This current ramp configures the slope compensation.

Once the CS level reaches V_{COMP} , the converter pulls down NGATE to turn off the N-channel MOSFET.

Note that the EA's transconductance is nonlinear. The EA's transconductance has a greater source ability than sink ability.

Transconductance can help speed up LED regulation when PWM dimming is initiated.

Oscillator and Switching Frequency (f_{SW})

The MPQ2484U's f_{SW} can be configured between 100kHz and 2.2MHz by connecting a resistor (R_{FSET}) between the FSET pin and GND. R_{FSET} can be calculated with Equation (1):

$$R_{FSET} (k\Omega) = \frac{8333}{f_{SW} (kHz)} \quad (1)$$

For EMI-sensitive applications, the switching clock can be synchronized to an external clock signal that is applied to the SYNC pin. Once the external clock signal is added on the SYNC pin, the FSET setting no longer has any effect.

Ensure that the external clock signal frequency is at least 10% greater than f_{SW} as set by FSET. If the external sync signal is lost, then the internal oscillator controls the switching rate and f_{SW} returns to the value set by FSET. This allows the switching clock to operate with intermittent synchronization signals.

Mode and Current-Sense Reference Selection

Table 1 lists different modes that can be selected using the DMODE and ISETMD pins.

Table 1: Mode Selection

	DMODE (High)	DMODE (Low)
ISETMD (High)	Normal operation mode: The LED current can be configured up to 100% of its nominal value.	Dimming switch mode: The LED current can be configured up to 100% of its nominal value.
ISETMD (Low)	Normal operation mode: The LED current can be configured up to 200% of its nominal value.	Dimming switch mode: The LED current can be configured up to 200% of its nominal value.

The DMODE pin selects whether the device operates in normal operation mode or dimming switch mode. If the logic is high, the dimming P-channel MOSFET is not used. If DMODE is pulled down to GND, then the dimming P-channel MOSFET is used as a dimming switch. The P-channel MOSFET turns off during dimming, or if any fault is triggered.

The ISETMD pin sets the internal reference voltage ($V_{REFICS+ICS-}$). If ISETMD is pulled down to GND, the ISET voltage rises from 0.6V to 1.8V, and $V_{REFICS+ICS-}$ rises linearly from 0mV to 200mV, which can be used for analog dimming. When the ISET voltage exceeds 2.3V, $V_{REFICS+ICS-}$ stays at about 100mV (see Figure 6 on page 44).

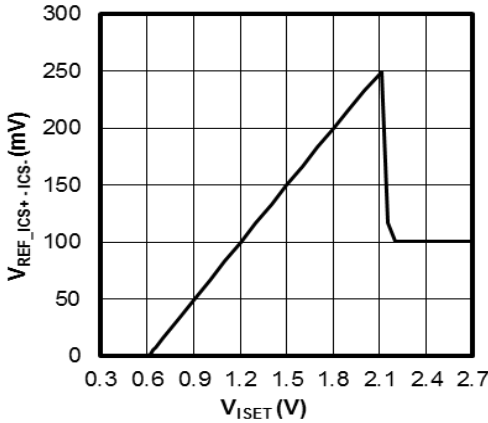


Figure 6: ISETMD is Low

When the ISETMD pin is logic high and the voltage on ISET (V_{ISET}) rises from 0.6V to 1.2V, V_{REFICS+ICS-} rises linearly from 0mV to 100mV. When V_{ISET} exceeds 1.2V, V_{REFICS+ICS-} stays at about 100mV (see Figure 7).

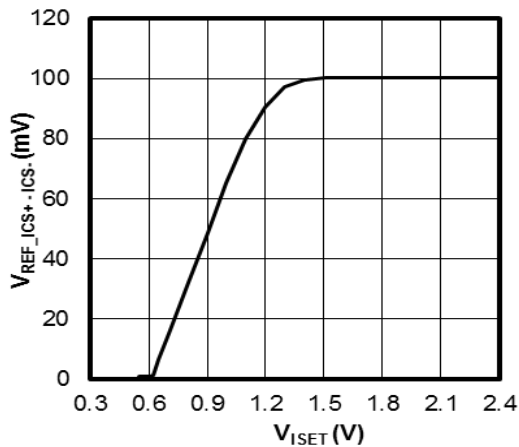


Figure 7: ISETMD is High

Frequency Spread Spectrum (FSS)

To optimize EMI performance, the MPQ2484U provides a frequency spread spectrum (FSS) function. Connect a capacitor from the FSPD pin to GND. The internal source and sink currents (both 100µA) charge and discharge the capacitor repeatedly to generate a stable triangular ramp waveform between 0.6V and 1.2V. This triangular ramp voltage works with the resistor connected between the FSPD and FSET pins to generate a current. The current flowing out from the FSET pin can dither f_{SW} for FSS.

The spread spectrum frequency (f_{SS}) can be estimated with Equation (2):

$$f_{SS} = \frac{I_{FSPD}}{2 \times C_{FSPD} \times \Delta U} \quad (2)$$

Where I_{FSPD} is the FSPD source/sink current (100µA), C_{FSPD} is the capacitor between FSPD and GND, and ΔU = 0.6V (1.2V - 0.6V).

The spread spectrum scope (Δf_{SS}) can be calculated with Equation (3):

$$\Delta f_{SS} = f_{SW} \times \frac{R_{FSET}}{R_{FSPD}} \quad (3)$$

Where R_{FSPD} is the resistor between FSPD and FSET.

The f_{SW} scope is between (f_{SW} - Δf_{SS}) and f_{SW}. For example, if f_{sw} = 400kHz, C_{FSPD} = 3.3nF, R_{FSET} = 21kΩ, and R_{FSPD} = 200kΩ, then f_{SS} is 20kHz and f_{SW} is dithered from 350kHz to 400kHz.

Figure 8 shows FSS operation.

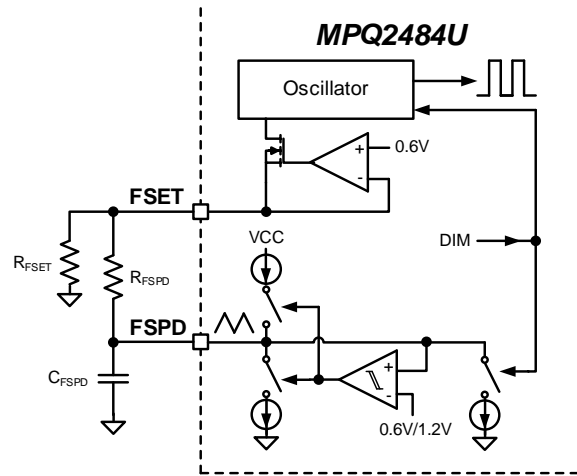


Figure 8: Frequency Spread Spectrum

Figure 9 shows FSS waveforms.

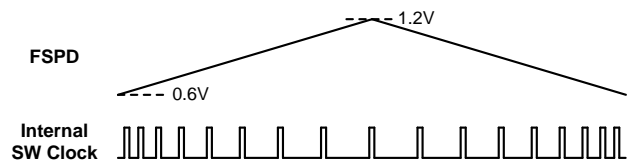


Figure 9: Frequency Spread Spectrum Waveforms

The modulation frequency should be below f_{SW} as set by FSET by a minimum factor of 10.

If an external clock signal applied to the SYNC pin, the FSS mechanism is screened. Remove R_{FSPD} if FSS is disabled.

Two-Step Dimming

Connect a bypass capacitor from PDIM to GND for two-step dimming mode. The two-step dimming frequency can be configured by placing a capacitor between the DFSET pin and GND. The internal source and sink currents charge and discharge the capacitor repeatedly to generate a stable triangular ramp waveform between 0.6V and 1.2V. The two-step dimming frequency (f_{DIM}) can be estimated with Equation (4):

$$f_{DIM} = \frac{I_{DFSET}}{2 \times C_{DFSET} \times \Delta U} \quad (4)$$

Where I_{DFSET} is the source/sink current (100 μ A), C_{DFSET} is the capacitor between DFSET and GND, and $\Delta U = 0.6V$ (1.2V - 0.6V).

The two-step dimming duty (D_{DIM}) can be calculated with Equation (5):

$$D_{DIM} = \frac{V_{LSET} - 0.6}{1.2 - 0.6} \quad (5)$$

Where V_{LSET} is the LSET pin voltage.

Figure 10 shows two-step dimming.

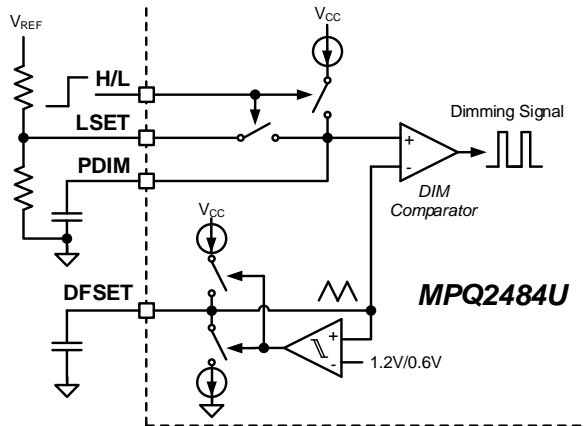


Figure 10: Two-Step Dimming

If the H/L pin is pulled up to a logic high input after two-step dimming is set, then the positive input of the DIM comparator is disconnected from the LSET pin. The internal pull-up current source charges the PDIM capacitor to 2V. The DIM comparator outputs a 100% duty cycle dimming signal, and the LED current is regulated at full scale.

If the H/L pin is set to logic low, then the internal pull-up current turns off and the DIM comparator's positive input is connected to the LSET pin. The LSET level can be set between 0.6V and 1.2V via an external resistor divider connected from VREF to the LSET pin. When compared to the DFSET triangular ramp waveform, the LSET voltage determines the duty cycle of the final dimming signal (see Figure 11).

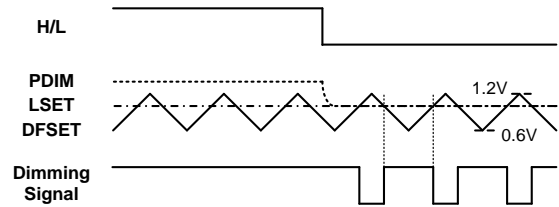


Figure 11: Dimming Signal Generation

The MPQ2484U can switch between full-scale LED brightness and lower levels via the H/L signal.

PWM Dimming

PWM dimming can be achieved by driving the PDIM pin with a pulsating voltage source. Tie the H/L pin to VREF, and connect an 8.06k Ω resistor from the DFSET pin to GND (V_{DFSET} is always 100 μ A \times 8.06k Ω = 0.806V) to disable the dimming oscillator (see Figure 12).

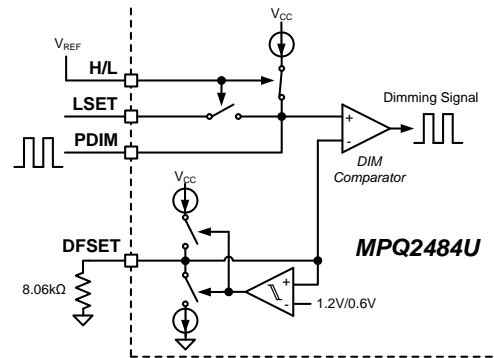


Figure 12: PWM Dimming

When the voltage on the PDIM pin exceeds 1.2V (meaning it exceeds V_{DFSET}), the DIM comparator outputs a dimming on signal. When the PDIM voltage drops below 0.4V (below V_{DFSET}), a dimming off signal is generated. Ensure that the minimum PWM dimming on time is longer than 60 μ s, or the MPQ2484U will stop switching.

Analog Dimming

Analog dimming can be achieved via the ISETMD and ISET pins, which set V_{REF} . When the ISETMD pin is pulled down to GND, provide a linear voltage between 0.6V and 1.8V for the ISET pin. V_{REF} rises linearly from 0mV to 200mV.

Dimming Performance

The DIM comparator outputs a dimming signal to control the pulse width that modulates the output LED current. When the dimming signal is logic high, the MPQ2484U is enabled and the dimming P-channel MOSFET turns on. When the dimming signal is logic low, the device stops switching and the dimming P-channel MOSFET turns off. The internal EA's output is also disconnected from both the PWM comparator and the COMP pin. The COMP level can remain constant when dimming is off.

The dimming signal also affects the switching oscillator and FSS functions. If f_{SW} is set by the FSET pin, then both the oscillator and FSS mechanisms are disabled when the dimming signal is off and the FSPD voltage is pulled down to 0.6V. When a dimming signal is received, these functions are reinitiated. This protocol can force the converter's switching clock to be synchronized by the dimming signal, which ensures that each dimming cycle performs consistently (see Figure 13).

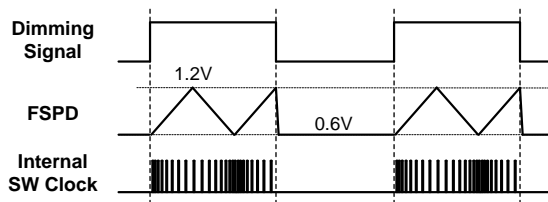


Figure 13: SW Clock Synchronization by the Dimming Signal

Over-Voltage Protection (OVP)

The MPQ2484U monitors the voltage across the LED strings. A resistor divider is connected from ICS+ to the cathode of the LED string, and the tap of the divider is tied to the VFB pin. If the differential voltage between ICS+ and VFB exceeds 1.17V, the converter stops switching, but the dimming P-channel MOSFET maintains its original status. If an open LED fault is triggered at the same time, then the P-channel MOSFET is disabled and the chip runs as it would during a fault condition. When the

differential voltage drops below 1.02V, the over-voltage (OV) condition is removed and the MPQ2484U restarts and resumes normal operation.

Over-Current Protection (OCP)

The cycle-by-cycle current limit restricts the N-channel MOSFET's maximum current via the current-sense resistor on the CS pin. V_{CS} is typically 400mV.

Additionally, if the N-channel MOSFET reaches its current limit and $V_{ICS+} - V_{LED+} < 50mV$ for $1\mu s$ when with P-channel MOSFET, or $V_{ICS+} - V_{LED+} < 0.1V$ for $1\mu s$ when without P-channel MOSFET, then the converter and dimming P-channel MOSFET turn off, and /FLT asserts. After 8192 consecutive clock cycles, the system restarts again with a soft start. During the recovery cycle, the /FLT signal stays latched. /FLT resets after $30\mu s$ without a fault.

Open LED Protection

If the LED string is disconnected from the system, then the device cannot obtain the LED current information and the converter automatically increases the output voltage until OVP is triggered.

If the dimming P-channel MOSFET is on when an OV condition is detected, the device checks the differential voltage between ICS+ and VLED+ to avoid start-up voltage overshoot. If the differential voltage is below 50mV, then an open LED fault occurs.

If the system is operating without a dimming P-channel MOSFET when an OV condition occurs, the device checks the voltage on the LED current-sense resistor between ICS+ and ICS-. If the voltage is below 50mV, then an open LED fault occurs.

If an open LED fault occurs, the converter and dimming P-channel MOSFET turn off, V_{COMP} is pulled down to ground, and /FLT asserts. The fault recovery counter starts once the differential voltage between ICS+ and VFB drops below 1.02V. After 8192 consecutive clock cycles, the system restarts again with a soft start. During the recovery cycle, the /FLT signal stays latched. /FLT resets after $30\mu s$ without a fault.

LED String Anode/Cathode to Battery/Ground Short Protection

If an LED short fault is detected, then the converter and dimming P-channel MOSFET turn off, V_{COMP} is pulled down to ground, and /FLT asserts. After 8192 consecutive clock cycles, the system restarts again with a soft start. During the recovery cycle, the /FLT signal remains latched. /FLT resets once 30 μ s pass with no fault present.

One or More LED Short Protection

In certain cases, only one LED may short, but it is possible for several LEDs to short. The MPQ2484U features one or more LEDs short detection to guarantee that the light source stays sufficiently illuminated. There are two conditions that trigger one or more LED short protection:

- $|V_{LEDSC1} - V_{LEDSC2}| > 180\text{mV}$ for 32 consecutive clock cycles
- $|V_{LEDSC1} - V_{LEDSC2}| > 80\text{mV}$ for 4096 consecutive clock cycles

If the absolute value of the differential voltage between LEDSC1 and LEDSC2 exceeds either of these thresholds for the set time, the converter and dimming P-channel MOSFET turn off, V_{COMP} is pulled to ground, and /FLT asserts. After 8192 consecutive clock cycles, the system restarts again with a soft start. During the recovery cycle, the /FLT signal remains latched. /FLT resets once 30 μ s pass with no fault present. LEDSC1 and LEDSC2 sense the voltage drop of one LED or the whole LED string. The LEDSC1 voltage (V_{LEDSC1}) can be estimated with Equation (6):

$$V_{LEDSC1} = V_{LED+} - \frac{1}{K} V_{LED} \times \frac{R_{SD3}}{R_{SD3} + R_{SD4}} \quad (6)$$

Where K is the LED number of the LED string, and V_{LED} is the whole LED string voltage drop.

The LEDSC2 voltage (V_{LEDSC2}) can be calculated with Equation (7):

$$V_{LEDSC2} = V_{LED+} - V_{LED} \times \frac{R_{SD1}}{R_{SD1} + R_{SD2}} \quad (7)$$

It is recommended to set $R3:R4 = 1:1$. It is required to set $R1:R2 = 1:(2K - 1)$ (see Figure 14).

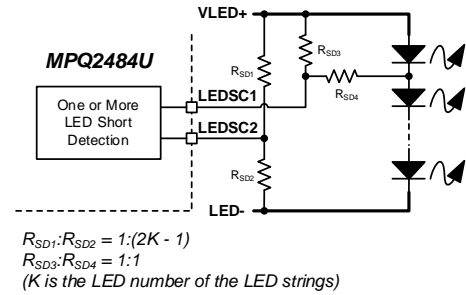


Figure 14: One or More LED Short Protection

For applications with 8 LEDs (such as in Figure 16 and Figure 17 on page 54), set $R_{SD2} = 100\text{k}\Omega$, $R_{SD1} = 6.65\text{k}\Omega$, and $R_{SD3} = R_{SD4} = 6.65\text{k}\Omega$.

For applications with 12 LEDs (such as in Figure 18 and Figure 19 on page 55), set $R_{SD2} = 100\text{k}\Omega$, $R_{SD1} = 4.32\text{k}\Omega$, and $R_{SD3} = R_{SD4} = 4.32\text{k}\Omega$.

Thermal Protection

Thermal shutdown is implemented to prevent the chip from operating at exceedingly high temperatures and possibly being damaged. If the silicon die temperature exceeds 170°C, over-temperature protection (OTP) shuts down the chip and /FLT asserts. Once the temperature returns to below the lower threshold (about 150°C), the chip restarts and resumes normal operation. During the recovery cycle, the /FLT signal remains latched. /FLT resets once 30 μ s pass with no fault present.

The ISET pin can be used as an NTC pin by connecting an NTC resistor between ICS+ and ISET. When the voltage on the NTC resistor rises from 0.6V to 1.8V, V_{REF} rises from its minimum value to 200mV. Then the LED current is dimmed according to the value of the NTC resistor.

Fault Flag (/FLT)

The /FLT pin is an active-low, open-drain output that should be connected to a voltage source through an external pull-up resistor for fault indication. For normal operation, the /FLT pin is pulled high to indicate that there is no fault. The /FLT pin is pulled high before soft start begins. If there is a fault, /FLT is pulled down to ground. If the fault is removed after soft start ends during a recovery cycle, the /FLT pin resets once the converter resumes normal operation (without a fault) for 30 μ s consecutively.

Table 2: UVLO, OCP, and OVP (No /FLT Assertion)

Protection	Trigger Condition	Release Condition	Action
V _{IN} UVLO	V _{IN} < 3.9V	V _{IN} > 4.15V	Disables the chip
V _{CC} UVLO	V _{CC} < 3.9V	V _{CC} > 4.135V	Disables the chip
V _{ICS+} UVLO	V _{ICS+} < 8.5V	V _{ICS+} > 8.7V	Disables the dimming MOSFET
Custom input UVLO	V _{EN} < 1.35V	V _{EN} > 1.5V	Disables the converter
OVP	V _{ICS+} - V _{FB} > 1.17V	0V < V _{ICS+} - V _{FB} < 1.02V	Disables the converter
N-channel MOSFET current limit	V _{CS} > 400mV & V _{ICS+} - V _{LED+} > 100mV with dimming P-channel MOSFET ⁽⁷⁾ ; V _{CS} > 400mV & V _{ICS+} - V _{LED+} > 50mV without dimming P-channel MOSFET ⁽⁷⁾ ;	Next SW clock comes	Disables the converter for this switching cycle

Table 3: OLP, SCP, and OTP (with Dimming P-Channel MOSFET)

Protection	Activating Condition			Release
	Boost	Buck-Boost	Buck	
Open LED	OVP status and V _{ICS+} - V _{LED+} < 0.1V			Must satisfy all of the release conditions in Table 2
LED+ to PGND short	V _{ICS+} - V _{ICS-} > 0.3V for 1μs			
LED- to PGND short	Normal connection	Short input	If V _{IN} is high (> 1.17 x V _{OUT}), OVP occurs, then SCP is triggered If V _{IN} is < (1.17 x V _{OUT}), SCP is triggered	
LED+ to battery short	V _{ICS+} - V _{ICS-} > 0.3V for 1μs		If the N-channel MOSFET reaches its current limit and V _{ICS+} - V _{LED+} < 0.1V for 1μs ⁽⁷⁾	
LED- to battery short	Short input	Normal connection		
Short one or more LEDs	V _{LEDSC1} - V _{LEDSC2} > 180mV for 32 consecutive clock cycles V _{LEDSC1} - V _{LEDSC2} > 80mV for 4096 consecutive clock cycles			
OTP	T _J > 170°C			

Table 4: OLP, SCP, and OTP (without Dimming P-Channel MOSFET)

Protection	Activating Condition			Release
	Boost	Buck-Boost	Buck	
Open LED	OVP status and V _{ICS+} - V _{ICS-} < 50mV			Must satisfy all of the release conditions in Table 2
LED+ to PGND short	N/A	N/A	N/A	
LED- to PGND short	N/A	N/A	N/A	
LED+ to battery short	V _{ICS+} - V _{ICS-} > 0.3V for 1μs		If the N-channel MOSFET reaches its current limit and V _{ICS+} - V _{LED+} < 50mV for 1μs ⁽⁷⁾	
LED- to battery short	N/A	N/A		
Short one or more LEDs	V _{LEDSC1} - V _{LEDSC2} > 180mV for 32 consecutive clock cycles V _{LEDSC1} - V _{LEDSC2} > 80mV for 4096 consecutive clock cycles			
OTP	T _J > 170°C			T _J < 150°C

Note:

7) Where the reference voltage between ICS+ and ICS- is 100mV, and the drop voltage of P-channel MOSFET is 50mV.

APPLICATION INFORMATION

Setting the LED Current

The external resistor between ICS+ and ICS- sets the output LED current. When $V_{ISET} > 2.2V$, V_{REF} on ICS+ and ICS- is always 100mV. V_{ISET} can be adjusted by changing the values of R_{IREF} and R_{ISET} . V_{ISET} can be estimated with Equation (8):

$$V_{ISET} = 100 \times \frac{0.805 \times R_{ISET}}{R_{IREF}} \quad (8)$$

Where R_{IREF} is the resistor connect to the IREF pin, and R_{ISET} is the resistor connected to the ISET pin.

If the calculated V_{ISET} is too high, V_{ISET} will be clamped to ~5V.

When the V_{REF} values on ICS+ and ICS- are 100mV, it is recommended for $R_{IREF} = R_{ISET} = 80.6k\Omega$. R_{SENSE} is the resistor between ICS+ and ICS-. R_{SENSE} can be calculated with Equation (9):

$$R_{SENSE} = \frac{0.1V}{I_{LED}} \quad (9)$$

Consider the power consumption when selecting the packages of the LED current-sense resistor. For example, if the required LED current is 1A, then the resistor should have a 1206 package.

V_{REF} on ICS+ and ICS- can be adjusted via ISETMD and V_{ISET} . See the Mode and Current-Sense Reference Selection section on page 43 for more details.

Selecting the Inductor

For most applications, use a 4.7 μ H to 100 μ H inductor with a DC current rating greater than the maximum inductor current. Consider the inductor's DC resistance when estimating the inductor's output current and power consumption.

For buck converter designs, estimate the required inductance (L) with Equation (10):

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times f_{SW}} \quad (10)$$

Where f_{SW} is the switching frequency, and ΔI_L is the inductor current ripple.

Choose the inductor ripple current to be 30% of the maximum load current. The peak inductor current (I_{L_PEAK}) can be calculated with Equation (11):

$$I_{L_PEAK} = I_{L_AVG} + \frac{\Delta I_L}{2} \quad (11)$$

Where I_{L_AVG} is the average current through the inductor.

I_{L_AVG} is equal to the output load current (LED current) for buck applications. For buck-boost converter designs, estimate the required inductance (L) with Equation (12):

$$L = \frac{V_{OUT} \times V_{IN}}{(V_{OUT} + V_{IN}) \times \Delta I_L \times f_{SW}} \quad (12)$$

Where ΔI_L is the peak-to-peak inductor current ripple.

Select ΔI_L to be about 25% of the average inductor current (I_{L_AVG}). I_{L_AVG} can be calculated with Equation (13):

$$I_{L_AVG} = I_{LED} \times \left(1 + \frac{V_{OUT}}{V_{IN}}\right) \quad (13)$$

I_{L_PEAK} can be calculated with Equation (14):

$$I_{L_PEAK} = I_{L_AVG} + \frac{\Delta I_L}{2} \quad (14)$$

For boost converter designs, calculate the required inductance (L) with Equation (15):

$$L = \frac{V_{IN} \times (V_{OUT} - V_{IN})}{V_{OUT} \times \Delta I_L \times f_{SW}} \quad (15)$$

Select ΔI_L to be around 30% of the average inductor current (I_{L_AVG}). I_{L_AVG} can be estimated with Equation (16):

$$I_{L_AVG} = I_{LED} \times \frac{V_{OUT}}{V_{IN}} \quad (16)$$

I_{L_PEAK} can be calculated with Equation (17):

$$I_{L_PEAK} = I_{L_AVG} + \frac{\Delta I_L}{2} \quad (17)$$

Under light-load conditions below 200mA, use a larger-value inductor to improve efficiency.

Selecting the Input Capacitor

The input current in buck mode and buck-boost mode is discontinuous, and requires a capacitor to supply AC current to the converter while maintaining the DC input voltage. For the best performance, use low-ESR capacitors. Ceramic capacitors with X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients.

For most applications, use a 10µF to 44µF capacitor. The input capacitor can be electrolytic, tantalum, or ceramic. When using electrolytic or tantalum capacitors, it is recommended to use another, lower-value capacitor (e.g. 0.1µF) with a small package size (e.g. 0603) to absorb high-frequency switching noise. Place the smaller capacitor as close as possible to VIN and GND (INGND = PGND in buck mode). In buck-boost mode, connect the capacitor to VIN, INGND, and PGND).

Because C_{IN} absorbs the input switching current in buck mode, the MPQ2484U requires an adequate ripple current rating. The RMS current in the input capacitor (I_{CIN}) can be estimated with Equation (18):

$$I_{CIN} = I_{LED} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)} \quad (18)$$

The worst-case condition occurs at V_{IN} = 2 × V_{OUT}, calculated with Equation (19):

$$I_{CIN} = \frac{I_{LED}}{2} \quad (19)$$

For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current. The input voltage ripple (ΔV_{IN}) caused by the capacitance can be estimated with Equation (20):

$$\Delta V_{IN} = \frac{I_{LED}}{f_{SW} \times C_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (20)$$

If ΔI_L ≥ the I_{LED} in buck-boost mode, then the input voltage ripple (ΔV_{IN}) can be calculated with Equation (21):

$$\Delta V_{IN} = \frac{I_{LED} \times V_{OUT}}{(V_{IN} + V_{OUT}) \times f_{SW} \times C_{IN}} \quad (21)$$

If ΔI_L ≥ the I_{LED} in boost mode, then the input voltage ripple (ΔV_{IN}) caused by the capacitance can be estimated with Equation (22):

$$\Delta V_{IN} = \frac{V_{IN}}{8 \times f_{SW}^2 \times L \times C_{IN}} \times \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \quad (22)$$

Selecting the Output Capacitor

The output capacitor maintains the DC output voltage. Ceramic, tantalum, or low-ESR electrolytic capacitors are recommended. For the best results, use low-ESR capacitors to maintain a low output voltage ripple. In buck mode, the output voltage ripple (ΔV_{OUT}) can be estimated with Equation (23):

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times f_{SW} \times C_{OUT}}\right) \quad (23)$$

Where L is the inductance, and R_{ESR} is the equivalent series resistance (ESR) of the output capacitor.

For ceramic capacitors, the capacitance dominates the impedance at the switching frequency and causes the majority of the output voltage ripple. For simplification, the output voltage ripple (ΔV_{OUT}) can be estimated with Equation (24):

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times f_{SW}^2 \times L \times C_{OUT}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (24)$$

For tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, ΔV_{OUT} can be calculated with Equation (25):

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times R_{ESR} \quad (25)$$

If ΔI_L ≥ I_{LED} for buck-boost applications, ΔV_{OUT} can be estimated with Equation (26):

$$\Delta V_{OUT} = I_{LED} \times \left(R_{ESR} + \frac{V_{OUT}}{f_{SW} \times C_{OUT} \times (V_{IN} + V_{OUT})}\right) \quad (26)$$

For tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, ΔV_{OUT} can be calculated with Equation (27):

$$\Delta V_{OUT} = I_{LED} \times R_{ESR} \quad (27)$$

If $I_{\text{BANDVALLEY}} \geq I_{\text{LED}}$ in boost applications, the output capacitor can be estimated using Equation (28):

$$\Delta V_{\text{OUT}} = I_{\text{LED}} \times \left(R_{\text{ESR}} + \frac{V_{\text{OUT}} - V_{\text{IN}}}{f_{\text{SW}} \times C_{\text{OUT}} \times V_{\text{OUT}}} \right) \quad (28)$$

For tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, ΔV_{OUT} can be calculated with Equation (29):

$$\Delta V_{\text{OUT}} = I_{\text{LED}} \times R_{\text{ESR}} \quad (29)$$

Selecting the N-Channel MOSFET

The MOSFET gate driver is sourced from VCC. The maximum gate charge is limited by the 50mA VCC sourcing current limit. A leadless package is recommended for designs with a high f_{SW} . The MOSFET gate capacitance should be small enough that the gate voltage is fully discharged during the off time.

During start-up (especially when the V_{IN} range is below the VCC regulation target), VCC must be sufficient to fully turn on the MOSFET. If the MOSFET's drive voltage is below its gate plateau voltage during start-up, the boost converter may not start up normally, and the converter may not operate at the maximum duty cycle in a high power dissipation state. To avoid this, select an N-channel MOSFET with a lower threshold and set the V_{IN} threshold above 5V.

Selecting the Diode

It is recommended to use a Schottky diode for D1 due to its low forward voltage drop and small reverse recovery charge. A low reverse leakage current is critical when selecting the Schottky diode. The diode must be rated to handle the maximum output voltage, as well as any switching node ringing. The diode must also be able to handle the average output current.

Selecting the Dimming P-Channel MOSFET

The P-channel MOSFET is typically used for dimming to improve dimming performance. In boost mode and buck-boost mode, the P-channel MOSFET can also provide protection for LED+ to battery shorts, as well as LED+ to PGND shorts.

When dimming is off, the voltage on the P-channel MOSFET is equal to the LED voltage.

Select the P-channel MOSFET V_{DS} to exceed the LED voltage, and ensure that the continuous drain current exceeds the LED current with a lower $R_{\text{DS(ON)}}$.

Over-Current Protection (OCP) Setting

Place a resistor in series with the N-channel MOSFET to sense the inductor current and set the current limit.

To ensure that there is a sufficient LED current, the current-limit threshold must be set via the CS resistor (R_{CS}) on the CS pin. $I_{\text{L_PEAK_LIMIT}}$ can be estimated with Equation (30):

$$I_{\text{L_PEAK_LIMIT}}(\text{A}) = \frac{400(\text{mV}) - I_{\text{SLOP_PK}} \times R9 \times D(\text{mV})}{R_{\text{CS}}(\text{m}\Omega)} \quad (30)$$

Where $(I_{\text{SLOP_PK}} \times R9 \times \text{duty})$ is the slope compensation on the CS pin; $I_{\text{SLOP_PK}}$ is the slope compensation ramp peak current during each switching cycle (typically 50 μA); R9 is for the slope compensation connection between the CS pin and R_{CS} ; and D is the switching duty.

When selecting R9, the following is recommended:

- **Buck mode:** $I_{\text{SLOP_PK}} / T \times R9 > 0.5 \times (V_{\text{O}} / L) \times R_{\text{CS}}$
- **Boost mode:** $I_{\text{SLOP_PK}} / T \times R9 > 0.5 \times (V_{\text{O}} - V_{\text{IN}}) / L \times R_{\text{CS}}$
- **Buck-boost mode:** $I_{\text{SLOP_PK}} / T \times R9 > 0.5 \times |V_{\text{O}} - V_{\text{IN}}| / L \times R_{\text{CS}}$

The $I_{\text{L_PEAK_LIMIT}}$ value is typically set to be between 120% and 130% of $I_{\text{L_PEAK}}$.

For the applications shown in Figure 16 and Figure 17 on page 54 and in Figure 18 and Figure 19 on page 55, It is recommended follow the guidelines below:

- Place three CS resistors (70m Ω , 70m Ω , and 70m Ω) with 2512 packages in parallel with one another.
- Use R9 to provide slope compensation.
- Use C4 to filter out the switching noise on the CS pin.

Over-Voltage Protection (OVP) Setting

The resistor divider network (R10 and R11) connected to ICS+, VFB, and the cathode of the LED string monitors the output voltage (see Figure 16 on page 54).

The resistor divider network can determine whether there is an open fault on an LED string. If the voltage between ICS+ and VFB exceeds 1.17V, then the converter stops switching and does not recover until the voltage drops below 1.02V.

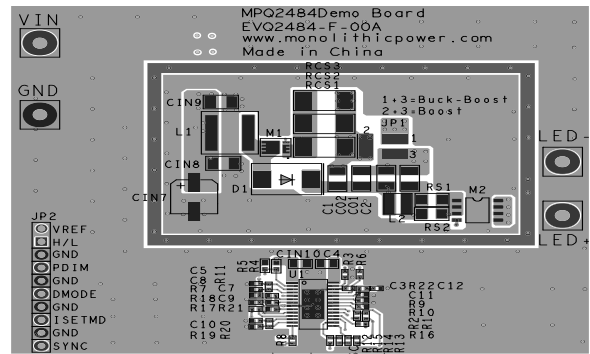
Set the over-voltage protection (OVP) threshold to be 10% to 30% greater than the maximum output voltage (LED string voltage). The OVP threshold (V_{OVP}) can be calculated with Equation (31):

$$V_{OVP} = \frac{R10+R11}{R10} \times 1.17 \quad (31)$$

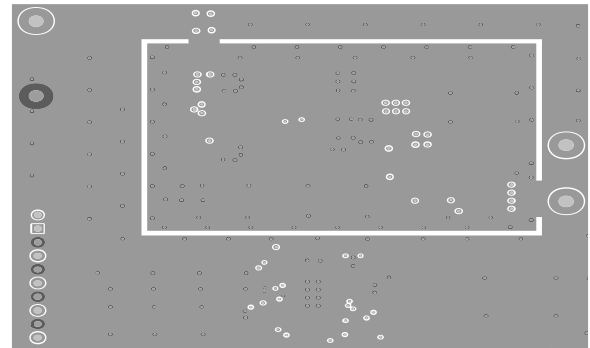
PCB Layout Guidelines

Efficient PCB layout is critical for stable operation. A 4-layer layout is strongly recommended to improve thermal performance. For the best results, refer to Figure 15 and follow the guidelines below:

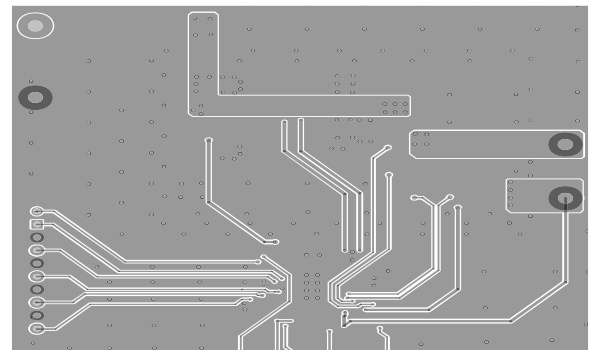
1. Use large copper areas to minimize conduction loss and thermal stress, and ensure that all heat-dissipating components have adequate cooling.
2. Isolate the power components and high-current paths from the sensitive analog circuitry, such as CS.
3. Keep the high-current paths short, especially at the ground terminals. This is recommended for stable, jitter-free operation.
4. Keep the switching loops short.
5. Connect the D1 anode close to the drain of the MOSFET (M1).
6. Connect the D1 cathode close to the output capacitor (C_{OUT}).
7. Connect C_{OUT} and the CS resistors (R1A, R1B, and R1C) directly to PGND.
8. Route high-speed switching nodes away from the sensitive analog areas.
9. Use an internal PCB layer for the GND plane. This layers acts as an EMI shield to keep radiated noise away from the device.



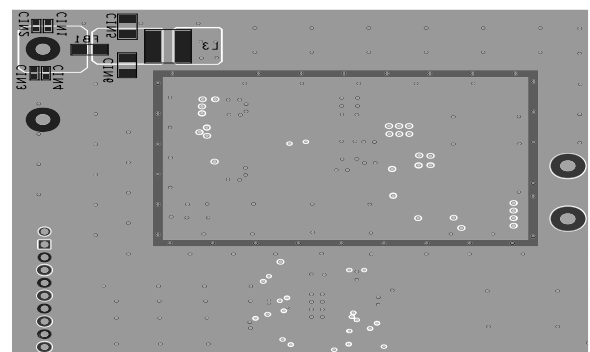
Top Layer



Mid-Layer 1



Mid-Layer 2



Bottom Layer

Figure 15: Recommended PCB Layout ⁽⁸⁾

Note:

- 8) The recommended layout is based on Figure 17 on page 54 and Figure 19 on page 55.

TYPICAL APPLICATION CIRCUITS

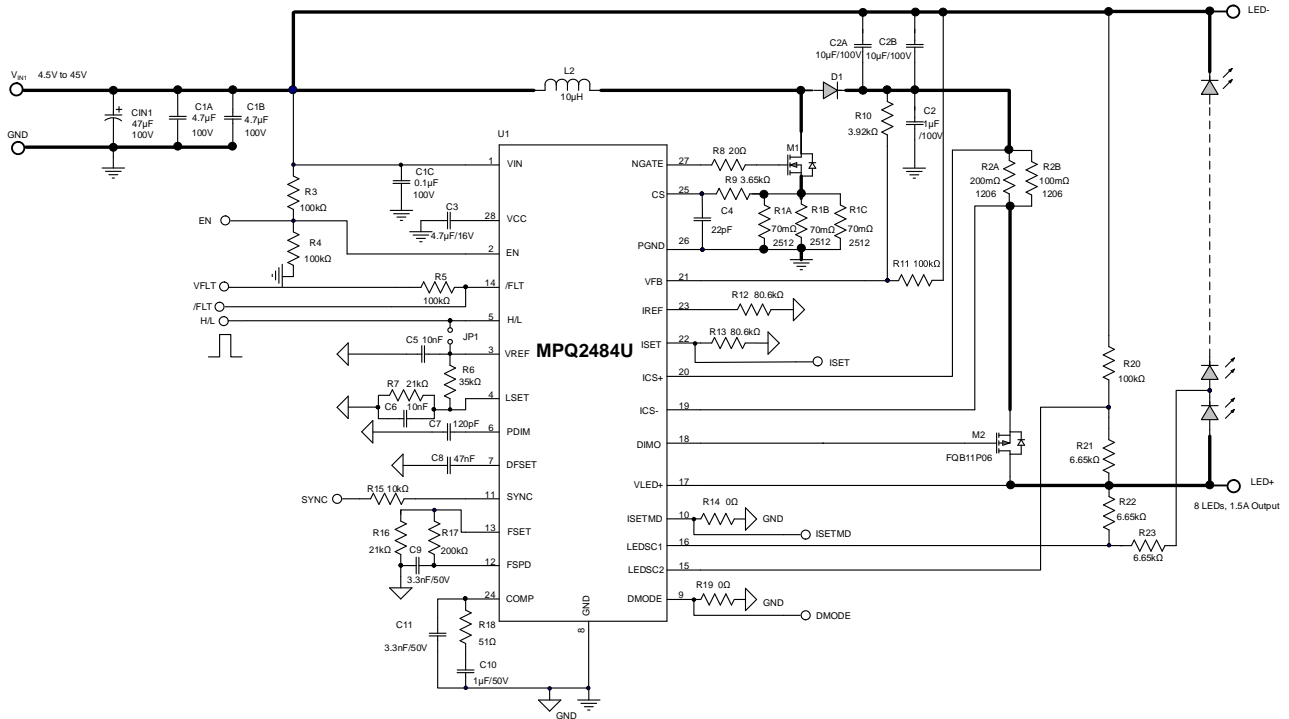


Figure 16: Typical Application Circuit for Buck-Boost Topology (Two-Step Dimming)

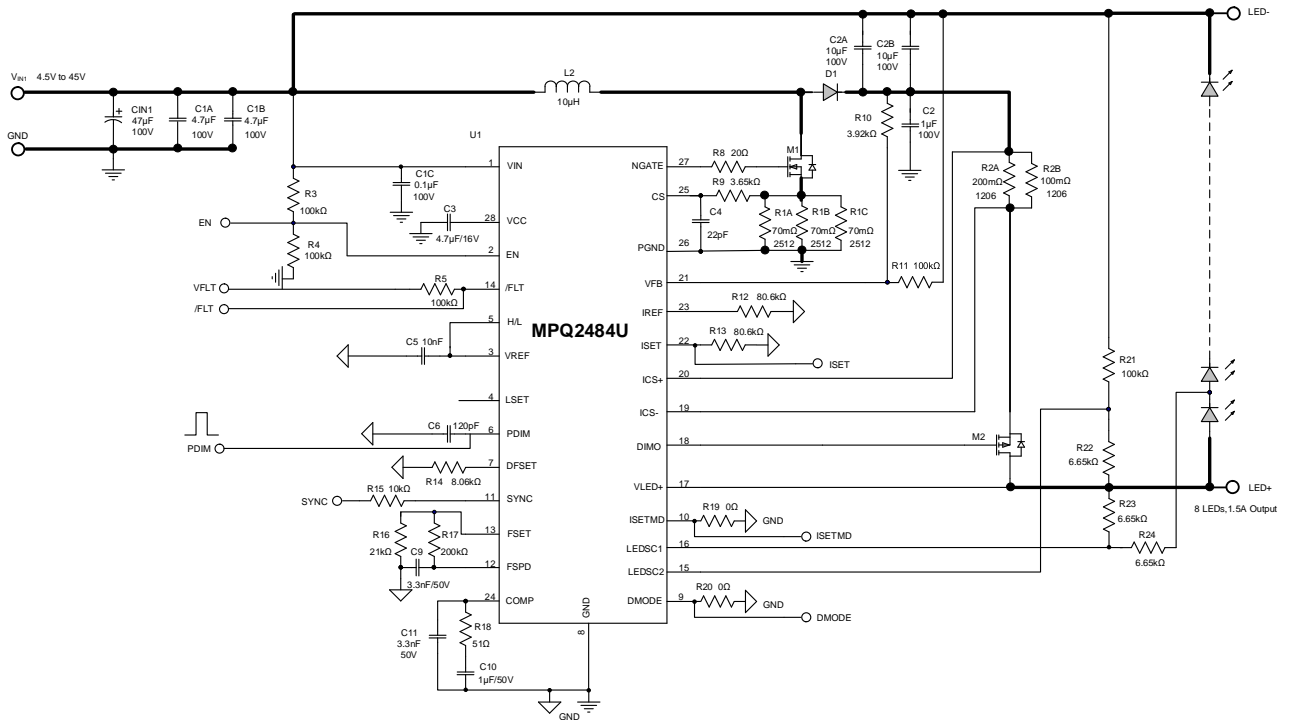


Figure 17: Typical Application Circuit for Buck-Boost Topology (PWM Dimming)

TYPICAL APPLICATION CIRCUITS (continued)

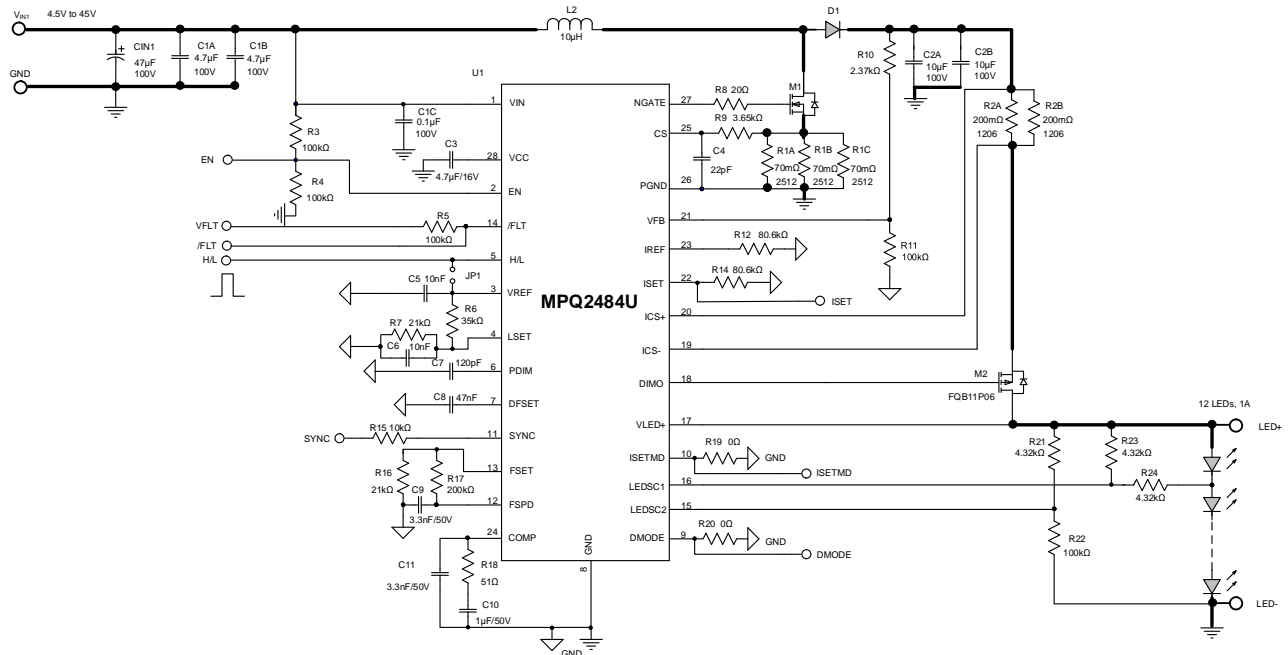


Figure 18: Typical Application Circuit for Boost Topology (Two-Step Dimming)

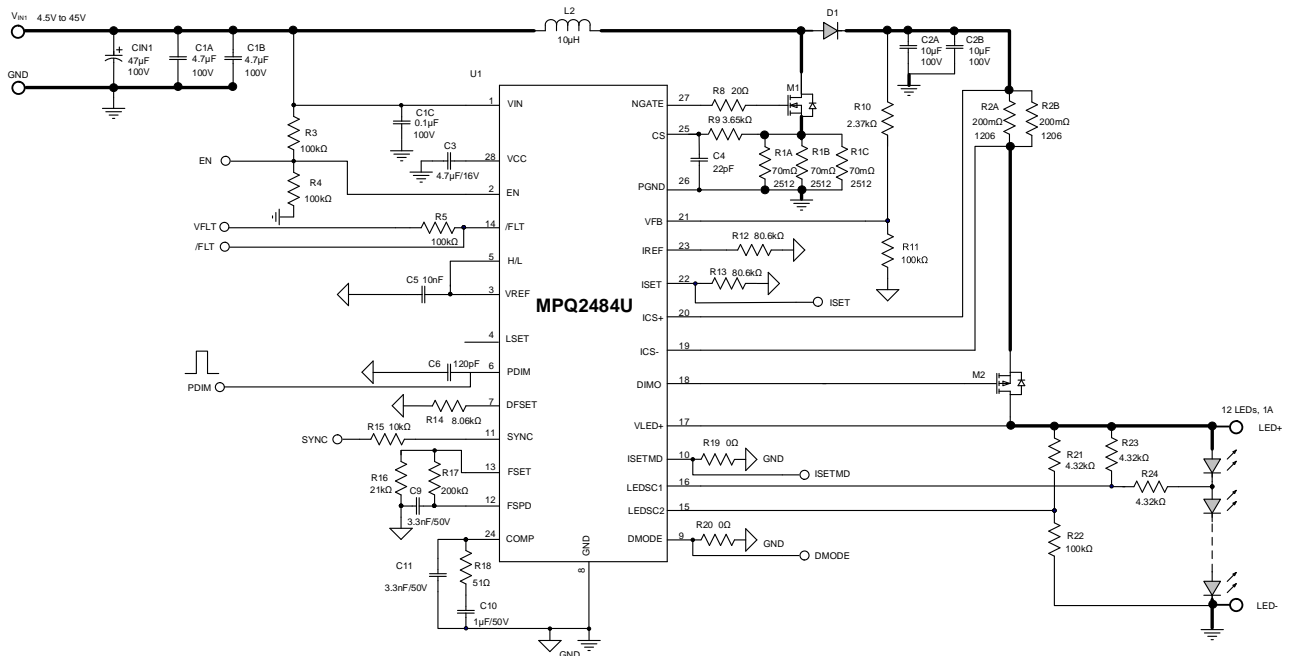
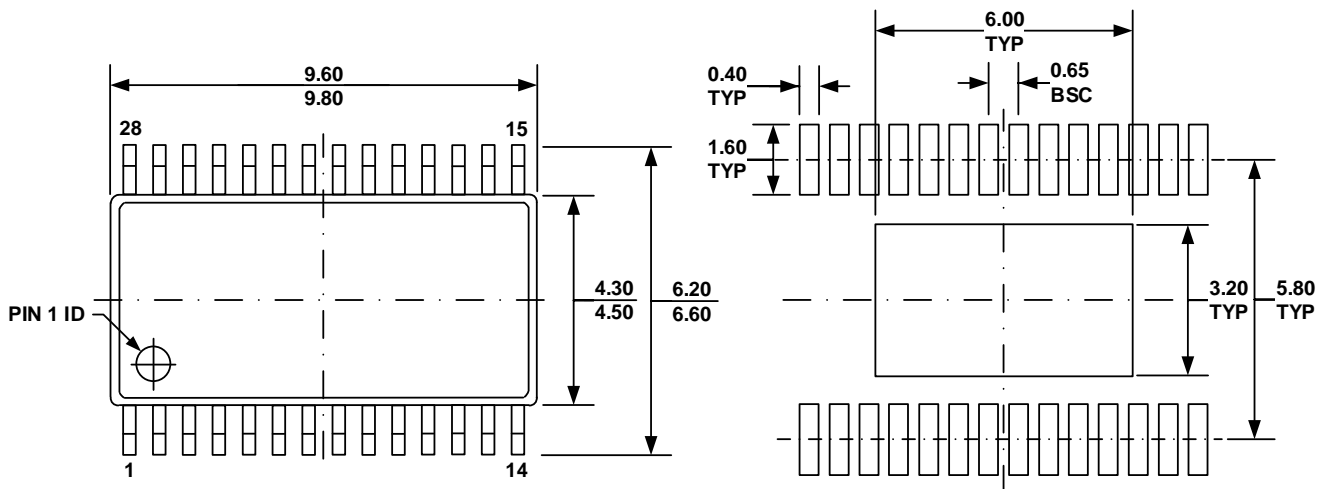
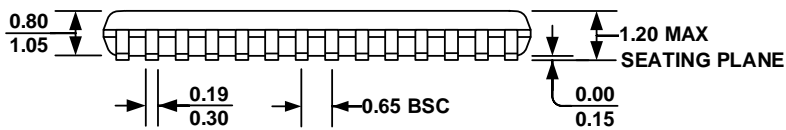
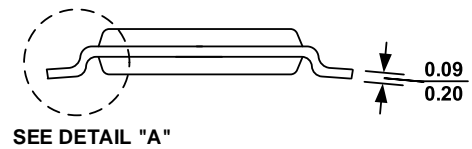
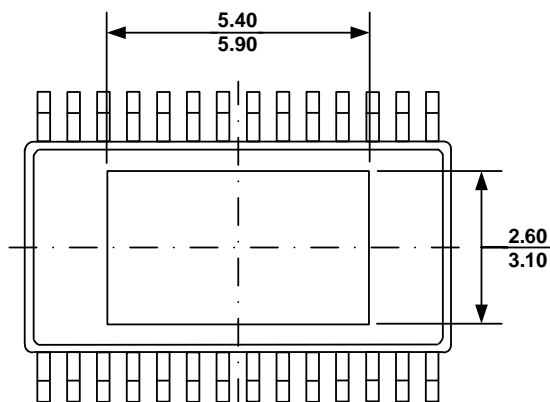
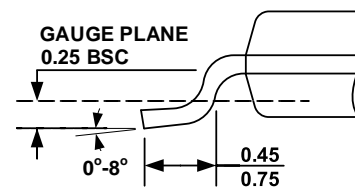


Figure 19: Typical Application Circuit for Boost Topology (PWM Dimming)

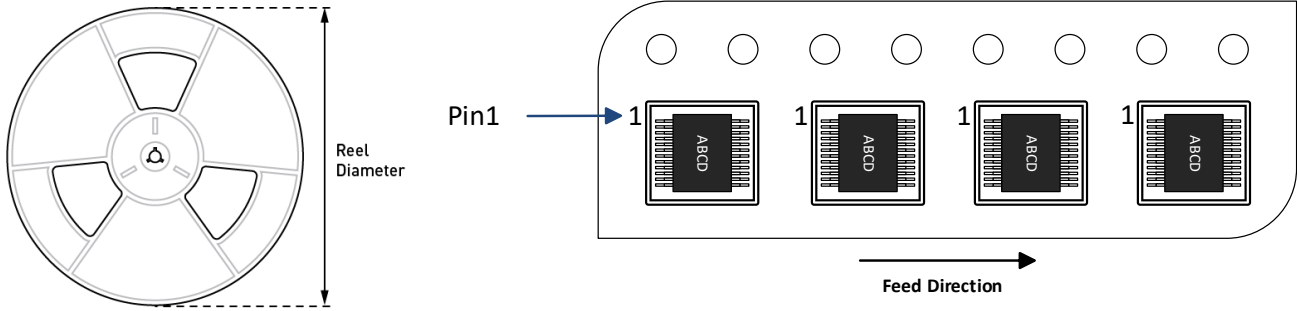
PACKAGE INFORMATION
TSSOP-28EP

TOP VIEW
RECOMMENDED LAND PATTERN

FRONT VIEW


SEE DETAIL "A"

SIDE VIEW

BOTTOM VIEW

DETAIL "A"
NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURR.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.1 MILLIMETERS MAX.
- 5) DRAWING CONFORMS TO JEDEC MO-153, VARIATION AET.
- 6) DRAWING IS NOT TO SCALE.

CARRIER INFORMATION



Part Number	Package Description	Quantity/ Reel	Quantity/ Tube	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MPQ2484UGF-AEC1-Z	TSSOP-28EP	2500	N/A	13in	16mm	8mm